



datasheet

PRODUCT SPECIFICATION

1/4" color CMOS QSXGA (5 megapixel) image sensor
with OmniBSI+™ technology

OV5648

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color CMOS QSXGA (5 megapixel) image sensor with OmniBSI+™ technology

datasheet (COB)
PRODUCT SPECIFICATION

version 2.12
september 2013

To learn more about OmniVision Technologies, visit www.ovt.com.

OmniVision Technologies is publicly traded on NASDAQ under the symbol OVTI.

applications

- cellular phones
- toys
- PC multimedia
- digital still cameras

ordering information

- **OV05648-G04A** (color, chip probing, 200 μm backgrinding, reconstructed wafer)

features

- 1.4 μm x 1.4 μm pixel with OmniBSI+ technology for high performance (high sensitivity, low crosstalk, low noise)
- optical size of 1/4"
- automatic image control functions: automatic exposure control (AEC), automatic gain control (AGC), automatic white balance (AWB), and automatic black level calibration (ABLC)
- programmable controls for frame rate, AEC/AGC 16-zone size/position/weight control, mirror and flip, cropping, windowing, and panning
- defective pixel canceling
- support for output formats: 8-/10-bit raw RGB data
- support for video or snapshot operations
- support for LED and flash strobe mode
- support for internal and external frame synchronization for frame exposure mode
- support for horizontal and vertical sub-sampling
- standard serial SCCB interface
- MIPI interface (two lanes)
- 32 bytes of embedded one-time programmable (OTP) memory
- on-chip phase lock loop (PLL)
- embedded 1.5V regulator for core power
- programmable I/O drive capability, I/O tri-state configurability
- support for black sun cancellation

key specifications (typical)

- **active array size:** 2592 x 1944
- **power supply:**
 - core: 1.5V \pm 5% (with embedded 1.5V regulator)
 - analog: 2.6 ~ 3.0V (2.8V typical)
 - I/O: 1.7 ~ 3.0V
- **power requirements:**
 - active: 219 mW
 - standby: 36 μW
- **temperature range:**
 - operating: -30°C to 70°C junction temperature (see **table 8-2**)
 - stable image: 0°C to 50°C junction temperature (see **table 8-2**)
- **output formats:** 8-/10-bit RGB RAW output
- **lens size:** 1/4"
- **lens chief ray angle:** 29.1° (see **figure 10-2**)
- **input clock frequency:** 6~27 MHz
- **max S/N ratio:** 36 dB
- **dynamic range:** 72 dB @ 8x gain
- **maximum image transfer rate:**
 - QSVGA (2592 x 1944): 15 fps
 - 1080p: 30 fps
 - 960p: 45 fps
 - 720p: 60 fps
 - VGA (640 x 480): 90 fps
- **sensitivity:** 690mV/Lux-sec
- **shutter:** rolling shutter
- **pixel size:** 1.4 μm x 1.4 μm
- **dark current:** 0.7mV/s @ 50°C junction temperature
- **image area:** 3673.6 μm x 2738.4 μm
- **die dimensions:** 5000 μm x 4800 μm (COB), 5050 μm x 4850 μm (RW) (see **section 9** for details)



note COB refers to whole wafers with known good die and RW refers to singulated good die on a reconstructed wafer. Die size differs between COB and RW.

OV5648

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table of contents

1 signal descriptions	1-1
2 system level description	2-1
2.1 overview	2-1
2.2 architecture	2-1
2.3 format and frame rate	2-3
2.4 I/O control	2-3
2.4.1 system clock control	2-3
2.5 power up sequence	2-3
2.5.1 power up with internal DVDD	2-3
2.5.2 power up with external DVDD source	2-4
2.6 reset	2-5
2.7 hardware and software standby	2-5
2.8 serial camera control bus (SCCB) interface	2-6
2.8.1 data transfer protocol	2-6
2.8.2 message format	2-6
2.8.3 read / write operation	2-6
2.8.4 SCCB timing	2-9
2.8.5 group write	2-10
3 block level description	3-1
3.1 pixel array structure	3-1
3.2 subsampling	3-2
3.3 analog amplifier	3-2
3.4 10-bit A/D converters	3-2
4 image sensor core digital functions	4-1
4.1 mirror and flip	4-1
4.2 image windowing	4-2
4.3 test pattern	4-3
4.3.1 color bar	4-3
4.3.2 square	4-3
4.3.3 random data	4-4
4.3.4 transparent effect	4-4
4.3.5 rolling bar effect	4-4
4.4 AEC and AGC algorithms	4-6

4.4.1	average-based algorithm	4-7
4.4.2	average luminance (YAVG)	4-9
4.5	AEC/AGC steps	4-11
4.5.1	auto exposure control (AEC)	4-11
4.5.2	night mode	4-11
4.5.3	banding mode ON with AEC	4-11
4.5.4	banding mode OFF with AEC	4-11
4.5.5	manual exposure control	4-11
4.5.6	auto gain control (AGC)	4-12
4.5.7	manual gain control	4-12
4.5.8	integration time between 1-16 rows	4-12
4.5.9	gain insertion between AEC banding steps	4-12
4.5.10	gain insertion between night mode steps	4-12
4.5.11	when AEC reaches maximum	4-12
4.6	black level calibration (BLC)	4-14
4.7	strobe flash and frame exposure	4-15
4.7.1	strobe flash control	4-15
4.8	xenon flash control	4-15
4.8.1	LED1 & 2 mode	4-16
4.8.2	LED 3 mode	4-17
4.9	frame exposure (FREX) mode	4-18
4.9.1	FREX control	4-18
4.9.2	STROBE control in FREX mode	4-21
4.10	FREX strobe flash control	4-22
4.11	one-time programmable (OTP) memory	4-23
4.11.1	OTP program	4-24
4.11.2	OTP read	4-25
5	image sensor processor digital functions	5-1
5.1	ISP general controls	5-1
5.2	defect pixel cancellation (DPC)	5-3
5.3	auto white balance (AWB)	5-3
5.4	post binning filter	5-5
5.5	picture-in-picture (PIP)	5-6

6 image sensor output interface digital functions	6-1
6.1 system control	6-1
6.2 SCCB	6-5
6.3 group register write	6-5
6.4 timing control	6-6
6.5 frame control (FC)	6-8
6.6 mobile industry processor interface (MIPI)	6-9
7 register tables	7-1
7.1 system control [0x3000 - 0x3209]	7-1
7.2 group hold control [0x3200 - 0x3208]	7-6
7.3 AEC/AGC [0x3500 - 0x373A, 0x3A00 - 0x3A21, 0x5680 - 0x5A41]	7-7
7.4 timing control [0x3800 - 0x3834]	7-12
7.5 strobe/frame exposure [0x3B00 - 0x3B0C]	7-14
7.6 OTP control [0x3D00 - 0x3D21]	7-15
7.7 BLC control [0x4000 - 0x4067]	7-16
7.8 frame control [0x4200 - 0x4202]	7-17
7.9 MIPI control [0x4800 - 0x4843]	7-18
7.10 ISP control [0x5000 - 0x5059]	7-24
7.11 AWB control [0x5180 - 0x51DF]	7-29
7.12 ISP output windows [0x5980 - 0x5988]	7-31
8 operating specifications	8-1
8.1 absolute maximum ratings	8-1
8.2 functional temperature	8-1
8.3 DC characteristics	8-2
8.4 AC characteristics	8-3
9 mechanical specifications	9-1
9.1 COB physical specifications	9-1
9.2 reconstructed wafer (RW) physical specifications	9-4
10 optical specifications	10-1
10.1 sensor array center	10-1
10.2 lens chief ray angle (CRA)	10-2
appendix A handling of RW devices	A-1
A.1 ESD /EOS prevention	A-1
A.2 particles and cleanliness of environment	A-1
A.3 other requirements	A-1

OV5648

color CMOS QSXGA (5 megapixel) image sensor with OmniBSI+™ technology

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list of figures

figure 1-1	pad diagram	1-4
figure 2-1	OV5648 block diagram	2-1
figure 2-2	reference design schematic	2-2
figure 2-3	power up timing with internal DVDD	2-4
figure 2-4	power up timing with external DVDD source	2-5
figure 2-5	message type	2-6
figure 2-6	SCCB single read from random location	2-7
figure 2-7	SCCB single read from current location	2-7
figure 2-8	SCCB sequential read from random location	2-7
figure 2-9	SCCB sequential read from current location	2-8
figure 2-10	SCCB single write to random location	2-8
figure 2-11	SCCB sequential write to random location	2-8
figure 2-12	SCCB interface timing	2-9
figure 3-1	sensor array region color filter layout	3-1
figure 3-2	example of 2x2 binning	3-2
figure 4-1	mirror and flip samples	4-1
figure 4-2	image windowing	4-2
figure 4-3	color bar types	4-3
figure 4-4	color, black and white square bars	4-3
figure 4-5	transparent effect	4-4
figure 4-6	rolling bar effect	4-4
figure 4-7	desired convergence	4-7
figure 4-8	average-based window definition	4-9
figure 4-9	xenon flash mode	4-15
figure 4-10	LED 1 & 2 mode - one pulse output	4-16
figure 4-11	LED 1 & 2 mode - multiple pulse output	4-17
figure 4-12	LED 3 mode	4-17
figure 4-13	FREX modes	4-18
figure 4-14	FREX mode 1 timing diagram	4-18
figure 4-15	FREX mode 2 timing diagram (when shutter delay is longer than exposure time)	4-20
figure 4-16	FREX mode 2 timing diagram (when shutter delay is shorter than exposure time)	4-20
figure 4-17	STROBE control in FREX mode	4-21

figure 5-1	picture-in-picture image	5-6
figure 5-2	picture-in-picture function block diagram	5-6
figure 9-1	COB die specifications	9-1
figure 9-2	OV5648 RW physical diagram	9-5
figure 10-1	sensor array center	10-1
figure 10-2	chief ray angle (CRA)	10-2

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list of tables

table 1-1	signal descriptions	1-1
table 1-2	pad configuration under various conditions	1-2
table 2-1	format and frame rate	2-3
table 2-2	SCCB interface timing specifications	2-9
table 2-3	SCCB interface register	2-10
table 2-4	group hold registers	2-10
table 3-1	horizontal and vertical binning registers	3-2
table 4-1	mirror flip control registers	4-1
table 4-2	image windowing registers	4-2
table 4-3	test pattern registers	4-5
table 4-4	AEC/AGC control function registers	4-6
table 4-5	average based control function registers	4-8
table 4-6	average luminance control function registers	4-9
table 4-7	AEC/AGC registers	4-12
table 4-8	BLC control functions	4-14
table 4-9	flashlight modes	4-15
table 4-10	FREX mode 2 timing point description	4-19
table 4-11	FREX strobe control functions	4-22
table 4-12	OTP control function registers	4-23
table 5-1	ISP general control registers	5-1
table 5-2	defect pixel cancellation registers	5-3
table 5-3	AWB control registers	5-3
table 5-4	post binning control registers	5-5
table 5-5	PIP control registers	5-7
table 5-6	SPI control registers	5-7
table 6-1	system control registers	6-1
table 6-2	system control registers	6-5
table 6-3	group hold control registers	6-5
table 6-4	timing control registers	6-6
table 6-5	frame control registers	6-8
table 6-6	MIPI transmitter registers	6-9
table 7-1	system control registers	7-1

table 7-2	group hold control registers	7-6
table 7-3	AEC/AGC registers	7-7
table 7-4	system timing registers	7-12
table 7-5	strobe/frame exposure control registers	7-14
table 7-6	OTP control registers	7-15
table 7-7	BLC registers	7-16
table 7-8	frame control registers	7-17
table 7-9	MIPI registers	7-18
table 7-10	ISP control registers	7-24
table 7-11	AWB registers	7-29
table 7-12	ISP output windows registers	7-31
table 8-1	absolute maximum ratings	8-1
table 8-2	functional temperature	8-1
table 8-3	DC characteristics (-30°C < T _J < 70°C)	8-2
table 8-4	timing characteristics	8-3
table 9-1	pad location coordinates	9-1
table 9-2	RW physical dimensions	9-4
table 10-1	CRA versus image height plot	10-2

1 signal descriptions

table 1-1 lists the signal descriptions and their corresponding pad numbers for the OV5648 image sensor. The die information is shown in **section 9**.

table 1-1 signal descriptions (sheet 1 of 2)

pad number	signal name	pad type	description	default status
01	DVDD	power	digital circuit power	1.5V
02	AGND	ground	analog ground	
03	AVDD	power	analog power	2.8V
04	DOGND	ground	I/O ground	
05	SIOD	I/O	SCCB interface data	
06	SIOC	input	SCCB interface input clock	
07	DVDD	power	digital circuit power	1.5V
08	SCK	I/O	SPI interface input clock	
09	SDI0	I/O	SPI interface data input 0	
10	SDI1	I/O	SPI interface data input 1	
11	DOVDD	power	I/O power	1.8/2.8V
12	GPIO	I/O	general purpose I/O	
13	VSYNC	I/O	video output vertical signal	
14	FREX	I/O	frame exposure input / mechanical shutter	
15	DOGND	ground	I/O ground	
16	STROBE	output	frame exposure output indicator	
17	RESETB	input	system reset (active low with pull up resistor)	
18	PWDNB	input	power down (active low with pull down resistor)	
19	DVDD	power	digital circuit power	1.5V
20	TM	input	test mode (active high with pull down resistor)	
21	AVDD	power	analog power	2.8V
22	AGND	ground	analog ground	
23	AGND	ground	analog ground	
24	AVDD	power	analog power	2.8V
25	HVDD	input	reference	

table 1-1 signal descriptions (sheet 2 of 2)

pad number	signal name	pad type	description	default status
26	NVDD	input	reference	
27	PVDD	power	PLL analog power	2.8V
28	XVCLK	input	system clock input	
29	DOVDD	power	I/O power	1.8V/2.8V
30	DVDD	power	digital circuit power	1.5V
31	DOGND	ground	I/O ground	
32	DOVDD	power	I/O power	1.8V/2.8V
33	MDP0	output	MIPI data positive output	
34	MDN0	output	MIPI data negative output	
35	EGND	ground	MIPI ground	
36	MCP	output	MIPI clock positive output	
37	MCN	output	MIPI clock negative output	
38	EVDD	power	MIPI power	1.5V
39	MDP1	output	MIPI data positive output	
40	MDN1	output	MIPI data negative output	
41	DOVDD	power	I/O power	
42	DOGND	ground	I/O ground	
43	DVDD	power	digital circuit power	1.5V
44	DOVDD	power	I/O power	1.8V/2.8V

table 1-2 pad configuration under various conditions (sheet 1 of 2)

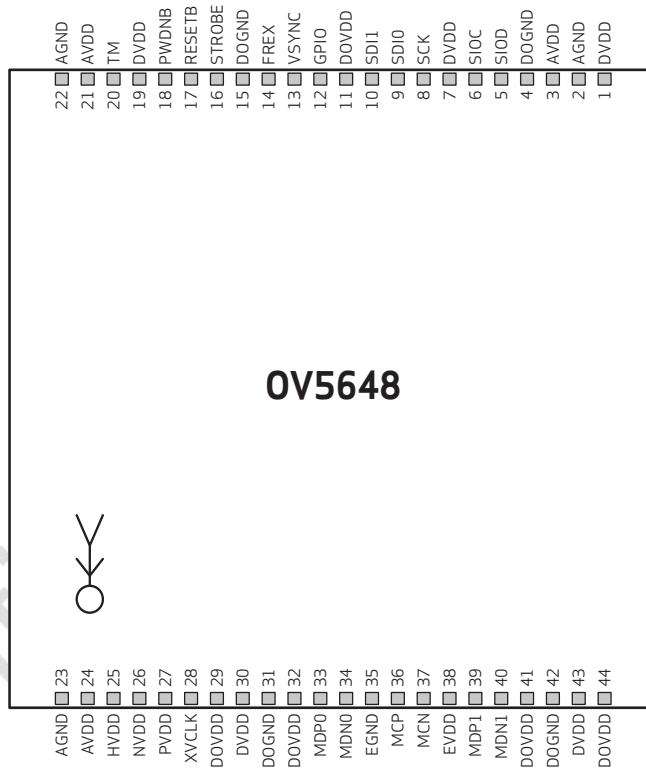
pad number	signal	RESET ^a	post-RESET	software sleep	hardware standby (power down pin = 0)
05	SIOD	high-z	I/O	I/O	open drain
06	SIOC	high-z	input	input	high-z
08	SCK	high-z	input by default (configurable)	high-z by default (configurable)	high-z by default (configurable)
09	SDI0	high-z	input by default (configurable)	high-z by default (configurable)	high-z by default (configurable)
10	SDI1	high-z	input by default (configurable)	high-z by default (configurable)	high-z by default (configurable)

table 1-2 pad configuration under various conditions (sheet 2 of 2)

pad number	signal	RESET ^a	post-RESET	software sleep	hardware standby (power down pin = 0)
12	GPIO	high-z	input by default (configurable)	high-z by default (configurable)	high-z by default (configurable)
13	VSYNC	high-z	input by default (configurable)	high-z by default (configurable)	high-z by default (configurable)
14	FREX	high-z	input by default (configurable)	high-z by default (configurable)	high-z by default (configurable)
16	STROBE	high-z	input by default (configurable)	high-z by default (configurable)	high-z by default (configurable)
17	RESETB	input	input	input	input
18	PWDNB	input	input	input	input
20	TM	input	input	input	input
25	HVDD	high-z	open drain	open drain	high-z
26	NVDD	high-z	open drain	open drain	high-z
28	XVCLK	input	input	input	high-z
33	MDP0	high-z	LP1 (configurable)	LP1 (configurable)	LP1 (configurable)
34	MDN0	high-z	LP1 (configurable)	LP1 (configurable)	LP1 (configurable)
36	MCP	high-z	LP1 (configurable)	LP1 (configurable)	LP1 (configurable)
37	MCN	high-z	LP1 (configurable)	LP1 (configurable)	LP1 (configurable)
39	MDP1	high-z	LP1 (configurable)	LP1 (configurable)	LP1 (configurable)
40	MDN1	high-z	LP1 (configurable)	LP1 (configurable)	LP1 (configurable)

a. PWDN pin = 1 when chip power up

figure 1-1 pad diagram



5648_COB_DS_1.1

2 system level description

2.1 overview

The OV5648 is a low voltage, high performance, 5 megapixel CMOS image sensor that provides 2592x1944 video output using OmniBSI+™ technology. It provides multiple resolution raw images via the control of the serial camera control bus.

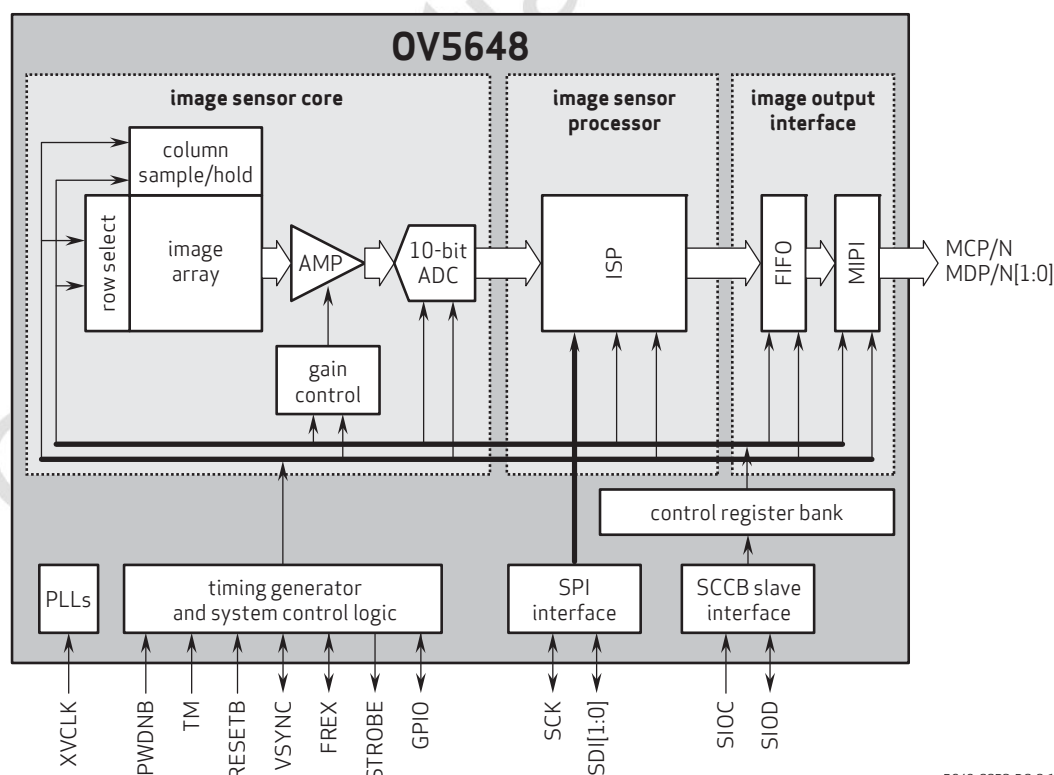
The OV5648 has an image array capable of operating up to 15 fps in 2592x1944 resolution with user control of image quality, data transfer, camera functions through the SCCB interface. The OV5648 uses innovative OmniBSI+ technology to improve the sensor performance without physical or optical trade-offs.

The OV5648 includes a one-time programmable (OTP) memory.

2.2 architecture

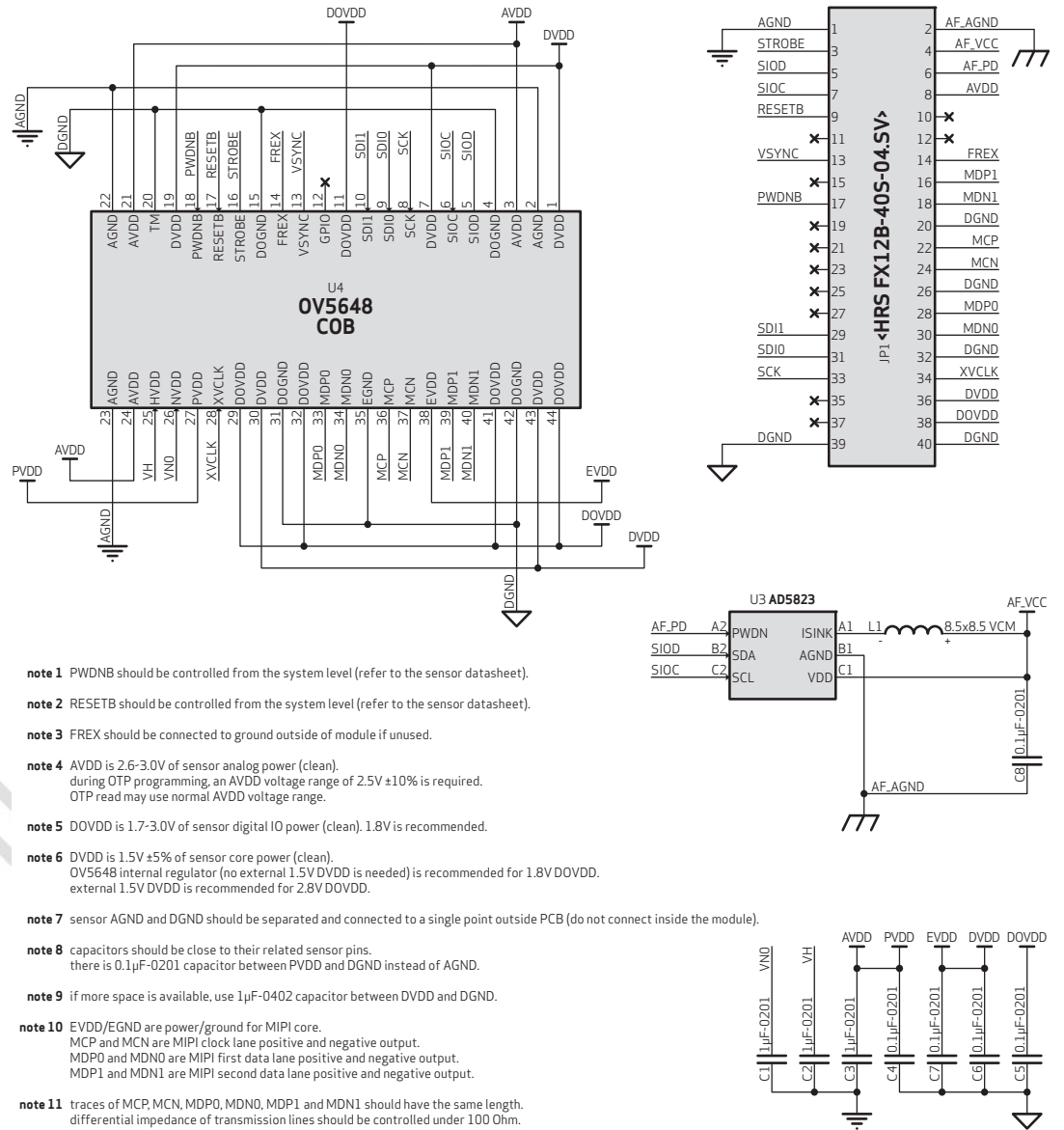
The OV5648 sensor core generates streaming pixel data at a constant frame rate, indicated by VSYNC. **figure 2-1** shows the functional block of the OV5648 image sensor. **figure 2-2** shows an example application of the OV5648.

figure 2-1 OV5648 block diagram



5648_CSP3_DS_2.1

figure 2-2 reference design schematic



5648_COB_DS_2.2

2.3 format and frame rate

table 2-1 format and frame rate

format	resolution	frame rate	methodology	pixel clock
5 Mpixel	2592x1944	15 fps	full resolution	84 MHz
1080p	1920x1080	30 fps	cropping	84 MHz
quarter 5Mp	1296x972	45 fps	cropping, subsampling/binning	84 MHz
720p	1280x720	60 fps	cropping, subsampling/binning	84 MHz
VGA	640x480	90 fps	cropping, subsampling/binning	84 MHz

2.4 I/O control

2.4.1 system clock control

The OV5648 has an on-chip PLL which generates a default 84 MHz clock from a 6~27 MHz input clock. A built-in programmable clock divider generates different internal frequencies.

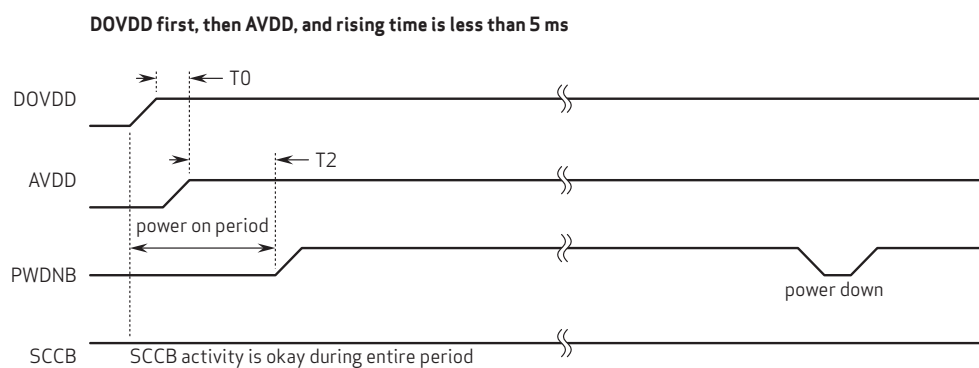
2.5 power up sequence

Based on the system power configuration (1.8V or 2.8V for I/O power), using external DVDD or internal DVDD, the power up sequence will differ. If 1.8V is used for I/O power, using the internal DVDD is preferred. If 2.8V is used for I/O power, due to the high voltage drop of the internal DVDD regulator, there is a potential heat issue. Hence, for a 2.8V power system, OmniVision recommends using an external DVDD source. Due to the higher power-down current when using an external DVDD source, OmniVision strongly recommends cutting off all power supplies, including the external DVDD, when the sensor is not in use.

2.5.1 power up with internal DVDD

For powering up with the internal DVDD and SCCB access during the power ON period, the following conditions must occur:

1. when DOVDD and AVDD are turned ON, make sure DOVDD becomes stable before AVDD becomes stable
2. PWDNB is active low with an asynchronized design (does not need clock)
3. PWDNB must be low during the power up period
4. for PWDNB to go high, power must first become stable (AVDD to PWDNB \geq 5 ms)
5. RESETB is active low with an asynchronized design
6. state of RESETB does not matter during power up period once DOVDD is stable
7. master clock XVCLK should be provided at least 1 ms before the host accesses the sensor's registers
8. host can access SCCB bus (if shared) during entire period. 20 ms after PWDNB goes high or 20 ms after RESETB goes high if reset is inserted after PWDNB goes high, the host can access the sensor's registers to initialize the sensor

figure 2-3 power up timing with internal DVDD

note $T_0 \geq 0$ ms: delay from DOVDD stable to AVDD stable
 $T_2 \geq 5$ ms: delay from AVDD stable to sensor power up stable

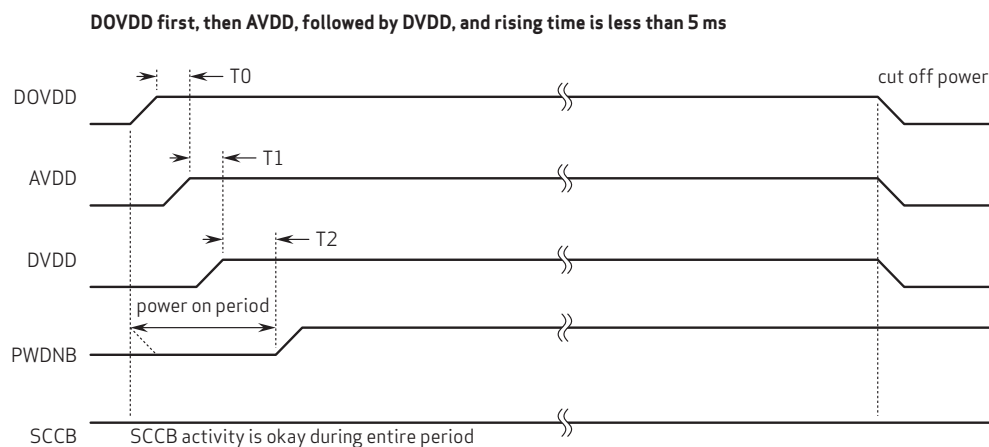
5648_DS_2_3

2.5.2 power up with external DVDD source

For powering up with an external DVDD source and SCCB access during the power ON period, the following conditions must occur:

1. when DOVDD and AVDD are turned ON, make sure DOVDD becomes stable before AVDD becomes stable
2. when AVDD and DVDD are turned ON, make sure AVDD becomes stable before DVDD becomes stable
3. PWDNB is active low with an asynchronized design (does not need clock)
4. for PWDNB to go high, power must first become stable (DVDD to PWDNB ≥ 5 ms)
5. all power supplies are cut off when the camera is not in use (power down mode is not recommended)
6. RESETB is active low with an asynchronized design
7. state of RESETB does not matter during power up period once DOVDD is stable
8. master clock XVCLK should be provided at least 1 ms before the host accesses the sensor's registers
9. host can access SCCB bus (if shared) during entire period. 20 ms after PWDNB goes high or 20 ms after RESETB goes high if reset is inserted after PWDNB goes low, the host can access the sensor's registers to initialize the sensor

figure 2-4 power up timing with external DVDD source



note $T_0 \geq 0$ ms: delay from DOVDD stable to AVDD stable
 $T_1 \geq 0$ ms: delay from AVDD stable to DVDD stable
 $T_2 \geq 5$ ms: delay from DVDD stable to sensor power up stable

5648_DS_2_4

2.6 reset

Two reset modes are available for the OV5648:

- hardware reset
- SCCB software reset

The OV5648 sensor includes a RESETB pad that forces a complete hardware reset when it is pulled low (GND). The OV5648 clears all registers and resets them to their default values when a hardware reset occurs. A reset can also be initiated through the SCCB interface by setting register 0x0103[0] to high.

The whole chip will be reset during power up. Manually applying a hard reset upon power up is recommended even though the on-chip power up reset is included. The hard reset is active low with an asynchronized design. The reset pulse width should be greater than or equal to 1 ms.

2.7 hardware and software standby

Two suspend modes are available for the OV5648:

- hardware standby
- software standby

To initiate hardware standby mode, the PWDNB pad must be tied to low while in MIPI mode. Set register 0x3018[4:3] to 2'b11 before the PWDNB pin is set to low. When this occurs, the OV5648 internal device clock is halted and all internal counters are reset and registers are maintained.

Executing a software standby (0x0100[0]) through the SCCB interface suspends internal circuit activity but does not halt the device clock. All register content is maintained in both modes.

2.8 serial camera control bus (SCCB) interface

The Serial Camera Control Bus (SCCB) interface controls the image sensor operation. Refer to the *OmniVision Technologies Serial Camera Control Bus (SCCB) Specification* for detailed usage of the serial control port.

2.8.1 data transfer protocol

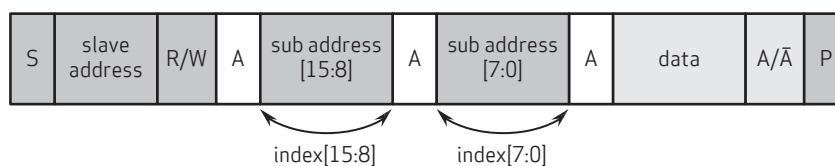
The data transfer of the OV5648 follows the SCCB protocol.

2.8.2 message format

The OV5648 supports the message format shown in **figure 2-5**. The 7-bit address of the OV5648 is 0x36 by default but can be programmed using register 0x3002[7:1]. The repeated START (Sr) condition is not shown in **figure 2-6**, but is shown in **figure 2-7** and **figure 2-8**.

figure 2-5 message type

message type: 16-bit sub-address, 8-bit data, and 7-bit slave address



<input type="checkbox"/>	from slave to master	S	START condition	A	acknowledge
<input checked="" type="checkbox"/>	from master to slave	P	STOP condition	Ā	negative acknowledge
<input type="checkbox"/>	direction depends on operation	Sr	repeated START condition		

5648_DS_2_5

2.8.3 read / write operation

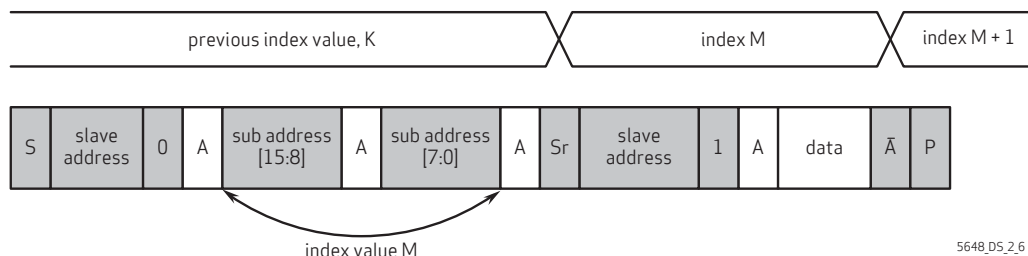
The OV5648 supports four different read operations and two different write operations:

- a single read from random locations
- a sequential read from random locations
- a single read from current location
- a sequential read from current location
- single write to random locations
- sequential write starting from random location

The sub-address in the sensor automatically increases by one after each read/write operation.

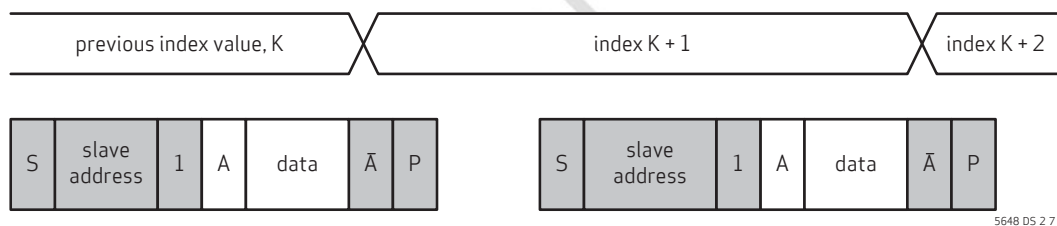
In a single read from random locations, the master does a dummy write operation to desired sub-address, issues a repeated start condition and then addresses the camera again with a read operation. After acknowledging its slave address, the camera starts to output data onto the SIOD line as shown in **figure 2-6**. The master terminates the read operation by setting a negative acknowledge and stop condition.

figure 2-6 SCCB single read from random location



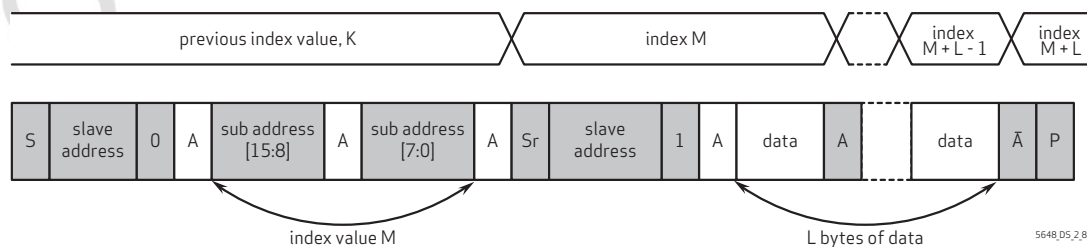
If the host addresses the camera with read operation directly without the dummy write operation, the camera responds by setting the data from last used sub-address to the SIOD line as shown in **figure 2-7**. The master terminates the read operation by setting a negative acknowledge and stop condition.

figure 2-7 SCCB single read from current location



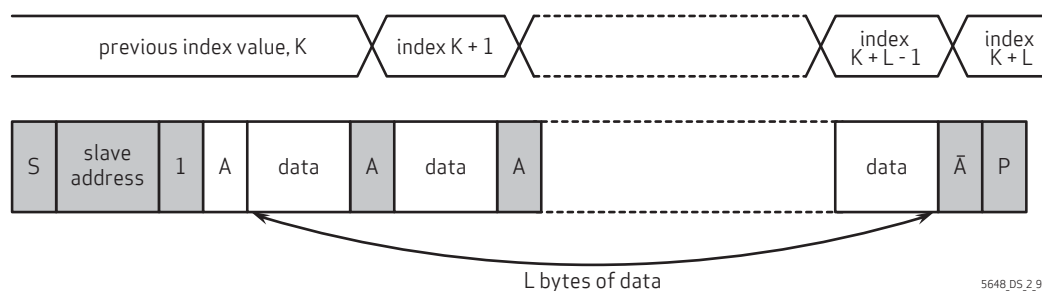
The sequential read from a random location is illustrated in **figure 2-8**. The master does a dummy write to the desired sub-address, issues a repeated start condition after acknowledge from slave and addresses the slave again with read operation. If a master issues an acknowledge after receiving data, it acts as a signal to the slave that the read operation shall continue from the next sub-address. When master has read the last data byte, it issues a negative acknowledge and stop condition.

figure 2-8 SCCB sequential read from random location



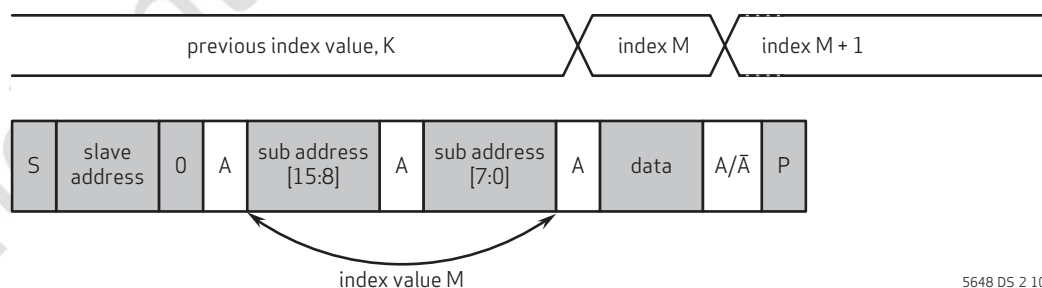
The sequential read from current location is similar to a sequential read from a random location. The only exception is that there is no dummy write operation, as shown in **figure 2-9**. The master terminates the read operation by setting a negative acknowledge and stop condition.

figure 2-9 SCCB sequential read from current location



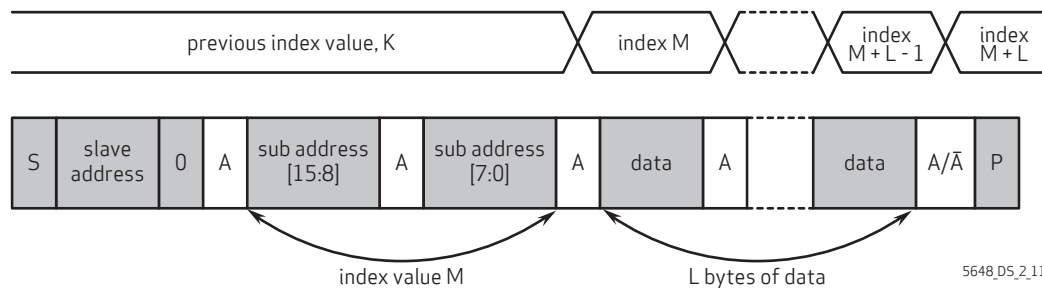
The write operation to a random location is illustrated in **figure 2-10**. The master issues a write operation to the slave, sets the sub-address and data correspondingly after the slave has acknowledged. The write operation is terminated with a stop condition from the master.

figure 2-10 SCCB single write to random location



The sequential write is illustrated in **figure 2-11**. The slave automatically increments the sub-address after each data byte. The sequential write operation is terminated with stop condition from the master.

figure 2-11 SCCB sequential write to random location



2.8.4 SCCB timing

figure 2-12 SCCB interface timing

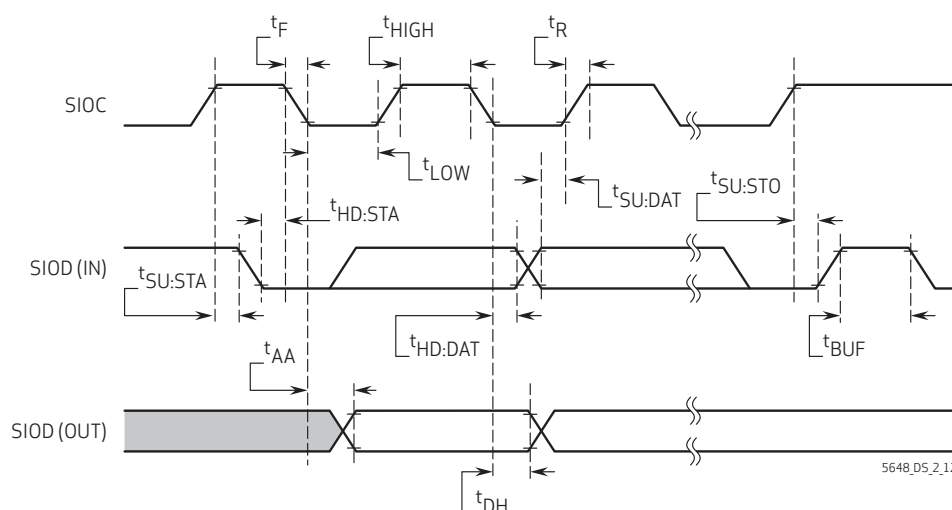


table 2-2 SCCB interface timing specifications^{ab}

symbol	parameter	min	typ	max	unit
f_{SIOC}	clock frequency			400	kHz
t_{LOW}	clock low period	1.3			μs
t_{HIGH}	clock high period	0.6			μs
t_{AA}	SIOC low to data out valid	0.1		0.9	μs
t_{BUF}	bus free time before new start	1.3			μs
$t_{HD:STA}$	start condition hold time	0.6			μs
$t_{SU:STA}$	start condition setup time	0.6			μs
$t_{HD:DAT}$	data in hold time	0			μs
$t_{SU:DAT}$	data in setup time	0.1			μs
$t_{SU:STO}$	stop condition setup time	0.6			μs
t_R, t_F	SCCB rise/fall times			0.3	μs
t_{DH}	data out hold time	0.05			μs

- a. SCCB timing is based on 400 kHz mode
- b. timing measurement shown at the beginning of the rising edge and/or of the falling edge signifies 30%, timing measurement shown in the middle of the rising/falling edge signifies 50%, timing measurement shown at the beginning of the rising edge and/or of the falling edge signifies 70%

2.8.5 group write

Group write is supported in order to update a group of registers in the same frame. These registers are guaranteed to be written prior to the internal latch at the frame boundary.

The OV5648 supports up to four groups. These groups share a total of 512 bytes of RAM and the size of each group is programmable by adjusting the start address. Each setting requires three bytes, two for the address and one for data.

table 2-3 SCCB interface register

address	register name	default value	R/W	description
0x3104	SCCB_PLL	0x20	RW	Bit[6]: sda_vblank Bit[5]: r_sys_sel (sclk) 0: pll2_dacclk 1: pll1_sclk Bit[4]: r_dac_sel (sen_clk) 0: pll2_dacclk 1: pll1_sclk Bit[3]: r_dacclk (dacclk) 0: pll2_dacclk 1: pll1_sclk Bit[2:0]: Debug mode

table 2-4 group hold registers

address	register name	default value	R/W	description
0x3208	GROUP ACCESS	—	W	Group Access Bit[7:4]: group_ctrl 0000: Group hold start 0001: Group hold end 1010: Group launch others: Reserved Bit[3:0]: group_id 0000: Group bank 0, default start from address 0x00 0001: Group bank 1, default start from address 0x40 0010: Group bank 2, default start from address 0x80 0011: Group bank 3, default start from address 0xB0 others: Reserved
0x3209	GRP0_PERIOD	0x00	RW	Frames For Staying in Group 0
0x320A	GRP1_PERIOD	0x00	RW	Frames For Staying in Group 1
0x320B	GRP_SWCTRL	0x01	RW	Bit[3]: group_switch_repeat Bit[2]: context_en Bit[1:0]: Second group selection

3 block level description

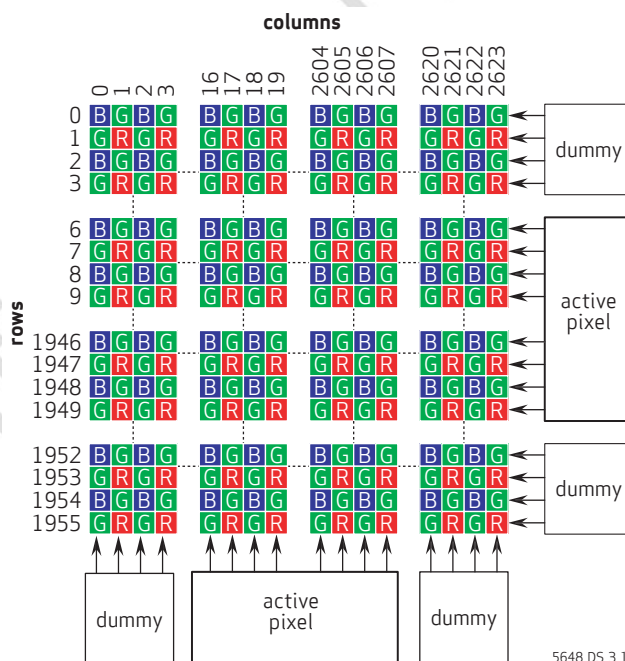
3.1 pixel array structure

The OV5648 sensor has an image array of 2624 columns by 1956 rows (5,132,544 pixels). **figure 3-1** shows a cross-section of the image sensor array.

The color filters are arranged in a Bayer pattern. The primary color BG/GR array is arranged in line-alternating fashion. Of the 5,132,544 pixels, 5,038,848 (2592x1944) are active pixels and can be output. The other pixels are used for black level calibration and interpolation. The center 2592x1944 is suggested to be output from the whole active pixel array. The backend processor can use the boundary pixels for additional processing.

The sensor array design is based on a field integration read-out system with line-by-line transfer and an electronic shutter with a synchronous pixel read-out scheme.

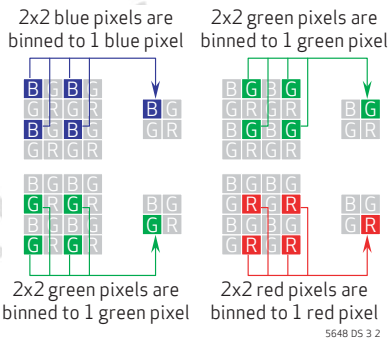
figure 3-1 sensor array region color filter layout



3.2 subsampling

There are two subsampling modes in the OV5648: binning and skipping. Both are acceptable methods of reducing output resolution while maintaining the field of view. Binning is usually preferred as it increases the pixel's signal-to-noise ratio. When the binning function is ON, voltage levels of adjacent pixels are averaged. In skipping mode (binning function is OFF), alternate pixels, which are not output, are merely skipped. The OV5648 supports 2x2 binning. **figure 3-2** illustrates 2x2 binning, where the voltage levels of two horizontal (2x1) adjacent same-color pixels are averaged before entering the ADC. See **table 3-1** for horizontal and vertical binning registers.

figure 3-2 example of 2x2 binning



Sensor timing adjustment is necessary after applying binning. Please consult your local OmniVision FAE for details.

table 3-1 horizontal and vertical binning registers

address	register name	default value	R/W	description	
0x3820	TIMING_TC_REG20	0x40	RW	Bit[0]:	Vertical binning 0: Disable 1: Enable
0x3821	TIMING_TC_REG21	0x00	RW	Bit[0]:	Horizontal binning 0: Disable 1: Enable

3.3 analog amplifier

When the column sample/hold circuit has sampled one row of pixels, the pixel data will shift out one-by-one into an analog amplifier.

3.4 10-bit A/D converters

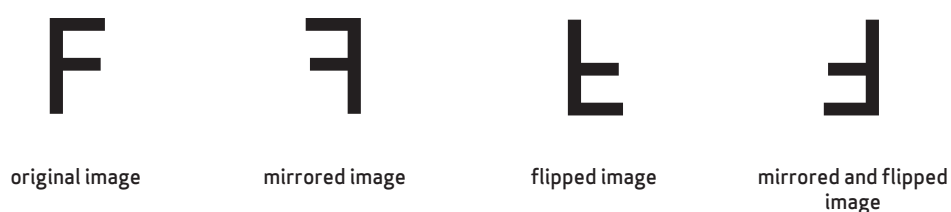
The balanced signal is then digitized by the on-chip 10-bit ADC. The actual conversion rate is determined by the frame rate and resolution.

4 image sensor core digital functions

4.1 mirror and flip

The OV5648 provides mirror and flip read-out modes, which respectively reverse the sensor data read-out order horizontally and vertically (see **figure 4-1**). In flip mode, the OV5648 does not need additional settings because the ISP block will auto-detect whether the pixel is in the red line or blue line and make the necessary adjustments.

figure 4-1 mirror and flip samples



5648_DS_4.1

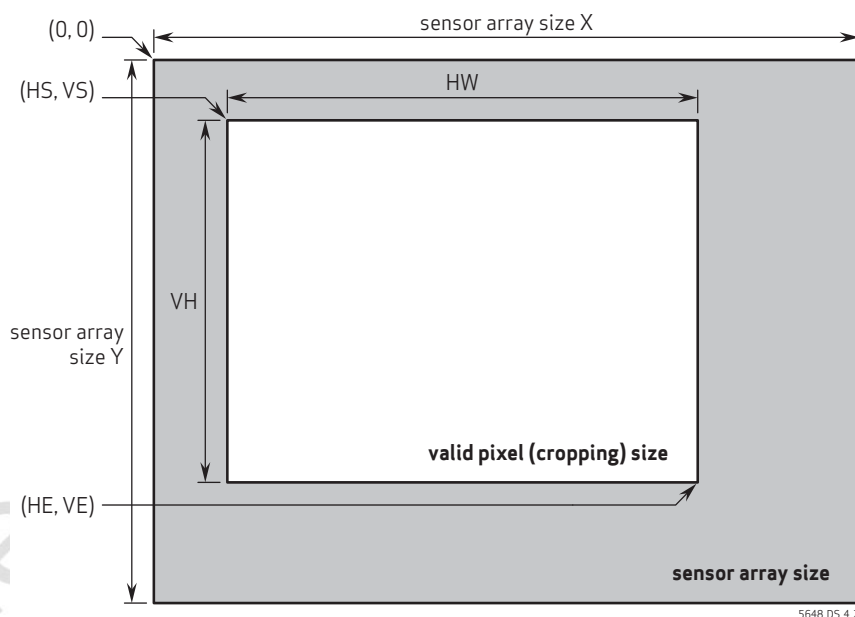
table 4-1 mirror flip control registers

address	register name	default value	R/W	description
0x3820	TIMING_TC_REG20	0x40	RW	Timing Control Bit[2]: ISP vertical flip Bit[1]: Sensor vertical flip
0x3821	TIMING_TC_REG21	0x00	RW	Timing Control Bit[2]: ISP mirror Bit[1]: Sensor mirror

4.2 image windowing

An image windowing area is defined by four parameters, x_addr_start , x_addr_end , y_addr_start , y_addr_end . By properly setting the parameters, any portion or size within the sensor array can be defined as an visible area. Windowing is achieved by simply masking off the pixels outside of the defined window; thus, the original timing will not be affected.

figure 4-2 image windowing



5648_DS_4.2

table 4-2 image windowing registers

address	register name	default value	R/W	description
0x3800	TIMING_X_ADDR_START	0x00	RW	Bit[3:0]: $x_addr_start[11:8]$
0x3801	TIMING_X_ADDR_START	0x0C	RW	Bit[7:0]: $x_addr_start[7:0]$
0x3802	TIMING_Y_ADDR_START	0x00	RW	Bit[3:0]: $y_addr_start[11:8]$
0x3803	TIMING_Y_ADDR_START	0x04	RW	Bit[7:0]: $y_addr_start[7:0]$
0x3804	TIMING_X_ADDR_END	0x0A	RW	Bit[3:0]: $x_addr_end[11:8]$
0x3805	TIMING_X_ADDR_END	0x33	RW	Bit[7:0]: $x_addr_end[7:0]$
0x3806	TIMING_Y_ADDR_END	0x07	RW	Bit[3:0]: $y_addr_end[11:8]$
0x3807	TIMING_Y_ADDR_END	0xA3	RW	Bit[7:0]: $y_addr_end[7:0]$

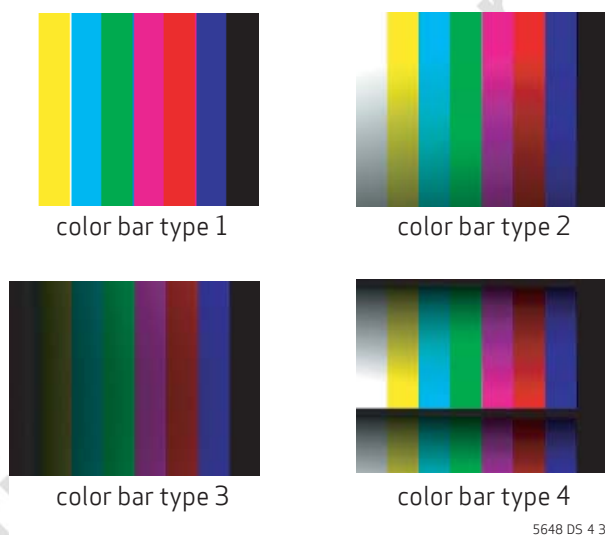
4.3 test pattern

For testing purposes, the OV5648 offers three types of test patterns, color bar, square and random data. The OV5648 also offers two effects: transparent effect and rolling bar effect. The output type of test pattern is controlled by register 0x503D[1:0] (test_pattern_type).

4.3.1 color bar

There are four types of color bars shown in **figure 4-3**. The output type of color the color bar can be selected by bar style register 0x503D[3:2].

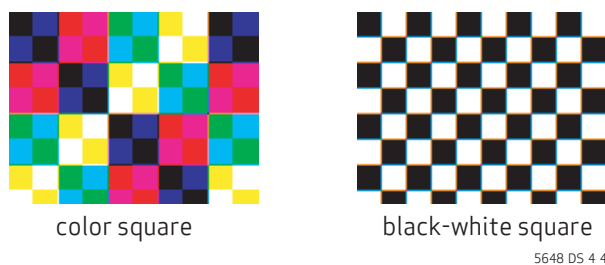
figure 4-3 color bar types



4.3.2 square

There are two types of square patterns: color square and black-white square. Register 0x503D[4] (squ_bw) determines which type of square will be output.

figure 4-4 color, black and white square bars



4.3.3 random data

There are two types of random data test patterns: frame-changing and frame-fixed random data. The output type of random data is determined by register 0x503E[4] (rnd_same). The random seed is set by register 0x503E[3:0] (rnd_seed).

4.3.4 transparent effect

The transparent effect is enabled by register 0x503D[5] (transparent_mode). If this register is set, the transparent test pattern will be used. **figure 4-5** is an example which shows a transparent color bar image.

figure 4-5 transparent effect



5648_DS_4.5

4.3.5 rolling bar effect

The rolling bar is set by register 0x503D[6] (rolling_bar). If it is set, an inverted-color rolling bar will roll up and down. **figure 4-6** is an example which shows a rolling bar on a color bar image.

figure 4-6 rolling bar effect



5648_DS_4.6

table 4-3 test pattern registers

address	register name	default value	R/W	description
0x503D	ISP_CTRL3D	0x00	RW	Bit[7]: test_pattern_en 0: Disable 1: Enable Bit[6]: rolling_bar 0: Disable rolling bar 1: Enable rolling bar Bit[5]: transparent_mode 0: Disable 1: Enable Bit[4]: squ_bw_mode 0: Output square is color square 1: Output square is black-white square Bit[3:2]: bar_style When set to different value, the different type color bar will be output Bit[1:0]: test_pattern_type 00: Color bar 01: Random data 10: Square 11: Input data
0x503E	ISP_CTRL3E	0x00	RW	Bit[6]: win_cut_en Bit[5]: isp_test 0: Two lowest bits are 1 1: Two lowest bits are 0 Bit[4]: rnd_same 0: Frame changing random data pattern 1: Frame-fixed random data pattern Bit[3:0]: rnd_seed Initial seed for random data pattern

4.4 AEC and AGC algorithms

The auto exposure control (AEC) and auto gain control (AGC) allows the image sensor to adjust the image brightness to a desired range by setting the proper exposure time and gain applied to the image. Besides automatic control, exposure time and gain can be set manually from external control. The related registers are listed in **table 4-4**

table 4-4 AEC/AGC control function registers

address	register name	default value	R/W	description
0x3500	EXPOSURE	0x00	RW	Bit[3:0]: Exposure[19:16] Exposure in units of 1/16 line
0x3501	EXPOSURE	0x02	RW	Bit[7:0]: Exposure[15:8] Exposure in units of 1/16 line
0x3502	EXPOSURE	0x00	RW	Bit[7:0]: Exposure[7:0] Exposure in units of 1/16 line; lower four bits are a fraction of a line; they should be 0 since OV5648 does not support fraction line exposure
0x3503	MANUAL CTRL	0x00	RW	Bit[5:4]: Gain latch timing delay x0: Gain has no latch delay 01: Gain delay of 1 frame 11: Gain delay of 2 frames Bit[1]: AGC manual 0: Auto enable 1: Manual enable Bit[0]: AEC manual 0: Auto enable 1: Manual enable
0x350A	AGC	0x00	RW	Bit[1:0]: Gain[9:8] AGC real gain output high byte Gain = {0x350A[1:0], 0x350B[7:0]}/16
0x350B	AGC	0x10	RW	Bit[7:0]: Gain[7:0] AGC real gain output low byte

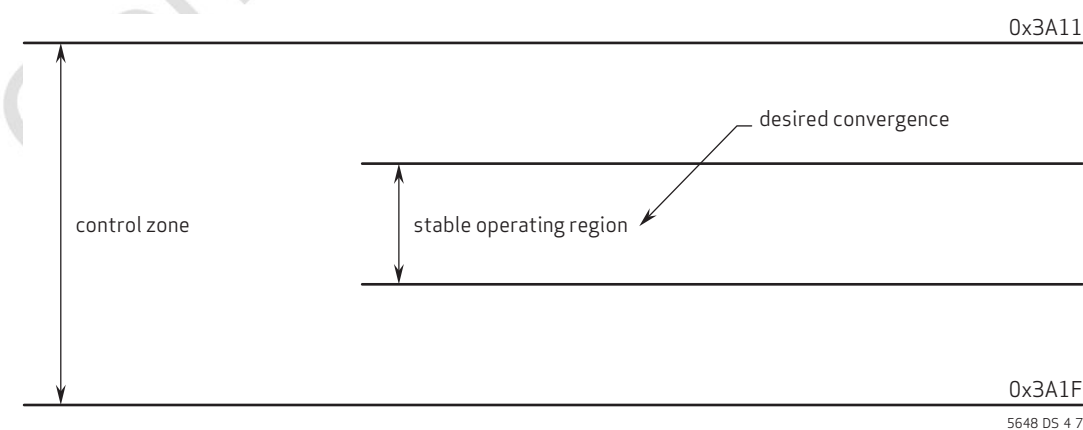
4.4.1 average-based algorithm

The average-based AEC controls image luminance using registers **WPT** (0x3A0F), **BPT** (0x3A10), **WPT2** (0x3A1B), and **BPT2** (0x3A1E). In average-based mode, the value of register **WPT** (0x3A0F) indicates the high threshold value for image change from unstable to stable state, and the value of register **BPT** (0x3A10) indicates the low threshold value for image change from unstable to stable state. The value of register **WPT2** (0x3A1B) indicates the high threshold value for image change from stable state to unstable state and the value of register **BPT2** (0x3A1E) indicates the low threshold value for image change from stable state to unstable state. When the target image luminance average value AVG (0x5693) is within the range specified by registers **WPT2** (0x3A1B) and **BPT2** (0x3A1E), the AEC keeps the image exposure and gain. When register AVG (0x5693) is greater than the value in register **WPT2** (0x3A1B), the AEC will decrease the image exposure and gain until it falls into the range of {0x3A10, 0x3A0F}. When register AVG (0x5693) is less than the value in register **BPT2** (0x3A1E), the AEC will increase the image exposure and gain until it falls into the range of {0x3A10, 0x3A0F}. Accordingly, the value in register **WPT** (0x3A0F) should be greater than the value in register **BPT** (0x3A10). The value of register **WPT2** should be no less than the value of register **WPT** (0x3A0F), and the value of register **BPT2** (0x3A1E) should be no greater than the value of **BPT** (0x3A10).

The AEC function supports both manual and auto speed selections in order to bring the image exposure into the range set by the values in registers **WPT** (0x3A0F) and **BPT** (0x3A10). For manual speed mode, the step is fixed and supports both normal and fast modes. Setting the AEC to normal mode will allow for the slowest step increment or decrement in image exposure to maintain the specified range. Setting the AEC to fast mode will provide for an approximate ten-step increment or decrement in image exposure to maintain the specified range. For auto speed mode, the step will automatically be adjusted according to the difference between the target and present values. The auto ratio of steps can be set by register bits AEC CTRL05[4:0] (0x3A05).

Register HIGH VPT (0x3A11) and register LOW VPT (0x3A1F) controls the fast AEC range in manual speed mode. If the target image AVG (0x5693) is greater than HIGH VPT (0x3A11), AEC will decrease by half. If register AVG (0x5693) is less than LOW VPT (0x3A1F), AEC will double, as shown in **figure 4-7**. These registers have no effect in auto speed mode.

figure 4-7 desired convergence



5648_DS_4.7

table 4-5 average based control function registers

address	register name	default value	R/W	description
0x3A0F	WPT	0x78	RW	Bit[7:0]: WPT Stable range high limit (from unstable state to stable state)
0x3A10	BPT	0x68	RW	Bit[7:0]: BPT Stable range low limit (from unstable state to stable state)
0x3A11	HIGH VPT	0xD0	RW	Bit[7:0]: vpt_high Fast zone high limit (when step ratio auto mode is disabled)
0x3A1B	WPT2	0x78	RW	Bit[7:0]: wpt2 Stable range high limit (from stable state to unstable state)
0x3A1E	BPT2	0x68	RW	Bit[7:0]: bpt2 Stable range low limit (from stable state to unstable state)
0x3A1F	LOW VPT	0x40	RW	Bit[7:0]: vpt_low Fast zone low limit (when step ratio auto mode is disabled)

For the average-based AEC/AGC algorithm, the measured window is horizontally and vertically adjustable and divided by sixteen (4x4) zones (see [figure 4-8](#)). Each zone (or block) is 1/16th of the image and has a 4-bit weight in calculating the average luminance (YAVG). The final YAVG is the weighted average of the sixteen zones. The 4-bit weight could be $n/16$ where n is from 0 to 15.

4.4.2 average luminance (YAVG)

Auto exposure time calculation is based on a frame brightness average value. By properly setting `x_start`, `x_window`, `y_start`, and `y_window` as shown in **figure 4-8**, a 4x4 grid average window is defined. It will automatically divide each zone into 4x4 zones. The average value is the weighted average of the 16 sections. **table 4-6** lists the corresponding registers.

figure 4-8 average-based window definition

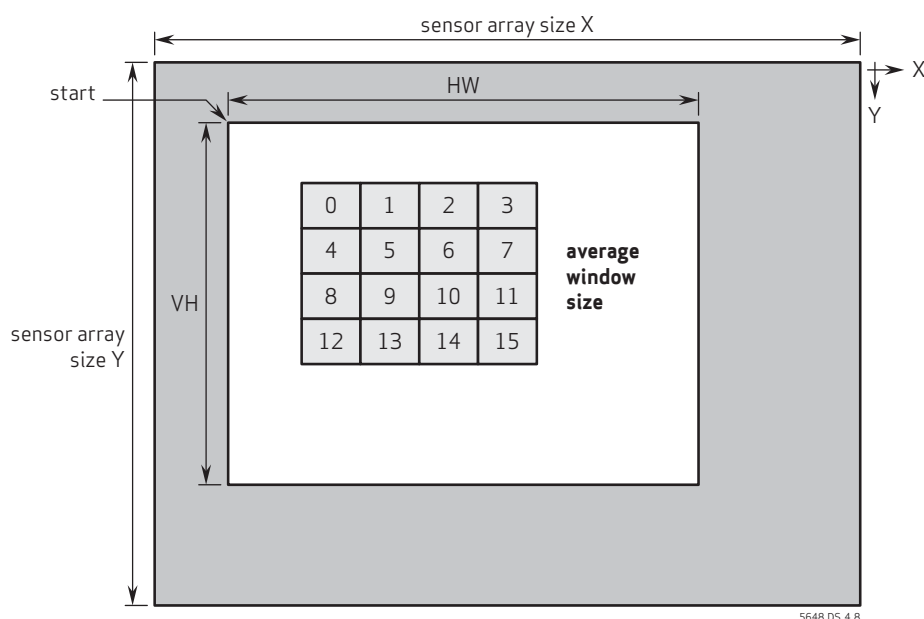


table 4-6 average luminance control function registers (sheet 1 of 2)

address	register name	default value	R/W	description
0x5680	XSTART	0x00	RW	Bit[3:0]: <code>x_start[11:8]</code> Horizontal start position for average window high byte
0x5681	XSTART	0x00	RW	Bit[7:0]: <code>x_start[7:0]</code> Horizontal start position for average window low byte
0x5682	YSTART	0x00	RW	Bit[3:0]: <code>y_start[11:8]</code> Vertical start position for average window high byte
0x5683	YSTART	0x00	RW	Bit[7:0]: <code>y_start[7:0]</code> Vertical start position for average window low byte

table 4-6 average luminance control function registers (sheet 2 of 2)

address	register name	default value	R/W	description
0x5684	X WINDOW	0x0A	RW	Bit[4:0]: x_window[12:8] Window X in manual average window mode high byte
0x5685	X WINDOW	0x20	RW	Bit[7:0]: x_window[7:0] Window X in manual average window mode low byte
0x5686	Y WINDOW	0x07	RW	Bit[3:0]: y_window[11:8] Window Y in manual average window mode high byte
0x5687	Y WINDOW	0x98	RW	Bit[7:0]: y_window[7:0] Window Y in manual average window mode low byte
0x5688	WEIGHT00	0x11	RW	Bit[7:4]: Window1 weight Bit[3:0]: Window0 weight
0x5689	WEIGHT01	0x11	RW	Bit[7:4]: Window3 weight Bit[3:0]: Window2 weight
0x568A	WEIGHT02	0x11	RW	Bit[7:4]: Window5 weight Bit[3:0]: Window4 weight
0x568B	WEIGHT03	0x11	RW	Bit[7:4]: Window7 weight Bit[3:0]: Window6 weight
0x568C	WEIGHT04	0x11	RW	Bit[7:4]: Window9 weight Bit[3:0]: Window8 weight
0x568D	WEIGHT05	0x11	RW	Bit[7:4]: Window11 weight Bit[3:0]: Window10 weight
0x568E	WEIGHT06	0x11	RW	Bit[7:4]: Window13 weight Bit[3:0]: Window12 weight
0x568F	WEIGHT07	0x11	RW	Bit[7:4]: Window15 weight Bit[3:0]: Window14 weight
0x5690	AVG CTRL10	0x02	RW	Bit[1]: avg_opt Bit[0]: avg_man 0: Auto average window 1: Manual average window
0x5693	AVG READOUT	–	R	Bit[7:0]: Avg value

4.5 AEC/AGC steps

The AEC and AGC work together to obtain optimum exposure/gain based on the current environmental illumination. In order to achieve the best signal-to-noise ratio (SNR), extending the exposure time is always preferred rather than raising the gain when the current illumination is getting darker. Similarly, under brighter conditions, the action to decrease the gain is always taken prior to shortening the exposure time.

4.5.1 auto exposure control (AEC)

The function of the AEC is to calculate the necessary integration time of the next frame and send the information to the timing control block. Based on the statistics of previous frames, the AEC is able to determine whether the integration time should increase, decrease, fast increase, fast decrease, or remain the same.

To avoid image flickering under a periodic light source, the integration time can be adjusted in steps of integer multiples of the period of the light source. This new AEC step system is called the banding filter, suggesting that the exposure time is not continuous but falls in some steps.

4.5.2 night mode

The OV5648 supports long integration time larger than one frame in dark conditions. This is achieved by slowing down the original frame rate and waiting for exposure. Night mode ceiling can be set in register {0x3A14[15:8], 0x3A15[7:0]} and {0x3A02[15:8], 0x3A03[7:0]} for 50/60 Hz lighting, respectively. Night mode can be disabled by setting register bit 0x3A00[2] to 0. Also, when in night mode, the increase and decrease step can be based on either band or frames, depending on register 0x3A05[6]. The minimum increase/decrease step can be one band.

4.5.3 banding mode ON with AEC

When banding mode is ON, the exposure time will fall in steps of integer multiples of the period of light intensity. This design is to reject image flickering when the light source is not steady but periodical.

For a given light flickering frequency, the band step can be expressed in units of row period.

Band Step = period of light intensity × frame rate × rows per frame.

The band steps for 50Hz and 60Hz light sources can be set in registers {0x3A08[1:0], 0x3A09[7:0]} and {0x3A0A[1:0], 0x3A0B[7:0]}, respectively. Banding mode can be enabled by setting register 0x3A00[5].

4.5.4 banding mode OFF with AEC

When banding mode is OFF, integration time increases/decreases as normal. It is not necessarily changed in multiples of band steps.

4.5.5 manual exposure control

To manually change exposure value, you must first set register 0x3503[0] to enable manual exposure control. The exposure value in registers 0x3500 ~ 0x3502 is in units of 1/16 line. The OV5648 only supports 0.n line exposure but does not support m.n line exposure, m is positive integer.

4.5.6 auto gain control (AGC)

Unlike prolonging integration time, increasing gain will amplify both signal and noise. Thus, AGC usually starts after AEC is full. However, in cases where adjacent AEC step changes are too large ($>1/16$), AGC steps should be inserted in between. Otherwise, the integration time will keep switching between two adjacent steps and the image flickers.

4.5.7 manual gain control

To manually change gain, first set register bit 0x3503[1] to enable manual control, then change the values in {0x350A[1:0], 0x350B[7:0]} for the manual gain.

$$\text{Gain} = \{0x350A[1:0], 0x350B[7:0]\} / 16$$

4.5.8 integration time between 1-16 rows

When integration time is less than 16 rows, the changes between adjacent AEC steps are larger than $1/16$, which may possibly make the image oscillate between two AEC levels. Thus, some AGC steps are added in between.

4.5.9 gain insertion between AEC banding steps

When banding mode is ON, the integration time changes in step of the period of light intensity. For the first 16 band steps, since the exposure time change between adjacent steps is larger than $1/16$, AGC steps are inserted to ensure image stability.

4.5.10 gain insertion between night mode steps

Between night mode steps (e.g., integration time = 1 frame and 2 frames), AGC steps are inserted to ensure no adjacent step change is larger than $1/16$.

4.5.11 when AEC reaches maximum

When AEC reaches its maximum while the image is still too dark, the gain starts to increase until the new frame average falls into the stable range or AGC reaches its maximum. The AGC ceiling can be set in {0x3A18[9:8], 0x3A19[7:0]}.

$$\text{Gain Ceiling} = \{0x3A18[1:0], 0x3A19[7:0]\} / 16$$

table 4-7 AEC/AGC registers (sheet 1 of 2)

address	register name	default value	R/W	description	
0x3A00	AEC CTRL00	0x78	RW	Bit[5]: Bit[2]:	Band function Night mode
0x3A02	MAX EXPO 60	0x3D	RW	Bit[7:0]:	Max expo[15:8] Night mode ceiling of 60Hz
0x3A03	MAX EXPO 60	0x80	RW	Bit[7:0]:	Max expo[7:0] Night mode ceiling of 60Hz
0x3A05	AEC CTRL05	0x30	RW	Bit[6]:	frame_insert 0: In night mode, insert frame disable 1: In night mode, insert frame enable

table 4-7 AEC/AGC registers (sheet 2 of 2)

address	register name	default value	R/W	description
0x3A08	B50 STEP	0x01	RW	Bit[1:0]: b50_step[9:8] Band step size of 50Hz
0x3A09	B50 STEP	0x27	RW	Bit[7:0]: b50_step[7:0] Band step size of 50Hz
0x3A0A	B60 STEP	0x00	RW	Bit[1:0]: b60_step[9:8] Band step size of 60Hz
0x3A0B	B60 STEP	0xF6	RW	Bit[7:0]: b60_step[7:0] Band step size of 60Hz
0x3A0D	B60 MAX	0x08	RW	Bit[5:0]: b60_max Max band step number of 60Hz
0x3A0E	B50 MAX	0x06	RW	Bit[5:0]: b50_max Max band step number of 50Hz
0x3A14	MAX EXPO 50	0x0E	RW	Bit[7:0]: Max expo[15:8] Night mode ceiling of 50Hz
0x3A15	MAX EXPO 50	0x40	RW	Bit[7:0]: Max expo[7:0] Night mode ceiling of 50Hz
0x3A17	NIGHT MODE GAIN BASE	0x01	RW	Bit[1:0]: gnight_thre Night mode gain threshold 00: 1x 01: 2x 10: 4x 11: 8x
0x3A18	AEC GAIN CEILING	0x00	RW	Bit[1:0]: gain_ceiling[9:8] Gain ceiling = {0x3A18[1:0], 0x3A19[7:0]} /16
0x3A19	AEC GAIN CEILING	0x7C	RW	Bit[7:0]: gain_ceiling[7:0]

4.6 black level calibration (BLC)

The pixel array contains several optically shielded (black) lines. These lines are used as reference for black level calibration. There are three main functions of the BLC:

- combining two ADC data paths into one data path
- adjusting all normal pixel values based on the values of the black levels
- applying multiplication to all pixel values based on digital gain

The target of BLC level can be set by register 0x4009.

table 4-8 BLC control functions

address	register name	default value	R/W	description
0x4000	BLC CTRL00	0x89	RW	BLC Control Bit[0]: BLC enable 0: Disable 1: Enable
0x4003	BLC CTRL03	0x08	RW	Bit[7]: blc_redo_en Writing 1 to this bit will trigger a BLC redo N frames begin Bit[6]: Freeze Bit[5:0]: manual_frame_num
0x4005	BLC CTRL05	0x18	RW	Bit[1]: blc_always_up_en 0: Normal freeze 1: BLC always update
0x4009	BLACK LEVEL TARGET	0x10	RW	Bit[7:0]: BLC black level target

4.7 strobe flash and frame exposure

4.7.1 strobe flash control

The strobe signal is programmable. It supports both LED and Xenon modes. The polarity of the pulse can be changed. The strobe signal is enabled (turned high/low depending on the pulse's polarity) by requesting the signal via the SCCB interface. Flash modules are triggered by the rising edge by default or by the falling edge if the signal polarity is changed. It supports the following flashlight modes (see [table 4-9](#)).

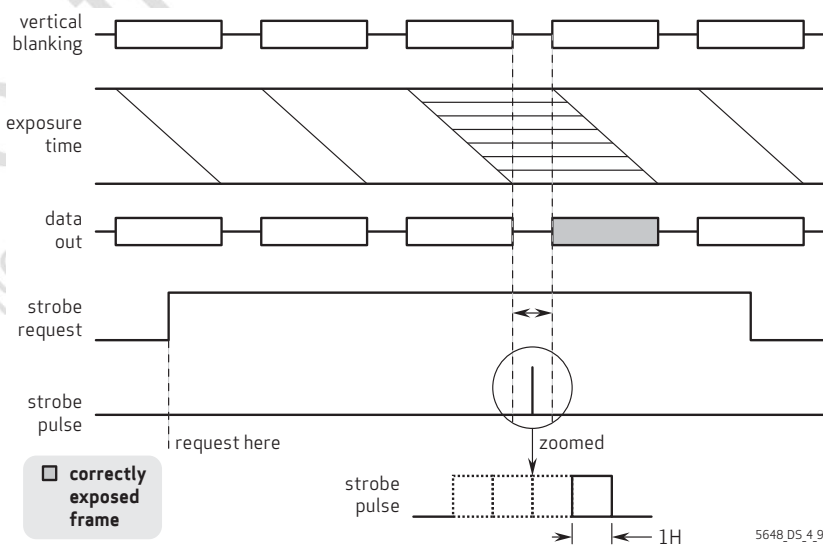
table 4-9 flashlight modes

mode	output	AEC / AGC	AWB
xenon	one-pulse	no	no
LED 1	pulse	no	no
LED 2	pulse	no	yes
LED 3	continuous	yes	yes

4.8 xenon flash control

After a strobe request is submitted, the strobe pulse will be activated at the beginning of the third frame (see [figure 4-9](#)). The third frame will be correctly exposed. The pulse width can be changed in Xenon mode between 1H and 4H, depending on register 0x3B00[3:2], where H is one row period.

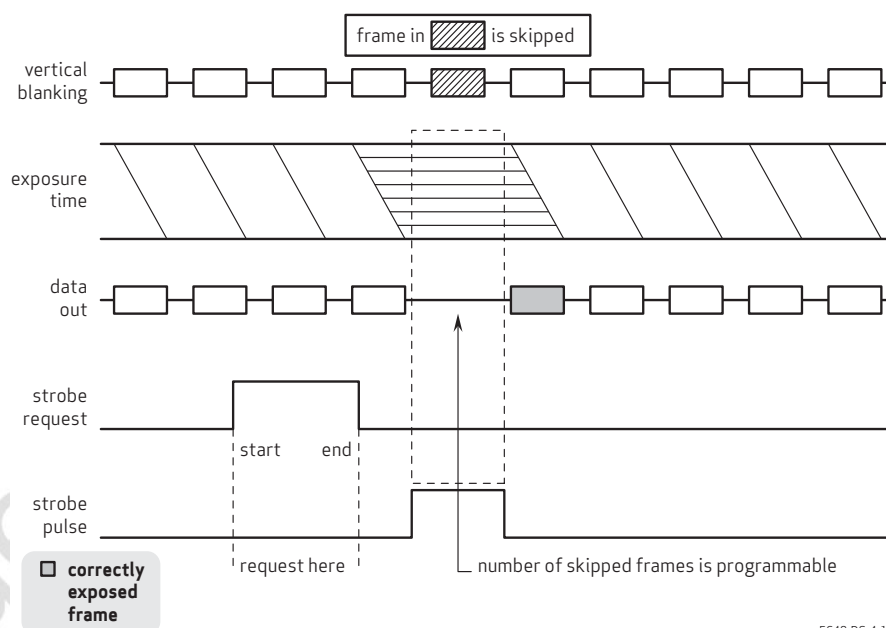
figure 4-9 xenon flash mode



4.8.1 LED1 & 2 mode

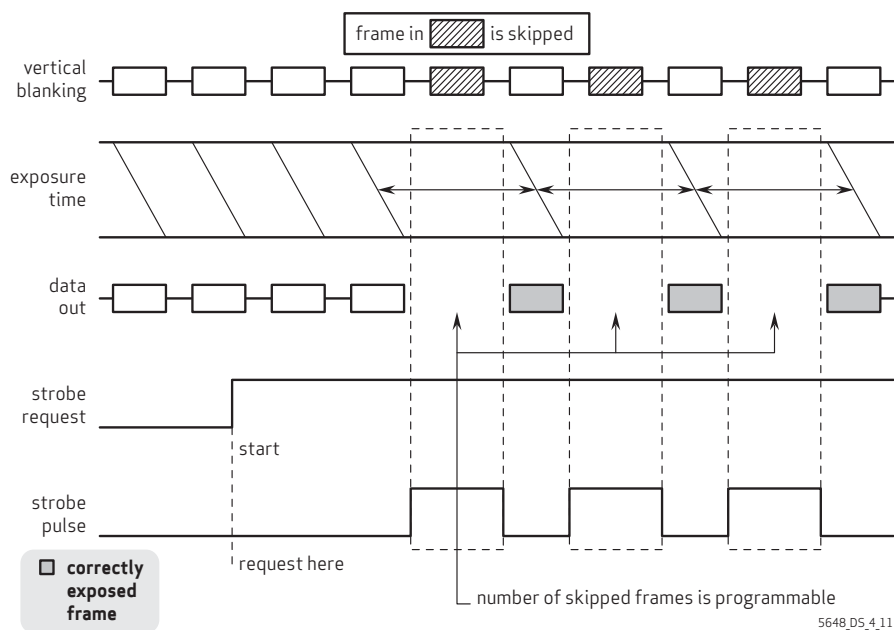
Two frames after the strobe request is submitted, the third frame is correctly exposed. The strobe pulse will be activated only one time if the strobe end request is set correctly (see [figure 4-10](#)). If end request is not sent, the strobe signal is activated intermittently until the strobe end request is set (see [figure 4-11](#)). The number of skipped frames is programmable using registers {0x3A1C, 0x3A1D}.

figure 4-10 LED 1 & 2 mode - one pulse output



5648_DS_4_10

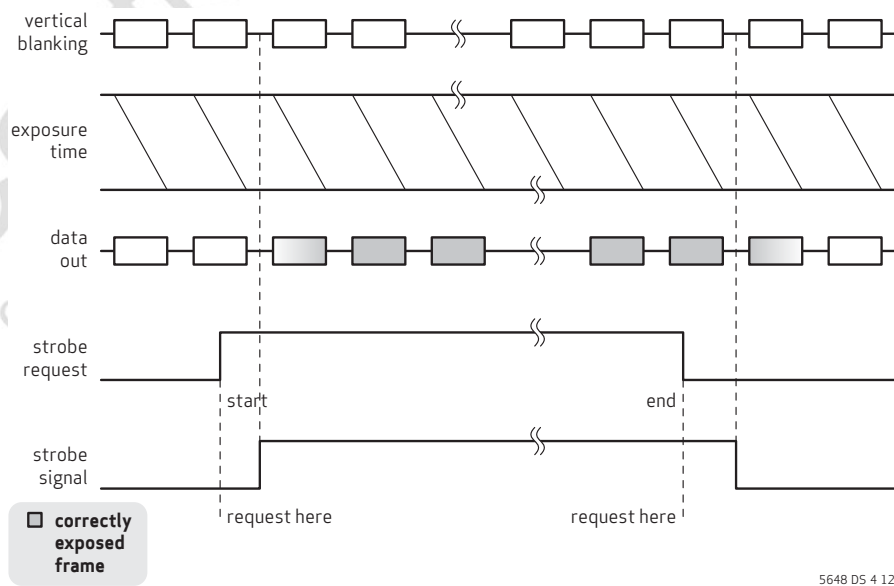
figure 4-11 LED 1 & 2 mode - multiple pulse output



4.8.2 LED 3 mode

In LED 3 mode, the strobe signal stays active until the strobe end request is sent (see figure 4-12).

figure 4-12 LED 3 mode

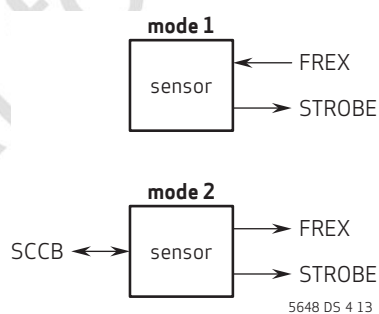


4.9 frame exposure (FREX) mode

4.9.1 FREX control

The OV5648 supports two modes of FREX (see **figure 4-13**). In FREX mode, whole frame pixels start integration at the same time, rather than integrating row by row. After the user-defined exposure time (either by external control in mode 1 or registers {0x3B01, 0x3B04, 0x3B05} in mode 2), the shutter closes, preventing further integration and the image begins to read out. After the readout finishes, the shutter opens again and the sensor resumes normal mode, waiting for the next FREX request. In mode 1, the FREX pin is configured as an input while it is configured as an output in mode 2. In both mode 1 and mode 2, the strobe output is irrelevant with the rolling strobe function. The strobe function of rolling shutter mode and FREX/shutter mode do not work at the same time.

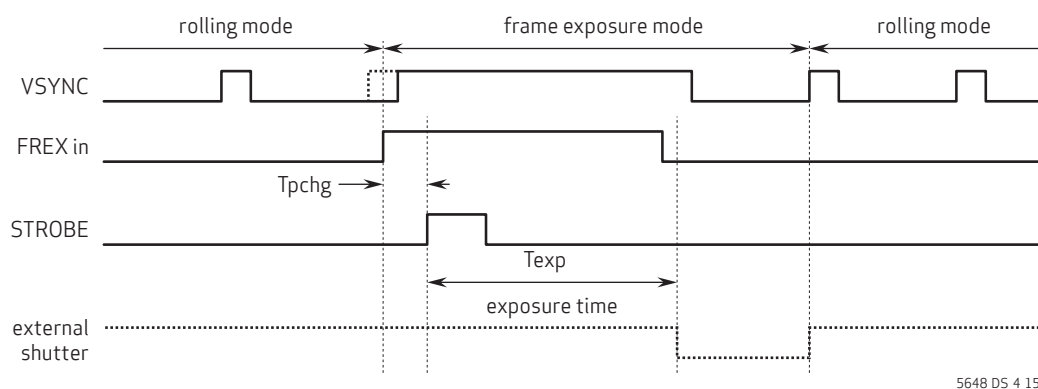
figure 4-13 FREX modes



note After frame exposure mode, the first output frame is invalid because of improper exposure during the readout time of the frame exposure image. From the second output frame, the images become normal.

Mode 1 (see **figure 4-14**) frame exposure and shutter control requests come from the external system via the FREX pin. The sensor will send a strobe output signal to control the flash light.

figure 4-14 FREX mode 1 timing diagram



Example setting:

```
6C 3002 EF;          FREX mode selection: input
6C 3B06 14;          STROBE width: fixed
6C 3B07 18;          FREX mode 1 selection
6C 3B0A 24;          STROBE output enable
6C 3011 00;          enable FREX pin
```

Mode 2 (see [figure 4-15](#) and [figure 4-16](#)) frame exposure request comes from the external system via the I2C register 0x3B08[0]. The sensor outputs two signals, shutter control signal through the FREX pin and strobe signal through the STROBE pin. When the sensor is in FREX mode 2, by default the FREX output signal maintains a high status until the signal is triggered. After trigger the FREX pin outputs a low control signal. The polarity of the FREX output signal can be changed by setting 0x3B07[2] to 1'b1.

Frame exposure time is defined by {0x3B01[7:0], 0x3B04[7:0], 0x3B05[7:0]} with one step equal to 128tp/bit. If OV5648 works at 96MHz, each step is equal to 1.33μs and the minimum exposure time is 1.33μs with 0x3811 = 0x00, 0x3B04 = 0x00 and 0x3B05 = 0x01; the maximum exposure time is 22.37s with 0x3811 = 0xFF, 0x3B04 = 0xFF and 0x3B05 = 0xFF.

A shutter delay time is defined by {0x3B02[4:0], 0x3B03[7:0]} to compensate for the mechanical shutter delay. One step is equal to 128tp/bit. The minimum shutter delay time is 0 with 0x3B02 = 0x00 and 0x3B03 = 0x00. With PCLK = 96MHz, each step is equal to 1.33μs and the maximum shutter delay is 10.92ms with 0x3B02 = 0x1F and 0x3B03 = 0xFF.

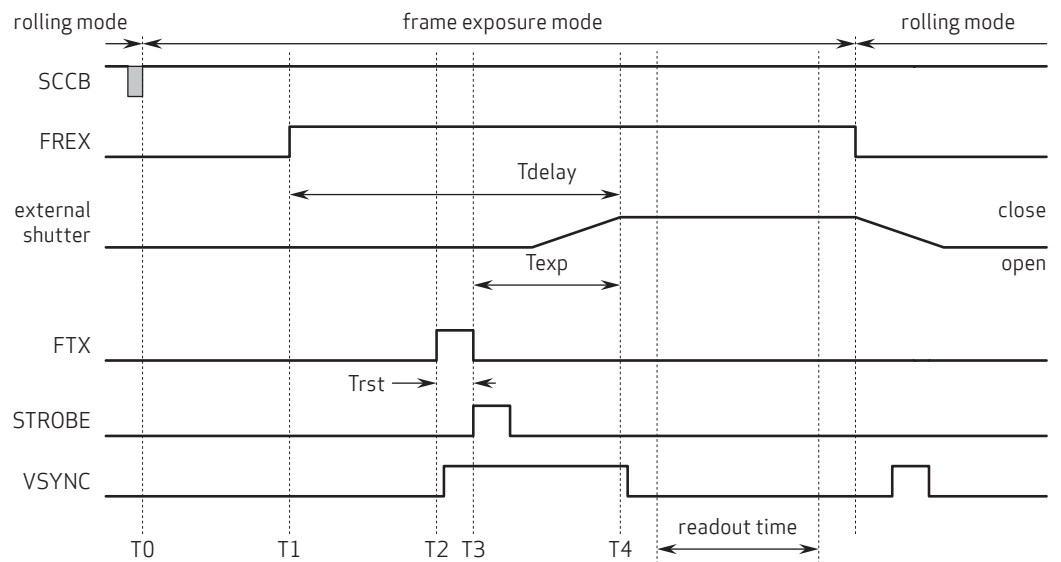
In [figure 4-15](#) and [figure 4-16](#) control of the relationship between shutter delay and the exposure time is realized by the following timing control. For FREXOUT signal, $T_4 - T_2 = T_{exp} + T_{pchg}$; For FTX signal, $T_4 - T_1 = T_{delay}$

table 4-10 FREX mode 2 timing point description

timing point	description
T ₀	end of SCCB request
T ₁	beginning of FREX output
T ₂	beginning of global reset
T ₃	end of global reset (beginning of exposure)
T ₄	external shutter close (end of exposure)

T₁ may be in front of or behind T₂ based on whether the T_{delay} is longer than T_{pchg} + T_{exp} (T₁ > T₂ see [figure 4-15](#)) or T_{delay} is shorter than T_{pchg} + T_{exp} (T₁ < T₂ see [figure 4-16](#)).

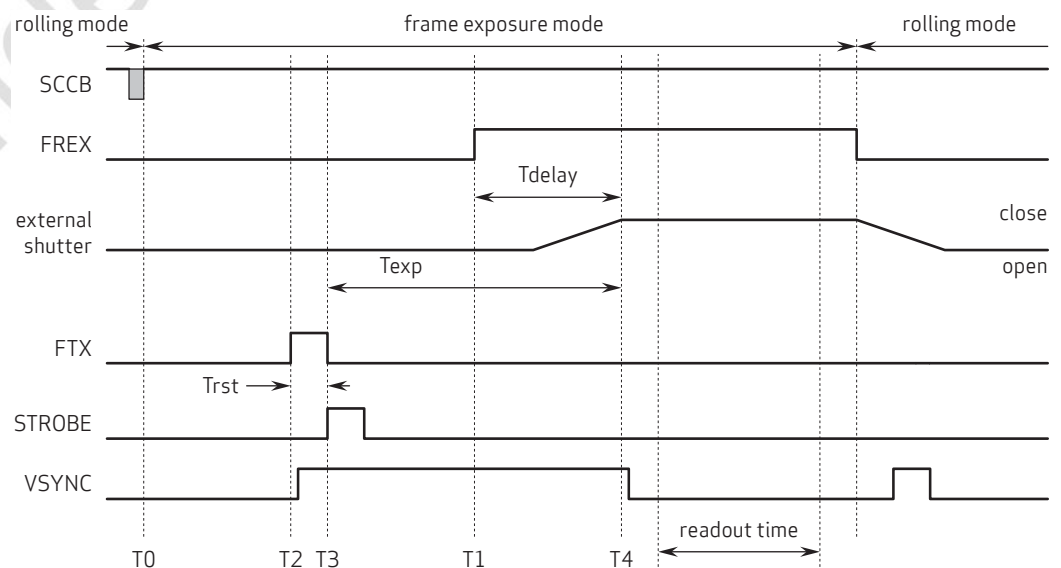
figure 4-15 FREX mode 2 timing diagram (when shutter delay is longer than exposure time)



note: Tdelay: shutter delay time
Texp: exposure time
Trst: global reset time

5648_DS_4_15

figure 4-16 FREX mode 2 timing diagram (when shutter delay is shorter than exposure time)



note: Tdelay: shutter delay time
Texp: exposure time
Trst: global reset time

5648_DS_4_16

Example setting (see [figure 4-15](#)):

```

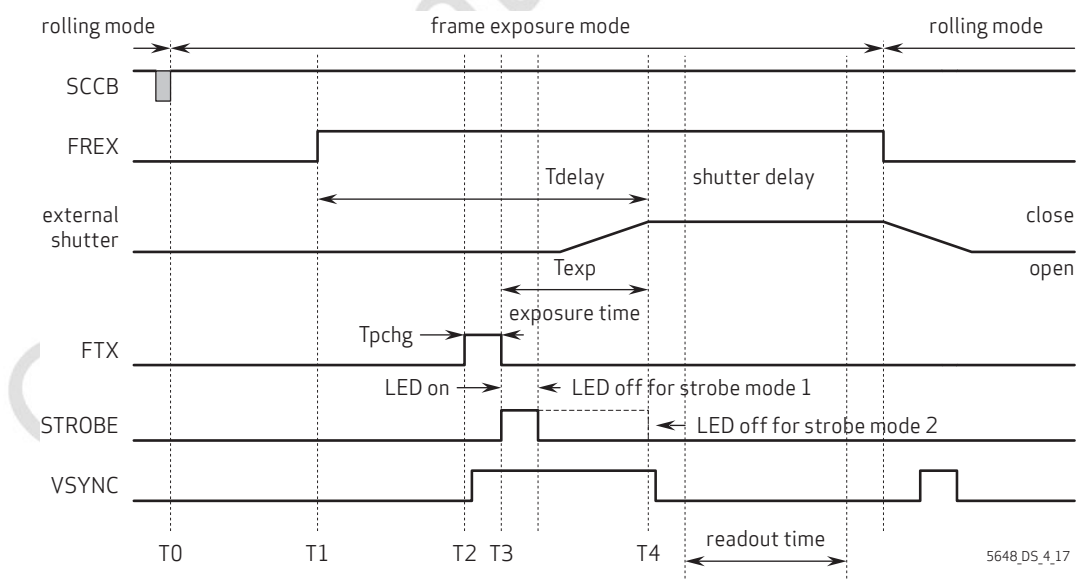
6C 3B06 14;
6C 3B07 1D;          FREX mode 2 selection and FREX polarity selection
6C 3002 FF;          FREX mode selection: output
6C 3B01 00;
6C 3B04 04;
6C 3B05 00;          with PCLK = 96MHz, exposure time = 1.37ms
6C 3B02 08;
6C 3B03 00;          with PCLK = 96MHz, shutter delay = 2.72ms
6C 3B08 01;          SCCB FREX trigger

```

4.9.2 STROBE control in FREX mode

In FREX mode, two modes of STROBE control are provided in OV5648 (see [figure 4-17](#)). The first mode provides controllable STROBE output high signal (0x3B06[4] to 1'b0) from 1 to 16 tp (0x3B06[3:0]). The second mode provides STROBE output high signal (0x3B06[4] to 1'b1) during whole exposure period.

figure 4-17 STROBE control in FREX mode



4.10 FREX strobe flash control

See **table 4-11** for FREX strobe control functions.

table 4-11 FREX strobe control functions

address	register name	default value	R/W	description
0x3B00	STROBE CTRL	0x00	RW	Strobe Control
				Bit[7]: Strobe request ON/OFF 0: OFF 1: ON
				Bit[6]: Strobe pulse reverse
				Bit[3:2]: width_in_xenon 00: 1 row period 01: 2 row period 10: 3 row period 11: 4 row period
				Bit[1:0]: Strobe mode 00: Xenon 01: LED 1 10: LED 2 11: LED 3
0x3B01	STROBE_FREX_EXP_H2	0x00	RW	Bit[7:0]: frex_exp[23:16]
0x3B02	STROBE_SHUTTER_DLY	0x08	RW	Bit[4:0]: shutter_dly[12:8]
0x3B03	STROBE_SHUTTER_DLY	0x00	RW	Bit[7:0]: shutter_dly[7:0]
0x3B04	STROBE_FREX_EXP_H	0x04	RW	Bit[7:0]: frex_exp[15:8]
0x3B05	STROBE_FREX_EXP_L	0x00	RW	Bit[7:0]: frex_exp[7:0]
0x3B06	FREX CTRL	0x04	RW	FREX Control
				Bit[7:6]: frex_pchg_width Bit[5:4]: frex_strobe_option Bit[3:0]: frex_strobe_width[3:0]
0x3B07	STROBE_FREX_MODE_SEL	0x08	RW	Bit[3]: fx1_fm_en
				Bit[2]: frex_inv Bit[1:0]: FREX mode select 00: frex_strobe mode1 01: frex_strobe mode2 1x: Rolling strobe
0x3B08	STROBE_FREX_EXP_REQ	0x00	RW	Bit[0]: frex_exp_req
0x3B09	FREX_SHUTTER_DELAY	0x00	RW	Bit[2:0]: frex end option
0x3B0A	STROBE_FREX_RST_LENGTH	0x04	RW	Bit[2:0]: frex_rst_length[2:0]
0x3B0B	STROBE_WIDTH	0x00	RW	Bit[7:0]: frex_strobe_width[19:12]
0x3B0C	STROBE_WIDTH	0x3D	RW	Bit[7:0]: frex_strobe_width[11:4]

4.11 one-time programmable (OTP) memory

The OV5648 supports 256 bits of one-time programmable (OTP) memory to store chip identification and manufacturing information. It can be controlled through the SCCB (see [table 4-12](#)).

table 4-12 OTP control function registers (sheet 1 of 2)

address	register name	default value	R/W	description	
0x3D00 ^a	OTP_DATA_0	0x00	RW	OTP Buffer 0	
0x3D01 ^a	OTP_DATA_1	0x00	RW	OTP Buffer 1	
0x3D02 ^a	OTP_DATA_2	0x00	RW	OTP Buffer 2	
0x3D03 ^a	OTP_DATA_3	0x00	RW	OTP Buffer 3	
0x3D04 ^a	OTP_DATA_4	0x00	RW	OTP Buffer 4	
0x3D05	OTP_DATA_5	0x00	RW	OTP Buffer 5	
0x3D06	OTP_DATA_6	0x00	RW	OTP Buffer 6	
0x3D07	OTP_DATA_7	0x00	RW	OTP Buffer 7	
0x3D08	OTP_DATA_8	0x00	RW	OTP Buffer 8	
0x3D09	OTP_DATA_9	0x00	RW	OTP Buffer 9	
0x3D0A	OTP_DATA_A	0x00	RW	OTP Buffer A	
0x3D0B	OTP_DATA_B	0x00	RW	OTP Buffer B	
0x3D0C	OTP_DATA_C	0x00	RW	OTP Buffer C	
0x3D0D	OTP_DATA_D	0x00	RW	OTP Buffer D	
0x3D0E	OTP_DATA_E	0x00	RW	OTP Buffer E	
0x3D0F	OTP_DATA_F	0x00	RW	OTP Buffer F	
0x3D80 ^b	OTP_PROGRAM_CTRL	0x00	RW	Bit[7]:	OTP_pgenb_o
				0:	It is programming time
				Bit[6:1]:	Reserved
				Bit[0]:	OTP_pgm
					Program start signal
					Changing from 0 to 1 initiates OTP programming

table 4-12 OTP control function registers (sheet 2 of 2)

address	register name	default value	R/W	description
0x3D81	OTP_LOAD_CTRL	0x00	RW	Bit[7]: OTP_pgenb 0: It is programming time Bit[6:1]: Reserved Bit[0]: OTP_rd Read start signal Changing from 0 to 1 initiates OTP read

- bank 0 (0x3D00~0x3D04) and bank 1 (0x3D0F) are reserved for OmniVision internal use.
- AVDD must be $2.5V \pm 5\%$ when writing/programming OTP; otherwise, there will be reliability issues. There is no such limitation when reading OTP under normal operating conditions.

The following sections provide instructions on how to program the OTP (can only be done once) and how to read back the OTP (can be done multiple times). Before read/write, make sure all sensor powers are properly provided and the sensor is up and running. The OTP module is at default enabled state, 0x301C[0] is 0 and 0x301C[4] is 1.

4.11.1 OTP program

An example of programming OTP addresses 0x3D0C~0x3D0F is shown below. Make sure non-programmable addresses 0x3D00~0x3D0B are at default value of 0 to avoid accidental programming to other OTP addresses.

```
;; OTP Program
;; OTP Program Bank #0
6c 3d84 40;
6c 3d85 00;
6c 3d86 0f;bank0 address from 00 ~0f
6c 3d00 22; otp write data1
6c 3d01 01; otp write data2
6c 3d02 02; otp write data3
6c 3d03 03; otp write data4
6c 3d04 04; otp write data5
6c 3d05 05; otp write data6
6c 3d06 06; otp write data7
6c 3d07 07; otp write data8
6c 3d80 01;
;# Delay 10ms

;; OTP Program Bank #1
6c 3d84 40;
6c 3d85 10;
```

```

6c 3d86 1f; bank1 address from 10 ~1f
6c 3d08 88; otp write data1
6c 3d09 99; otp write data2
6c 3d0a aa; otp write data3
6c 3d0b bb; otp write data4
6c 3d0c cc; otp write data5
6c 3d0d dd; otp write data6
6c 3d0e ee; otp write data7
6c 3d0f 55; otp write data8
6c 3d80 01;
;# Delay 10ms

```

Note that the procedure shown above can only be performed once for each sensor.

4.11.2 OTP read

After programming and at any time after the sensor is powered on, use the procedure shown below to read back the OTP values. Before each read, the user can clear 0x3D00~0x3D0F registers first if just finished write.

```

; OTP Bank #0 read out
6c 3d84 c0;
6c 3d85 00;
6c 3d86 0f;
6c 3d81 01;
; delay 1ms
6c 3d00 ; read back bank #0
6c 3d01 ;
6c 3d02 ;
6c 3d03 ;check 3d00 ~3d0f for bank0 readout data

; OTP Bank #1 read out
6c 3d84 c0;
6c 3d85 10;
6c 3d86 1f;
6c 3d81 01;
; delay 1ms
6c 3d0c ; read back bank #1
6c 3d0d ;
6c 3d0e ;
6c 3d0f ;check 3d00 ~3d0f for bank0 readout data

```

OV5648

color CMOS QSXGA (5 megapixel) image sensor with OmniBSI+™ technology

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5 image sensor processor digital functions

5.1 ISP general controls

table 5-1 ISP general control registers (sheet 1 of 2)

address	register name	default value	R/W	description
0x5000	ISP CTRL00	0xFF	RW	ISP Control 00 (0: disable; 1: enable) Bit[2]: Black pixel correction Bit[1]: White pixel correction
0x5001	ISP CTRL01	0x01	RW	ISP Control 01 Bit[0]: AWB 0: Disable 1: Enable
0x5002	ISP CTRL02	0x41	RW	ISP Control 02 (0: disable; 1: enable) Bit[6]: win_en Bit[1]: otp_en Bit[0]: AWB gain
0x5003	ISP CTRL03	0x0A	RW	ISP Control 03 (0: disable; 1: enable) Bit[3]: buf_en Bit[2]: bin_man_set Bit[1]: bin_auto_en
0x5005	ISP CTRL05	0x14	RW	ISP Control 05 (0: disable; 1: enable) Bit[5]: awb_bias_on
0x501F	ISP CTRL1F	0x03	RW	Bit[5]: enable_opt 0: Not latched by VSYNC 1: Enable latched by VSYNC Bit[4]: cal_sel 0: DPC cal_start using SOF 1: DPC cal_start using VSYNC Bit[2:0]: fmt_sel 011: ISP output data Others: ISP input data bypass
0x5025	ISP CTRL25	0x00	RW	Bit[1:0]: avg_sel 00: Inputs of AVG module are from ISP input 01: Inputs of AVG module are from AWB gain output 10: Inputs of AVG module are from DPC output 11: Inputs of AVG module are from binning output

table 5-1 ISP general control registers (sheet 2 of 2)

address	register name	default value	R/W	description
0x503D	ISP CTRL3D	0x00	RW	Bit[7]: test_pattern_en 0: Disable 1: Enable Bit[6]: rolling_bar 0: Disable rolling bar 1: Enable rolling bar Bit[5]: transparent_mode 0: Disable 1: Enable Bit[4]: squ_bw_mode 0: Output square is color square 1: Output square is black-white square Bit[3:2]: bar_style When set to a different value, a different type of color bar is output Bit[1:0]: test_pattern_type 00: Color bar 01: Random data 10: Square 11: Input data
0x503E	ISP CTRL3E	0x00	RW	Bit[6]: win_cut_en Bit[5]: isp_test 0: Two lowest bits are 1 1: Two lowest bits are 0 Bit[4]: rnd_same 0: Frame-changing random data pattern 1: Frame-fixed random data pattern Bit[3:0]: rnd_seed Initial seed for random data pattern
0x504B	ISP CTRL4B	0x30	RW	ISP Control 4B (0: disable; 1: enable) Bit[5]: post_binning_h_enable Bit[4]: post_binning_v_enable Bit[3]: flip_man_en Bit[2]: flip_man Bit[1]: mirror_man_en Bit[0]: Mirror

5.2 defect pixel cancellation (DPC)

Primarily due to process anomalies, pixel defects in the sensor array will occur, generating incorrect pixel levels and color values. The purpose of defect pixel cancellation (DPC) function is to remove the effects caused by defective pixels. To correctly remove defective pixels, the proper threshold should first be determined. Additionally, there are special functions available for those pixels located at the image boundary.

table 5-2 defect pixel cancellation registers

address	register name	default value	R/W	description
0x5000	ISP CTRL00	0xFF	RW	Bit[2]: bc_en 0: Disable 1: Enable Bit[1]: wc_en 0: Disable 1: Enable

5.3 auto white balance (AWB)

The purpose of the auto white balance (AWB) block is to avoid unrealistic colors so that objects that appear white to the human eye are rendered white in the final image or video. This image sensor supports both manual white balance and simple auto white balance. Simple AWB calculates the gain based on gray world assumptions.

table 5-3 AWB control registers (sheet 1 of 3)

address	register name	default value	R/W	description
0x5001	ISP CTRL01	0x01	RW	Bit[0]: awb_en 0: Disable 1: Enable
0x5002	ISP CTRL02	0x41	RW	Bit[0]: AWB_gain_en 0: Disable 1: Enable

table 5-3 AWB control registers (sheet 2 of 3)

address	register name	default value	R/W	description
0x5180	AWB CTRL	0x00	RW	Bit[6]: fast_awb 0: Disable fast AWB calculation function 1: Enable fast AWB calculation function Bit[5]: freeze_gain_en When it is enabled, the output AWB gains will be input AWB gains Bit[4]: freeze_sum_en When it is set, the sums and averages value will be same as previous frame Bit[3]: gain_man_en 0: Output calculated gains 1: Output manual gains set by registers Bit[2]: start_sel 0: Select the last HREF falling edge of before gain input as calculated start signal 1: Select the last HREF falling edge of after gain input as calculated start signal
0x5181	AWB DELTA	0x20	RW	Bit[7]: delta_opt Bit[6]: base_man_en Bit[5:0]: awb_delta Delta value to increase or decrease the gains
0x5182	STABLE RANGE	0x04	RW	Bit[7:0]: stable_range
0x5183	STABLE RANGEW	0x08	RW	Bit[7:0]: stable_rangew Wide stable range
0x5186	MANUAL RED GAIN MSB	0x04	RW	Bit[3:0]: red_gain_man[11:8]
0x5187	MANUAL RED GAIN LSB	0x00	RW	Bit[7:0]: red_gain_man[7:0]
0x5188	MANUAL GREEN GAIN MSB	0x04	RW	Bit[3:0]: grn_gain_man[11:8]
0x5189	MANUAL GREEN GAIN LSB	0x00	RW	Bit[7:0]: grn_gain_man[7:0]
0x518A	MANUAL BLUE GAIN MSB	0x04	RW	Bit[3:0]: blu_gain_man[11:8]
0x518B	MANUAL BLUE GAIN LSB	0x00	RW	Bit[7:0]: blu_gain_man[7:0]

table 5-3 AWB control registers (sheet 3 of 3)

address	register name	default value	R/W	description
0x518C	RED GAIN LIMIT	0xF0	RW	Bit[7:4]: red_gain_up_limit Bit[3:0]: red_gain_dn_limit They are only the highest 4 bits of limitation. Max red gain is {red_gan_up_limit,FF} Min red gain is {red_gain_dn_limit,00}
0x518D	GREEN GAIN LIMIT	0xF0	RW	Bit[7:4]: green_gain_up_limit Bit[3:0]: green_gain_dn_limit They are only the highest 4 bits of limitation. Max green gain is {green_gan_up_limit,FF} Min green gain is {green_gain_dn_limit,00}
0x518E	BLUE GAIN LIMIT	0xF0	RW	Bit[7:4]: blue_gain_up_limit Bit[3:0]: blue_gain_dn_limit They are only the highest 4 bits of limitation. Max blue gain is {blue_gan_up_limit,FF} Min blue gain is {blue_gain_dn_limit,00}

5.4 post binning filter

Subsampling in the raw domain will cause zigzag issues around slanted edges and color shifts because it is a non-uniform method in physical coordinates. The post binning filter will map these pixels to their physically correct locations.

table 5-4 post binning control registers

address	register name	default value	R/W	description
0x5003	ISP CTRL3	0x0A	RW	Bit[2]: bin_en
0x504B	ISP CTRL75	0x30	RW	Bit[5]: h_en Bit[4]: v_en

5.5 picture-in-picture (PIP)

The picture-in-picture (PIP) module is used to overlay a secondary camera image on live video (see [figure 5-1](#)). Contact your local OmniVision FAE for the second camera OV5648 support.

In OV5648 PIP mode, a smaller image is input from an external sensor (sensor 1) through the SPI (serial-to-parallel interface) port, see [figure 5-2](#). After OV5648 (sensor 2) receives the image from sensor 1, the PIP image combination logic will combine those two images, as well as the boundary, and output the PIP image. The width and color of the boundary can be changed using registers 0x5B00~0x5B08. The position of the smaller image can be adjusted arbitrarily inside the larger image by the frame-sync function of sensor 1. As the delay of the frame-sync control signal increases (0x4314~0x4316), the image of sensor 1 moves to right/bottom. PIP related registers are listed in [table 5-5](#). The SPI receiver control registers are listed in [table 5-6](#).

figure 5-1 picture-in-picture image

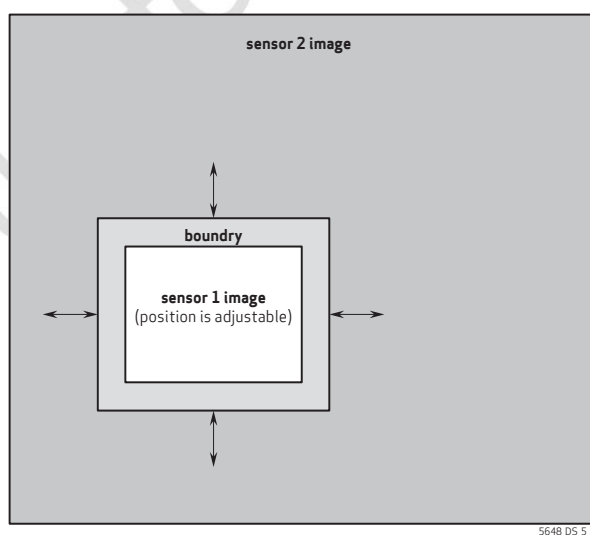


figure 5-2 picture-in-picture function block diagram

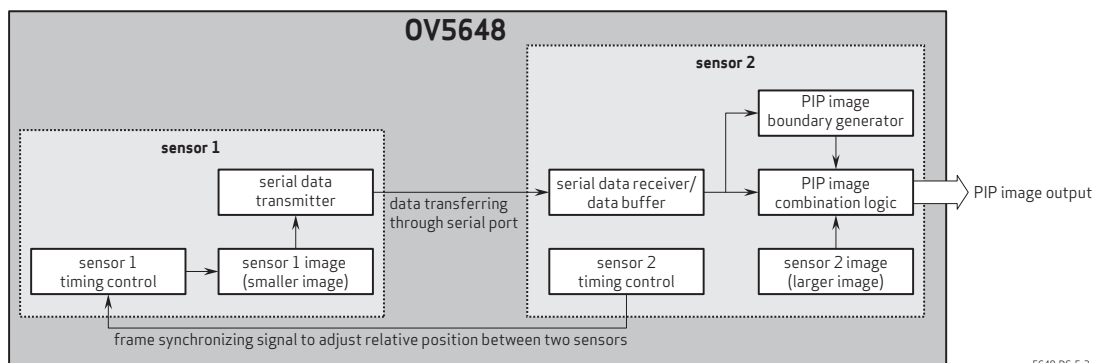


table 5-5 PIP control registers

address	register name	default value	R/W	description
0x3017	PAD OUTPUT ENABLE 01	0x00	RW	Bit[6]: VSYNC output enable
0x4314	VSYNC DELAY1	0x00	RW	Bit[7:0]: VSYNC trigger to VSYNC delay[23:16]
0x4315	VSYNC DELAY2	0x00	RW	Bit[7:0]: VSYNC trigger to VSYNC delay[15:8]
0x4316	VSYNC DELAY3	0x00	RW	Bit[7:0]: VSYNC trigger to VSYNC delay[7:0]
0x5002	ISP CONTROL02	0x80	RW	Bit[0]: pip_enable
0x5B00	PIP HORIZONTAL SIZE	0x01	RW	Bit[3:0]: PIP horizontal size[11:8]
0x5B01	PIP HORIZONTAL SIZE	0x40	RW	Bit[7:0]: PIP horizontal size[7:0]
0x5B02	PIP VERTICAL SIZE	0x00	RW	Bit[2:0]: PIP vertical size[10:8]
0x5B03	PIP VERTICAL SIZE	0xF0	RW	Bit[7:0]: PIP vertical size[7:0]
0x5B04	PIP BORDER Y	0x00	RW	PIP Border Y
0x5B05	PIP BORDER U	0x80	RW	PIP Border U
0x5B06	PIP BORDER V	0x80	RW	PIP Border V
0x5B07	PIP BORDER HORIZONTAL WIDTH	0x04	RW	PIP Border Horizontal Width (when 0x5B07=8'hFF, the border is disabled)
0x5B08	PIP BORDER VERTICAL WIDTH	0x04	RW	PIP Border Vertical Width

table 5-6 SPI control registers (sheet 1 of 2)

address	register name	default value	R/W	description
0x3003	SYSTEM RESET03	0x00	RW	Bit[0]: Reset SPI_RX
0x3007	CLOCK ENABLE03	0xFF	RW	Bit[2]: Enable SPI_RX SCLK clock

table 5-6 SPI control registers (sheet 2 of 2)

address	register name	default value	R/W	description
0x4B00	SPI RX CTRL00	0x06	RW	Bit[7]: b_pix_flag_opt Bit[6]: spi_rx_sel 0: SPI 2.0 1: SPI 3.0 Bit[5]: spi_1_line_opt Bit[4]: line_st_man_en Bit[3]: line_st_update_dis Bit[2]: byte_order 0: LSB first 1: MSB first Bit[1]: bit_order 0: LSB first 1: MSB first Bit[0]: Data high/low byte swap
0x4B01	SPI RX CTRL01	0x0A	RW	Bit[7]: CSK reverse Bit[6]: r_rx_opt Bit[5]: Raw8 enable Bit[4]: SRAM_test1 Bit[3:0]: SRAM_RM
0x4B02	SPI RX CTRL02	0x01	RW	Bit[5:0]: line_st_man_h
0x4B03	SPI RX CTRL03	0x40	RW	Bit[7:0]: line_st_man_l
0x4B04	SPI RX CTRL04	0x10	RW	Bit[7]: start_size_man Bit[5]: update_per_line_en Bit[4]: update_per_frame_en Bit[3]: crc_req_b Bit[2:1]: crc_flag_opt
0x4B05	SPI RX CTRL05	–	R	Bit[7:0]: data_id[7:0]
0x4B06	SPI RX CTRL06	–	R	Bit[7:0]: image_width[15:8]
0x4B07	SPI RX CTRL07	–	R	Bit[7:0]: image_width[7:0]
0x4B08	SPI RX CTRL08	–	R	Bit[7:0]: image_height[15:8]
0x4B09	SPI RX CTRL09	–	R	Bit[7:0]: image_height[7:0]

6 image sensor output interface digital functions

6.1 system control

System control registers include clock, reset control, and PLL configure.

table 6-1 system control registers (sheet 1 of 4)

address	register name	default value	R/W	description
0x3000	SC_CMMN_PAD_OEN0	0x00	RW	I/O Direction (0: input; 1: output) Bit[3:0]: D[11:8]
0x3001	SC_CMMN_PAD_OEN1	0x00	RW	I/O Direction (0: input; 1: output) Bit[7:0]: D[7:0]
0x3002	SC_CMMN_PAD_OEN2	0x00	RW	I/O Direction (0: input; 1: output) Bit[7]: VSYNC Bit[5]: PCLK Bit[4]: FREX Bit[3]: STROBE Bit[2]: CSD Bit[1]: CSK Bit[0]: GPIO
0x3008	SC_CMMN_PAD_OUT0	0x00	RW	I/O Output Value Bit[3:0]: D[11:8]
0x3009	SC_CMMN_PAD_OUT1	0x00	RW	I/O Output Value Bit[7:0]: D[7:0]
0x300A	SC_CMMN_CHIP_ID	0x56	R	Chip ID High Byte
0x300B	SC_CMMN_CHIP_ID	0x48	R	Chip ID Low Byte
0x300C	SC_CMMN_SCCB_ID	0x6C	RW	SCCB ID
0x300D	SC_CMMN_PAD_OUT2	0x00	RW	I/O Output Value Bit[7]: VSYNC Bit[5]: PCLK Bit[4]: FREX Bit[3]: STROBE Bit[2]: CSD Bit[1]: CSK Bit[0]: GPIO
0x300E	SC_CMMN_PAD_SEL0	0x00	RW	I/O Pad Select Bit[3:0]: D[11:8]
0x300F	SC_CMMN_PAD_SEL1	0x00	RW	I/O Pad Select Bit[7:0]: D[7:0]

table 6-1 system control registers (sheet 2 of 4)

address	register name	default value	R/W	description
0x3010	SC_CMMN_PAD_SEL2	0x00	RW	I/O Pad Select Bit[7]: VSYNC Bit[5]: PCLK Bit[4]: FREX Bit[3]: STROBE Bit[2]: CSD Bit[1]: CSK Bit[0]: GPIO
0x3011	SC_CMMN_PAD_PK	0x02	RW	Bit[7]: pd_dato_en Bit[6:5]: IO drive strength 00: 1x 01: 1x 10: 2x 11: 2x Bit[1]: FREX pad enable
0x3013	SC_CMMN_A_PWC_PK_O	0x00	RW	Bit[3]: bp_regulator 0: Enable internal regulator 1: Disable internal regulator
0x3014	SC_CMMN_A_PWC_PK_O	0x0B	RW	Bit[6:4]: apd[2:0] Bit[3:0]: dio
0x3016	SC_CMMN_MIPI_PHY	0xA0	RW	Bit[7:6]: lph Bit[3]: mipi_pad_enable Bit[2]: pgm_bp_hs_en_lat Bypass the latch of hs_enable Bit[1:0]: ictl[1:0] Bias current adjustment
0x3017	SC_CMMN_MIPI_PHY	0x00	RW	Bit[7:6]: pgm_vcm[1:0] High speed common mode voltage Bit[5:4]: ck_skew Bit[3:2]: d1_skew Bit[1:0]: d0_skew

table 6-1 system control registers (sheet 3 of 4)

address	register name	default value	R/W	description
0x3018	SC_CMMN_MIPI_SC_CTRL	0x4C	RW	Bit[7:5]: mipi_lane_mode 001: One lane mode 010: Two lane mode others: Not used Bit[4]: r_phy_pd_mipi 1: Power down PHY HS TX Bit[3]: r_phy_pd_lprx 1: Power down PHY LP RX module Bit[2]: mipi_en 0: DVP enable 1: MIPI enable Bit[1]: mipi_susp_reg MIPI system suspend register 1: Suspend Bit[0]: lane_dis_op 0: Use mipi_release1/2 and lane_disable1/2 to disable two data lane 1: Use lane_disable1/2 to disable two data lane
0x3019	SC_CMMN_MIPI_SC_CTRL	0x10	RW	Bit[7:0]: MIPI ULPS resume mark1 detect length
0x3021	SC_CMMN_MISC_CTRL	0x23	RW	Bit[5]: fst_stby_ctr 0: Software standby enter at v_blk 1: Software standby enter at l_blk Bit[4]: mipi_ctr_en 0: Disable the function 1: Enable MIPI remote reset and suspend control SC Bit[3]: mipi_rst_sel 0: MIPI remote reset all registers 1: MIPI remote reset all digital modules Bit[2]: gpio_pclk_en Bit[1]: frex_ef_sel Bit[0]: cen_global_o
0x3022	SC_CMMN_MIPI_SC_CTRL	0x00	RW	Bit[3]: lptx_ck_opt Bit[2]: pull_down_clk_lane Bit[1]: pull_down_data_lane2 Bit[0]: pull_down_data_lane1
0x302A	SC_CMMN_SUB_ID	0xB1	R	Bit[7:4]: Process Bit[3:0]: Version

table 6-1 system control registers (sheet 4 of 4)

address	register name	default value	R/W	description
0x3034	SC_CMMN_PLL_CTRL0	0x1A	RW	Bit[6:4]: pll_charge_pump Bit[3:0]: mipi_bit_mode 0000: 8-bit mode 0001: 10-bit mode
0x3035	SC_CMMN_PLL_CTRL1	0x21	RW	Bit[7:4]: system_pll_div Bit[3:0]: scale_divider_mipi
0x3036	SC_CMMN_PLL_MULTIPLIER	0x69	RW	Bit[7:0]: PLL_multiplier (4~252) This can be any integer during 4~127 and only even integer during 128~252
0x3037	SC_CMMN_PLL_CTRL13	0x03	RW	Bit[4]: pll_root_div 0: Bypass 1: /2 Bit[3:0]: pll_prediv 1, 2, 3, 4, 6, 8
0x3038	SC_CMMN_PLL_DEBUG_OPT	0x00	RW	Bit[7]: pll_mult_debug_en Bit[1:0]: pll_mult1_debug
0x3039	SC_CMMN_PLL_CTRL_R	0x00	RW	Bit[7]: pll_bypass
0x303A	SC_CMMN_PLLS_CTRL0	0x00	RW	Bit[7]: plls_bypass
0x303B	SC_CMMN_PLLS_CTRL1	0x19	RW	Bit[4:0]: plls_multiplier
0x303C	SC_CMMN_PLLS_CTRL2	0x11	RW	Bit[6:4]: plls_cp Bit[3:0]: plls_sys_div
0x303D	SC_CMMN_PLLS_CTRL3	0x30	RW	Bit[5:4]: plls_pre_div 00: /1 01: /1.5 10: /2 11: /3 Bit[2]: plls_div_r 0: /1 1: /2 Bit[1:0]: plls_seld5 00: /1 01: /1 10: /2 11: /2.5

6.2 SCCB

table 6-2 system control registers

address	register name	default value	R/W	description
0x300C	SC_CMMN_SCCB_ID	0x6C	RW	SCCB ID

6.3 group register write

The OV5648 supports group register write with up to four groups. Each group could have up to 16 registers.

Example settings:

6C 0x3208 0x00; Group 0 begin

6C 0x3503 0x03; register 1

6C 0x3501 0x7A; register 2

6C 0x3502 0xA0; register 3

6C 0x3208 0x10; Group 0 end

6C 0x3208 0xA0; write register group 0

table 6-3 group hold control registers (sheet 1 of 2)

address	register name	default value	R/W	description
0x3200	GROUP ADR0	0x00	RW	Group0 Start Address in SRAM, actual address is {0x3200[3:0], 4'h0}
0x3201	GROUP ADR1	0x08	RW	Group1 Start Address in SRAM, actual address is {0x3201[3:0], 4'h0}
0x3202	GROUP ADR2	0x10	RW	Group2 Start Address in SRAM, actual address is {0x3202[3:0], 4'h0}
0x3203	GROUP ADR3	0x18	RW	Group3 Start Address in SRAM, actual address is {0x3203[3:0], 4'h0}
0x3204	GROUP LEN0	–	R	Length of Group0
0x3205	GROUP LEN1	–	R	Length of Group1
0x3206	GROUP LEN2	–	R	Length of Group2
0x3207	GROUP LEN3	–	R	Length of Group3

table 6-3 group hold control registers (sheet 2 of 2)

address	register name	default value	R/W	description
0x3208	GROUP ACCESS	–	W	Bit[7:4]: Group_ctrl 0000: Enter group write mode 0001: Exit group write mode 1010: Initiate group write Bit[3:0]: Group ID 0000: Group 0 0001: Group 1 0010: Group 2 0011: Group 3

6.4 timing control

table 6-4 timing control registers (sheet 1 of 2)

address	register name	default value	R/W	description
0x3800	TIMING_X_ADDR_START	0x00	RW	Bit[3:0]: x_addr_start[11:8]
0x3801	TIMING_X_ADDR_START	0x0C	RW	Bit[7:0]: x_addr_start[7:0]
0x3802	TIMING_Y_ADDR_START	0x00	RW	Bit[3:0]: y_addr_start[11:8]
0x3803	TIMING_Y_ADDR_START	0x04	RW	Bit[7:0]: y_addr_start[7:0]
0x3804	TIMING_X_ADDR_END	0x0A	RW	Bit[3:0]: x_addr_end[11:8]
0x3805	TIMING_X_ADDR_END	0x33	RW	Bit[7:0]: x_addr_end[7:0]
0x3806	TIMING_Y_ADDR_END	0x07	RW	Bit[3:0]: y_addr_end[11:8]
0x3807	TIMING_Y_ADDR_END	0xA3	RW	Bit[7:0]: y_addr_end[7:0]
0x3808	TIMING_X_OUTPUT_SIZE	0x0A	RW	Bit[3:0]: Video output horizontal width[11:8]
0x3809	TIMING_X_OUTPUT_SIZE	0x20	RW	Bit[7:0]: Video output horizontal width[7:0]
0x380A	TIMING_Y_OUTPUT_SIZE	0x07	RW	Bit[3:0]: Video output vertical height[11:8]
0x380B	TIMING_Y_OUTPUT_SIZE	0x98	RW	Bit[7:0]: Video output vertical height[7:0]
0x380C	TIMING_HTS	0x0B	RW	Bit[4:0]: Total horizontal size[12:8]
0x380D	TIMING_HTS	0x00	RW	Bit[7:0]: Total horizontal size[7:0]
0x380E	TIMING_VTS	0x07	RW	Bit[7:0]: Total vertical size[15:8]
0x380F	TIMING_VTS	0xC0	RW	Bit[7:0]: Total vertical size[7:0]
0x3810	TIMING_ISP_X_WIN	0x00	RW	Bit[3:0]: ISP horizontal offset[11:8]

table 6-4 timing control registers (sheet 2 of 2)

address	register name	default value	R/W	description
0x3811	TIMING_ISP_X_WIN	0x04	RW	Bit[7:0]: ISP horizontal offset[7:0]
0x3812	TIMING_ISP_Y_WIN	0x00	RW	Bit[3:0]: ISP vertical offset[11:8]
0x3813	TIMING_ISP_Y_WIN	0x02	RW	Bit[7:0]: ISP vertical offset[7:0]
0x3814	TIMING_X_INC	0x11	RW	Bit[7:4]: h_odd_inc Horizontal subsample odd increase number Bit[3:0]: h_even_inc Horizontal subsample even increase number
0x3815	TIMING_Y_INC	0x11	RW	Bit[7:4]: v_odd_inc Vertical subsample odd increase number Bit[3:0]: v_even_inc Vertical subsample even increase number
0x3816	TIMING_HSYNCST	0x00	RW	Bit[3:0]: HSYNC start point[11:8]
0x3817	TIMING_HSYNCST	0x00	RW	Bit[7:0]: HSYNC start point[7:0]
0x3818	TIMING_HSYNCW	0x00	RW	Bit[3:0]: HSYNC window[11:8]
0x3819	TIMING_HSYNCW	0x00	RW	Bit[7:0]: HSYNC window[7:0]
0x3820	TIMING_TC_REG20	0x40	RW	Bit[2]: ISP vertical flip Bit[1]: Sensor vertical flip Bit[0]: Vertical binning
0x3821	TIMING_TC_REG21	0x00	RW	Bit[2]: ISP mirror Bit[1]: Sensor mirror Bit[0]: Horizontal binning

6.5 frame control (FC)

Frame control (FC) is used to mask some specified frame by setting the appropriate registers.

table 6-5 frame control registers

address	register name	default value	R/W	description
0x4200	FRAME CONTROL00	0x00	RW	Bit[2]: fcnt_eof_sel Bit[1]: fcnt_mask_dis Bit[0]: Frame counter reset
0x4201	FRAME CONTROL01	0x00	RW	Control Passed Frame Number Bit[3:0]: Frame ON number When both ON and OFF numbers are set to 0x00, frame control is in bypass mode
0x4202	FRAME CONTROL02	0x00	RW	Control Masked Frame Number Bit[3:0]: Frame OFF number When both ON and OFF numbers are set to 0x00, frame control is in bypass mode
0x4203	FRAME CONTROL03	0x00	RW	Bit[6]: rblue_mask_dis Bit[5]: data_mask_dis Bit[4]: valid_mask_dis Bit[3]: href_mask_dis Bit[2]: eof_mask_dis Bit[1]: sof_mask_dis Bit[0]: all_mask_dis

6.6 mobile industry processor interface (MIPI)

The OV5648 provides one clock lane and two data lanes for the communications link between sensor (transmitter) and receiver inside a mobile device. It follows MIPI specifications D-PHY 0.89 and above and CSI2-V1, and supports all mandatory MIPI features. Most of the optional features (e.g., LP transfer mode) are not supported unless otherwise specified in this specification. For any further questions, contact your local OmniVision FAE for more details.

table 6-6 MIPI transmitter registers (sheet 1 of 6)

address	register name	default value	R/W	description
0x4800	MIPI CTRL 00	0x04	RW	MIPI Control 00 Bit[7:6]: Debug mode Bit[5]: Clock lane gate enable 0: Clock lane is free running 1: Gate clock lane when no packet to transmit Bit[4]: Line sync enable 0: Do not send line short packet for each line 1: Send line short packet for each line Bit[3]: Lane select 0: Use lane1 as default data lane 1: Use lane2 as default data lane Bit[2]: Idle status 0: MIPI bus will be LP00 when no packet to transmit 1: MIPI bus will be LP11 when no packet to transmit Bit[1:0]: Debug mode

table 6-6 MIPI transmitter registers (sheet 2 of 6)

address	register name	default value	R/W	description
0x4801	MIPI CTRL 01	0x0F	RW	<p>MIPI Control 01</p> <p>Bit[7]: Long packet data type manual enable</p> <p>0: Use mipi_dt</p> <p>1: Use dt_man_o as long packet data (see register 0x4814[5:0])</p> <p>Bit[6]: Short packet data type manual enable</p> <p>1: Use dt_spkt as short packet data (see register 0x4815[5:0])</p> <p>Bit[5]: Short packet word counter manual enable</p> <p>0: Use frame counter or line counter</p> <p>1: Select spkt_wc_reg_o (see {0x4812, 0x4813})</p> <p>Bit[4]: PH bit order for ECC</p> <p>0: {DI[7:0],WC[7:0],WC[15:8]}</p> <p>1: {DI[0:7],WC[0:7],WC[8:15]}</p> <p>Bit[3]: PH byte order for ECC</p> <p>0: {DI,WC_l,WC_h}</p> <p>1: {DI,WC_h,WC_l}</p> <p>Bit[2]: PH byte order2 for ECC</p> <p>0: {DI,WC}</p> <p>1: {WC,DI}</p> <p>Bit[1:0]: Debug mode</p>

table 6-6 MIPI transmitter registers (sheet 3 of 6)

address	register name	default value	R/W	description
0x4802	MIPI CTRL 02	0x00	RW	MIPI Control 02
				Bit[7]: hs_prepare_sel 0: Auto calculate T_hs_prepare, unit pclk2x 1: Use hs_prepare_min_o[7:0]
				Bit[6]: clk_prepare_sel 0: Auto calculate T_clk_prepare, unit pclk2x 1: Use clk_prepare_min_o[7:0]
				Bit[5]: clk_post_sel 0: Auto calculate T_clk_post, unit pclk2x 1: Use clk_post_min_o[7:0]
				Bit[4]: clk_trail_sel 0: Auto calculate T_clk_trail, unit pclk2x 1: Use clk_trail_min_o[7:0]
				Bit[3]: hs_exit_sel 0: Auto calculate T_hs_exit, unit pclk2x 1: Use hs_exit_min_o[7:0]
				Bit[2]: hs_zero_sel 0: Auto calculate T_hs_zero, unit pclk2x 1: Use hs_zero_min_o[7:0]
				Bit[1]: hs_trail_sel 0: Auto calculate T_hs_trail, unit pclk2x 1: Use hs_trail_min_o[7:0]
				Bit[0]: clk_zero_sel 0: Auto calculate T_clk_zero, unit pclk2x 1: Use clk_zero_min_o[7:0]
0x4805	MIPI CTRL 05	0x10	RW	MIPI Control 05
				Bit[7]: MIPI lane1 disable 1: Disable MIPI data lane1, lane1 will be LP00
				Bit[6]: MIPI lane2 disable 1: Disable MIPI data lane2, lane2 will be LP00
				Bit[5]: lpx_p_sel 0: Auto calculate t_lpx_o in pclkex domain, unit pclk2x 1: Use lp_p_min[7:0]
				Bit[4]: lp_rx_intr_sel 0: Send lp_rx_intr_o at the first byte 1: Send lp_rx_intr_o at the end of receiving
				Bit[3:1]: Debug mode Bit[0]: Not used
0x4810	MIPI MAX FRAME COUNT	0xFF	RW	High Byte of Maximum Frame Count of Frame Sync Short Packet

table 6-6 MIPI transmitter registers (sheet 4 of 6)

address	register name	default value	R/W	description
0x4811	MIPI_MAX_FRAME_COUNT	0xFF	RW	Low Byte of Maximum Frame Count of Frame Sync Short Packet
0x4814	MIPI_CTRL14	0x2A	RW	MIPI Control 14 Bit[7:6]: Virtual channel of MIPI Bit[5:0]: Data type in manual mode
0x4815	MIPI_DT_SPKT	0x00	RW	Bit[6]: Debug mode Bit[5:0]: Manual data type for short packet
0x4818	HS_ZERO_MIN	0x00	RW	High Byte of Minimum Value for hs_zero Unit ns
0x4819	HS_ZERO_MIN	0x96	RW	Low Byte of Minimum Value for hs_zero, unit ns $hs_zero_real = hs_zero_min_o + Tui*ui_hs_zero_min_o$
0x481A	HS_TRAIL_MIN	0x00	RW	High Byte of Minimum Value for hs_trail, unit ns
0x481B	HS_TRAIL_MIN	0x3C	RW	Low Byte of Minimum Value for hs_trail, $hs_trail_real = hs_trail_min_o + Tui*ui_hs_trail_min_o$
0x481C	CLK_ZERO_MIN	0x01	RW	High Byte of Minimum Value for clk_zero, unit ns
0x481D	CLK_ZERO_MIN	0x86	RW	Low Byte of Minimum Value for clk_zero, $clk_zero_real = clk_zero_min_o + Tui*ui_clk_zero_min_o$
0x481E	CLK_PREPARE_MIN	0x00	RW	High Byte of Minimum Value for clk_prepare, unit ns Bit[1:0]: $clk_prepare_min[9:8]$
0x481F	CLK_PREPARE_MIN	0x3C	RW	Low Byte of Minimum Value for clk_prepare $clk_prepare_real = clk_prepare_min_o + Tui*ui_clk_prepare_min_o$
0x4820	CLK_POST_MIN	0x00	RW	High Byte of Minimum Value for clk_post, unit ns Bit[1:0]: $clk_post_min[9:8]$
0x4821	CLK_POST_MIN	0x56	RW	Low Byte of Minimum Value for clk_post $clk_post_real = clk_post_min_o + Tui*ui_clk_post_min_o$
0x4822	CLK_TRAIL_MIN	0x00	RW	High Byte of Minimum Value for clk_trail, unit ns Bit[1:0]: $clk_trail_min[9:8]$
0x4823	CLK_TRAIL_MIN	0x3C	RW	Low Byte of Minimum Value for clk_trail $clk_trail_real = clk_trail_min_o + Tui*ui_clk_trail_min_o$
0x4824	LPX_P_MIN	0x00	RW	High Byte of Minimum Value for lpx_p, unit ns Bit[1:0]: $lpx_p_min[9:8]$
0x4825	LPX_P_MIN	0x32	RW	Low Byte of Minimum Value for lpx_p $lpx_p_real = lpx_p_min_o + Tui*ui_lpx_p_min_o$

table 6-6 MIPI transmitter registers (sheet 5 of 6)

address	register name	default value	R/W	description
0x4826	HS_PREPARE_MIN	0x00	RW	High Byte of Minimum Value for hs_prepare, unit ns Bit[1:0]: hs_prepare_min[9:8]
0x4827	HS_PREPARE_MIN	0x32	RW	Low Byte of Minimum Value for hs_prepare $hs_prepare_real = hs_prepare_min_o + Tui * ui_hs_prepare_min_o$
0x4828	HS_EXIT_MIN	0x00	RW	High Byte of Minimum Value for hs_exit, unit ns Bit[1:0]: hs_exit_min[9:8]
0x4829	HS_EXIT_MIN	0x64	RW	Low Byte of Minimum Value for hs_exit $hs_exit_real = hs_exit_min_o + Tui * ui_hs_exit_min_o$
0x482A	UI_HS_ZERO_MIN	0x06	RW	Minimum UI Value of hs_zero, unit UI
0x482B	UI_HS_TRAIL_MIN	0x04	RW	Minimum UI Value of hs_trail, unit UI
0x482C	UI_CLK_ZERO_MIN	0x00	RW	Minimum UI Value of clk_zero, unit UI
0x482D	UI_CLK_PREPARE_MIN	0x00	RW	Minimum UI Value of clk_prepare, unit UI
0x482E	UI_CLK_POST_MIN	0x34	RW	Minimum UI Value of clk_post, unit UI
0x482F	UI_CLK_TRAIL_MIN	0x00	RW	Minimum UI Value of clk_trail, unit UI
0x4830	UI_LPX_P_MIN	0x00	RW	Minimum UI Value of lpx_p, unit UI
0x4831	UI_HS_PREPARE_MIN	0x04	RW	Minimum UI Value of hs_prepare, unit UI
0x4832	UI_HS_EXIT_MIN	0x00	RW	Minimum UI Value of hs_exit, unit UI
0x4833	MIPI_REG_MIN	0x00	RW	MIPI Register Address, Lower Bound (High Byte) Address range of MIPI RW registers is from mipi_reg_min to mipi_reg_max
0x4834	MIPI_REG_MIN	0x00	RW	MIPI Register Address, Lower Bound (Low Byte)
0x4835	MIPI_REG_MAX	0xFF	RW	MIPI Register Address, Upper Bound (High Byte)
0x4836	MIPI_REG_MAX	0xFF	RW	MIPI Register Address, Upper Bound (Low Byte)
0x4837	PCLK_PERIOD	0x18	RW	Period of pclk2x, pclk_div = 1, and 1-bit decimal
0x4838	WKUP_DLY	0x02	RW	Wakeup Delay for MIPI
0x483A	DEBUG MODE	–	–	Debug Mode

table 6-6 MIPI transmitter registers (sheet 6 of 6)

address	register name	default value	R/W	description
0x483B	MIPI_LP_GPIO	0x33	RW	Bit[7]: lp_sel1 0: Auto generate mipi_lp_dir1_o 1: Use lp_dir_man1 as mipi_lp_dir1_o Bit[6]: lp_dir_man1 0: Input 1: Output Bit[5]: lp_p1_o Bit[4]: lp_n1_o Bit[3]: lp_sel2 0: Auto generate mipi_lp_dir2_o 1: Use lp_dir_man2 as mipi_lp_dir2_o Bit[2]: lp_dir_man2 0: Input 1: Output Bit[1]: lp_p2_o Bit[0]: lp_n2_o
0x483C	MIPI_CTRL_33	0x4F	RW	Bit[7:4]: t_lpx Unit: sclk cycles Bit[3:0]: t_clk_pre Unit: sclk cycles
0x483D~ 0x483F	DEBUG MODE	–	–	Debug Mode
0x4843	SNR_PCLK_DIV	0x03	RW	Bit[0]: PCLK divider 0: PCLK/SCLK = 2 and pclk_div = 1 1: PCLK/SCLK = 1 and pclk_div = 1

7 register tables

The following tables provide descriptions of the device control registers contained in the OV5648. For all registers enable/disable bits, ENABLE = 1 and DISABLE = 0. The device slave addresses are 0x6C for write and 0x6D for read.

7.1 system control [0x3000 - 0x3209]

table 7-1 system control registers (sheet 1 of 5)

address	register name	default value	R/W	description
0x3000	SC_CMMN_PAD_OEN0	0x00	RW	I/O Direction (0: input; 1: output) Bit[7:4]: Not used Bit[3:0]: D[11:8]
0x3001	SC_CMMN_PAD_OEN1	0x00	RW	I/O Direction (0: input; 1: output) Bit[7:0]: D[7:0]
0x3002	SC_CMMN_PAD_OEN2	0x00	RW	I/O Direction (0: input; 1: output) Bit[7]: VSYNC Bit[6]: Not used Bit[5]: PCLK Bit[4]: FREX Bit[3]: STROBE Bit[2]: CSD Bit[1]: CSK Bit[0]: GPIO
0x3003~ 0x3005	DEBUG MODE	–	–	Debug Mode
0x3006	SC_CMMN_PLL_CTR13	0x00	RW	Bit[7:0]: Debug control Changing these registers is not recommended
0x3007	DEBUG MODE	–	–	Debug Mode
0x3008	SC_CMMN_PAD_OUT0	0x00	RW	I/O Output Value Bit[7:4]: Not used Bit[3:0]: D[11:8]
0x3009	SC_CMMN_PAD_OUT1	0x00	RW	I/O Output Value Bit[7:0]: D[7:0]
0x300A	SC_CMMN_CHIP_ID	0x56	R	Chip ID High Byte
0x300B	SC_CMMN_CHIP_ID	0x48	R	Chip ID Low Byte
0x300C	SC_CMMN_SCCB_ID	0x6C	RW	SCCB ID

table 7-1 system control registers (sheet 2 of 5)

address	register name	default value	R/W	description
0x300D	SC_CMMN_PAD_OUT2	0x00	RW	I/O Output Value Bit[7]: VSYNC Bit[6]: Not used Bit[5]: PCLK Bit[4]: FREX Bit[3]: STROBE Bit[2]: CSD Bit[1]: CSK Bit[0]: GPIO
0x300E	SC_CMMN_PAD_SEL0	0x00	RW	I/O Pad Select Bit[7:4]: Not used Bit[3:0]: D[11:8]
0x300F	SC_CMMN_PAD_SEL1	0x00	RW	I/O Pad Select Bit[7:0]: D[7:0]
0x3010	SC_CMMN_PAD_SEL2	0x00	RW	I/O Pad Select Bit[7]: VSYNC Bit[6]: Not used Bit[5]: PCLK Bit[4]: FREX Bit[3]: STROBE Bit[2]: CSD Bit[1]: CSK Bit[0]: GPIO
0x3011	SC_CMMN_PAD_PK	0x02	RW	Bit[7]: pd_dato_en Bit[6:5]: IO drive strength 00: 1x 01: 1x 10: 2x 11: 2x Bit[4:2]: Not used Bit[1]: FREX pad enable 0: Enable 1: Disable Bit[0]: Not used
0x3012	DEBUG MODE	–	–	Debug Mode
0x3013	SC_CMMN_A_PWC_PK_O	0x00	RW	Bit[7:4]: Debug control Changing these registers is not recommended Bit[3]: bp_regulator 0: Enable internal regulator 1: Disable internal regulator Bit[2:0]: Debug control Changing these registers is not recommended

table 7-1 system control registers (sheet 3 of 5)

address	register name	default value	R/W	description
0x3014	SC_CMMN_A_PWC_PK_O	0x0B	RW	Bit[7]: Not used Bit[6:4]: apd[2:0] Bit[3:0]: dio
0x3016	SC_CMMN_MIPI_PHY	0xA0	RW	Bit[7:6]: lph Bit[5:4]: Not used Bit[3]: mipi_pad_enable Bit[2]: pgm_bp_hs_en_lat Bypass the latch of hs_enable Bit[1:0]: ictl[1:0] Bias current adjustment
0x3017	SC_CMMN_MIPI_PHY	0x00	RW	Bit[7:6]: pgm_vcm[1:0] High speed common mode voltage Bit[5:4]: ck_skew Bit[3:2]: d1_skew Bit[1:0]: d0_skew
0x3018	SC_CMMN_MIPI_SC_CTRL	0x4C	RW	Bit[7:5]: mipi_lane_mode 001: One lane mode 010: Two lane mode Others: Not used Bit[4]: r_phy_pd_mipi 0: Not used 1: Power down PHY HS TX Bit[3]: r_phy_pd_lprx 0: Not used 1: Power down PHY LP RX module Bit[2]: mipi_en 1: MIPI enable Bit[1]: mipi_susp_reg MIPI system suspend register 0: Not used 1: Suspend Bit[0]: lane_dis_op 0: Use mipi_release1/2 and lane_disable1/2 to disable two data lane 1: Use lane_disable1/2 to disable two data lane
0x3019	SC_CMMN_MIPI_SC_CTRL	0x10	RW	Bit[7:0]: MIPI ULPS resume mark1 detect length
0x301A~0x3020	DEBUG MODE	–	–	Debug Mode

table 7-1 system control registers (sheet 4 of 5)

address	register name	default value	R/W	description
0x3021	SC_CMMN_MISC_CTRL	0x23	RW	Bit[7:6]: Not used Bit[5]: fst_stby_ctr 0: Software standby enter at v_blk 1: Software standby enter at l_blk Bit[4]: mipi_ctr_en 1: Enable MIPI remote reset and suspend control SC 0: Disable the function Bit[3]: mipi_rst_sel 0: MIPI remote reset all registers 1: MIPI remote reset all digital modules Bit[2]: gpio_pclk_en Bit[1]: frex_ef_sel Bit[0]: cen_global_o
0x3022	SC_CMMN_MIPI_SC_CTRL	0x00	RW	Bit[7:4]: Not used Bit[3]: lptx_ck_opt Bit[2]: pull_down_clk_lane Bit[1]: pull_down_data_lane2 Bit[0]: pull_down_data_lane1
0x302A	SC_CMMN_SUB_ID	0xB1	R	Bit[7:4]: Process Bit[3:0]: Version
0x3034	SC_CMMN_PLL_CTRL0	0x1A	RW	Bit[7]: Not used Bit[6:4]: pll_charge_pump Bit[3:0]: mipi_bit_mode 1000: 8-bit mode 1010: 10-bit mode
0x3035	SC_CMMN_PLL_CTRL1	0x21	RW	Bit[7:4]: system_pll_div Bit[3:0]: scale_divider_mipi
0x3036	SC_CMMN_PLL_MULTIPLIER	0x69	RW	Bit[7:0]: PLL_multiplier (4~252) This can be any integer during 4~127 and only even integer during 128~252
0x3037	SC_CMMN_PLL_CTR13	0x03	RW	Bit[7:5]: Debug mode Bit[4]: pll_root_div 0: Bypass 1: /2 Bit[3:0]: pll_prediv 1, 2, 3, 4, 6, 8
0x3038	SC_CMMN_PLL_DEBUG_OPT	0x00	RW	Bit[7]: pll_mult_debug_en Bit[1:0]: pll_mult1_debug

table 7-1 system control registers (sheet 5 of 5)

address	register name	default value	R/W	description
0x3039	SC_CMMN_PLL_CTRL_R	0x00	RW	Bit[7]: pll_bypass Bit[6:0]: Not used
0x303A	SC_CMMN_PLLS_CTRL0	0x00	RW	Bit[7]: plls_bypass Bit[6:0]: Not used
0x303B	SC_CMMN_PLLS_CTRL1	0x19	RW	Bit[7:5]: Not used Bit[4:0]: plls_multiplier
0x303C	SC_CMMN_PLLS_CTRL2	0x11	RW	Bit[6:4]: plls_cp Bit[3:0]: plls_sys_div
0x303D	SC_CMMN_PLLS_CTRL3	0x30	RW	Bit[7:6]: Not used Bit[5:4]: plls_pre_div 00: /1 01: /1.5 10: /2 11: /3 Bit[2]: plls_div_r 0: /1 1: /2 Bit[1:0]: plls_seld5 00: /1 01: /1 10: /2 11: /2.5
0x3040~ 0x3044	DEBUG MODE	–	–	Debug Mode
0x3106	SRB CTRL	0xF9	RW	Bit[7:4]: Not used Bit[3:2]: PLL clock divider 00: pll_sclk 01: pll_sclk/2 10: pll_sclk/4 11: pll_sclk Bit[1]: rst_arb 0: Not used 1: Reset arbiter Bit[0]: sclk_arb 0: Not used 1: Enable SCLK to arbiter

7.2 group hold control [0x3200 - 0x3208]

table 7-2 group hold control registers

address	register name	default value	R/W	description
0x3200	GROUP ADR0	0x00	RW	Group0 Start Address in SRAM, actual address is {0x3200[3:0], 4'h0}
0x3201	GROUP ADR1	0x08	RW	Group1 Start Address in SRAM, actual address is {0x3201[3:0], 4'h0}
0x3202	GROUP ADR2	0x10	RW	Group2 Start Address in SRAM, actual address is {0x3202[3:0], 4'h0}
0x3203	GROUP ADR3	0x18	RW	Group3 Start Address in SRAM, actual address is {0x3203[3:0], 4'h0}
0x3204	GROUP LEN0	–	R	Length of Group0
0x3205	GROUP LEN1	–	R	Length of Group1
0x3206	GROUP LEN2	–	R	Length of Group2
0x3207	GROUP LEN3	–	R	Length of Group3
0x3208	GROUP ACCESS	–	W	Bit[7:4]: Group_ctrl 0000: Enter group write mode 0001: Exit group write mode 1010: Initiate group write Bit[3:0]: Group ID 0000: Group 0 0001: Group 1 0010: Group 2 0011: Group 3
0x3209	DEBUG MODE	–	–	Debug Mode

7.3 AEC/AGC [0x3500 - 0x373A, 0x3A00 - 0x3A21, 0x5680 - 0x5A41]

table 7-3 AEC/AGC registers (sheet 1 of 6)

address	register name	default value	R/W	description
0x3500	EXPOSURE	0x00	RW	Bit[7:4]: Not used Bit[3:0]: Exposure[19:16] Exposure in units of 1/16 line
0x3501	EXPOSURE	0x02	RW	Bit[7:0]: Exposure[15:8] Exposure in units of 1/16 line
0x3502	EXPOSURE	0x00	RW	Bit[7:0]: Exposure[7:0] Exposure in units of 1/16 line; lower four bits are a fraction of a line; they should be 0 since OV5648 does not support fraction line exposure
0x3503	MANUAL CTRL	0x00	RW	Bit[7:6]: Not used Bit[5:4]: Gain latch timing delay x0: Gain has no latch delay 01: Gain delay of 1 frame 11: Gain delay of 2 frames Bit[2]: Not used Bit[1]: AGC manual 0: Auto enable 1: Manual enable Bit[0]: AEC manual 0: Auto enable 1: Manual enable
0x350A	AGC	0x00	RW	Bit[7:2]: Not used Bit[1:0]: Gain[9:8] AGC real gain output high byte Gain = {0x350A[1:0], 0x350B[7:0]}/16
0x350B	AGC	0x10	RW	Bit[7:0]: Gain[7:0] AGC real gain output low byte
0x3600~0x3637	ANALOG_CONTROL	–	RW	Analog Control Registers
0x3700~0x373A	ANALOG_CONTROL	–	RW	Analog Control Registers
0x3A00	AEC CTRL00	0x78	RW	Bit[7:6]: Not used Bit[5]: Band function Bit[4]: Band low limit mode Bit[3]: start_sel Bit[2]: Night mode Bit[1]: Not used Bit[0]: Freeze

table 7-3 AEC/AGC registers (sheet 2 of 6)

address	register name	default value	R/W	description
0x3A01	MIN EXPO	0x01	RW	Bit[7:0]: Min expo
0x3A02	MAX EXPO 60	0x3D	RW	Bit[7:0]: Max expo[15:8] Night mode ceiling of 60 Hz
0x3A03	MAX EXPO 60	0x80	RW	Bit[7:0]: Max expo[7:0] Night mode ceiling of 60 Hz
0x3A05	AEC CTRL05	0x30	RW	Bit[7]: f50_reverse 0: Hold 50, 60Hz detect input 1: Switch 50, 60Hz detect input Bit[6]: frame_insert 0: In night mode, insert frame disable 1: In night mode, insert frame enable Bit[5]: step_auto_en 0: Step manual mode 1: Step auto mode Bit[4:0]: step_auto_ratio In step auto mode, set the step ratio setting to adjust speed
0x3A06	AEC CTRL06	0x10	RW	Bit[7:5]: Not used Bit[4:0]: step_man1 Step manual Increase mode fast step
0x3A07	AEC CTRL07	0x18	RW	Bit[7:4]: step_man2 Step manual, slow step Bit[3:0]: step_man3 Step manual, decrease mode fast step
0x3A08	B50 STEP	0x01	RW	Bit[7:2]: Not used Bit[1:0]: b50_step[9:8] Banding step size for 50 Hz
0x3A09	B50 STEP	0x27	RW	Bit[7:0]: b50_step[7:0] Banding step size for 50 Hz
0x3A0A	B60 STEP	0x00	RW	Bit[7:2]: Not used Bit[1:0]: b60_step[9:8] Banding step size for 60 Hz
0x3A0B	B60 STEP	0xF6	RW	Bit[7:0]: b60_step[7:0] Banding step size for 60 Hz
0x3A0C	AEC CTRL0C	0xE4	RW	Bit[7:4]: e1_max Decimal line high limit zone Bit[3:0]: e1_min Decimal line low limit zone

table 7-3 AEC/AGC registers (sheet 3 of 6)

address	register name	default value	R/W	description
0x3A0D	B60 MAX	0x08	RW	Bit[7:6]: Not used Bit[5:0]: b60_max Max banding step number for 60 Hz
0x3A0E	B50 MAX	0x06	RW	Bit[7:6]: Not used Bit[5:0]: b50_max Max banding step number for 50 Hz
0x3A0F	WPT	0x78	RW	Bit[7:0]: WPT Stable range high limit (from unstable state to stable state)
0x3A10	BPT	0x68	RW	Bit[7:0]: BPT Stable range low limit (from unstable state to stable state)
0x3A11	HIGH VPT	0xD0	RW	Bit[7:0]: vpt_high Fast zone high limit (when step ratio auto mode is disabled)
0x3A12	MANUAL AVG	0x00	RW	Bit[7:0]: avg_man
0x3A13	PRE GAIN	0x40	RW	Bit[7]: Not used Bit[6]: Pre-gain enable Bit[5:0]: Pre-gain value
0x3A14	MAX EXPO 50	0x0E	RW	Bit[7:0]: Max expo[15:8] Night mode ceiling of 50 Hz
0x3A15	MAX EXPO 50	0x40	RW	Bit[7:0]: Max expo[7:0] Night mode ceiling of 50 Hz
0x3A17	NIGHT MODE GAIN BASE	0x01	RW	Bit[7:2]: Not used Bit[1:0]: gnight_thre Night mode gain threshold 00: 1x 01: 2x 10: 4x 11: 8x
0x3A18	AEC GAIN CEILING	0x00	RW	Bit[7:2]: Not used Bit[1:0]: gain_ceiling[9:8] Gain ceiling = {0x3A18[1:0], 0x3A19[7:0]}/16
0x3A19	AEC GAIN CEILING	0x7C	RW	Bit[7:0]: gain_ceiling[7:0]
0x3A1A	DIFF MAX	0x04	RW	Bit[7:0]: diff_max
0x3A1B	WPT2	0x78	RW	Bit[7:0]: wpt2 Stable range high limit (from stable state to unstable state)

table 7-3 AEC/AGC registers (sheet 4 of 6)

address	register name	default value	R/W	description
0x3A1C	LED ADD ROW	0x06	RW	Bit[7:0]: led_add_row[15:8] Exposure values added when STROBE is ON
0x3A1D	LED ADD ROW	0x18	RW	Bit[7:0]: led_add_row[7:0] Exposure values added when STROBE is ON
0x3A1E	BPT2	0x68	RW	Bit[7:0]: bpt2 Stable range low limit (from stable state to unstable state)
0x3A1F	LOW VPT	0x40	RW	Bit[7:0]: vpt_low Fast zone low limit (when step ration auto mode is disabled)
0x3A20	AEC CTRL20	0x00	RW	Bit[7:2]: Not used Bit[1]: man_avg_en_i 0: Disable 1: Enable Bit[0]: Not used
0x3A21	AEC CTRL21	0x70	RW	Bit[7:]: Not used Bit[6:4]: Frame insert number Bit[3:0]: Not used
0x5680	X START	0x00	RW	Bit[7:4]: Not used Bit[3:0]: x_start[11:8] Horizontal start position for average window high byte
0x5681	X START	0x00	RW	Bit[7:0]: x_start[7:0] Horizontal start position for average window low byte
0x5682	Y START	0x00	RW	Bit[7:4]: Not used Bit[3:0]: y_start[11:8] Vertical start position for average window high byte
0x5683	Y START	0x00	RW	Bit[7:0]: y_start[7:0] Vertical start position for average window low byte
0x5684	X WINDOW	0x0A	RW	Bit[7:5]: Not used Bit[4:0]: x_window[12:8] Window X in manual average window mode high byte
0x5685	X WINDOW	0x20	RW	Bit[7:0]: x_window[7:0] Window X in manual average window mode low byte

table 7-3 AEC/AGC registers (sheet 5 of 6)

address	register name	default value	R/W	description
0x5686	Y WINDOW	0x07	RW	Bit[7:4]: Not used Bit[3:0]: y_window[11:8] Window Y in manual average window mode high byte
0x5687	Y WINDOW	0x98	RW	Bit[7:0]: y_window[7:0] Window Y in manual average window mode low byte
0x5688	WEIGHT00	0x11	RW	Bit[7:4]: window1_weight Bit[3:0]: window0_weight
0x5689	WEIGHT01	0x11	RW	Bit[7:4]: window3_weight Bit[3:0]: window2_weight
0x568A	WEIGHT02	0x11	RW	Bit[7:4]: window5_weight Bit[3:0]: window4_weight
0x568B	WEIGHT03	0x11	RW	Bit[7:4]: window7_weight Bit[3:0]: window6_weight
0x568C	WEIGHT04	0x11	RW	Bit[7:4]: window9_weight Bit[3:0]: window8_weight
0x568D	WEIGHT05	0x11	RW	Bit[7:4]: window11_weight Bit[3:0]: window10_weight
0x568E	WEIGHT06	0x11	RW	Bit[7:4]: window13_weight Bit[3:0]: window12_weight
0x568F	WEIGHT07	0x11	RW	Bit[7:4]: window15_weight Bit[3:0]: window14_weight
0x5690	AVG CTRL10	0x02	RW	Bit[7:2]: Not used Bit[1]: avg_opt Bit[0]: avg_man 0: Auto average window 1: Manual average window
0x5691	AVG WEIGHT SUM	–	R	avg_wt_sum_o
0x5692	DEBUG MODE	–	–	Debug Mode
0x5693	AVG READOUT	–	R	Bit[7:0]: AVG value
0x5A00	DIGC CTRL0	0x00	RW	Bit[7:4]: Not used Bit[3]: Debug mode Bit[2]: dig_comp_bypass Bit[1]: dig_comp_man_opt Bit[0]: dig_comp_man_en
0x5A02	DIG COMP MAN	0x02	RW	Bit[7:2]: Not used Bit[1:0]: dig_comp_man[9:8]
0x5A03	DIG COMP MAN	0x00	RW	Bit[7:0]: dig_comp_man[7:0]

table 7-3 AEC/AGC registers (sheet 6 of 6)

address	register name	default value	R/W	description
0x5A20	SENSOR GAIN MAN	0x00	RW	Bit[7:1]: Not used Bit[0]: gainc_sensorgain_man[8]
0x5A21	SENROR GAIN MAN	0x00	RW	Bit[7:0]: gainc_sensorgain_man[7:0]
0x5A22	DIG COMP MAN	0x00	RW	Bit[7:2]: Not used Bit[1:0]: gainc_dgc_man[9:8]
0x5A23	DIG COMP MAN	0x00	RW	Bit[7:0]: gainc_dgc_man[7:0]
0x5A24	GAINC CTRL0	0x00	RW	Bit[7:3]: Not used Bit[2]: Debug mode Bit[1]: bypass_opt Bit[0]: gainc_man_en
0x5A40	GAINF ANA NUM	0x07	RW	Bit[7:0]: gainf_ana_bit_num
0x5A41	GAINF DIG GAIN	0x00	RW	Bit[7:0]: gainf_dig_gain

7.4 timing control [0x3800 ~ 0x3834]

table 7-4 system timing registers (sheet 1 of 3)

address	register name	default value	R/W	description
0x3800	TIMING_X_ADDR_START	0x00	RW	Bit[7:4]: Not used Bit[3:0]: x_addr_start[11:8]
0x3801	TIMING_X_ADDR_START	0x0C	RW	Bit[7:0]: x_addr_start[7:0]
0x3802	TIMING_Y_ADDR_START	0x00	RW	Bit[7:4]: Not used Bit[3:0]: y_addr_start[11:8]
0x3803	TIMING_Y_ADDR_START	0x04	RW	Bit[7:0]: y_addr_start[7:0]
0x3804	TIMING_X_ADDR_END	0x0A	RW	Bit[7:4]: Not used Bit[3:0]: x_addr_end[11:8]
0x3805	TIMING_X_ADDR_END	0x33	RW	Bit[7:0]: x_addr_end[7:0]
0x3806	TIMING_Y_ADDR_END	0x07	RW	Bit[7:4]: Not used Bit[3:0]: y_addr_end[11:8]
0x3807	TIMING_Y_ADDR_END	0xA3	RW	Bit[7:0]: y_addr_end[7:0]
0x3808	TIMING_X_OUTPUT_SIZE	0x0A	RW	Bit[7:4]: Not used Bit[3:0]: Video output horizontal width[11:8]

table 7-4 system timing registers (sheet 2 of 3)

address	register name	default value	R/W	description
0x3809	TIMING_X_OUTPUT_SIZE	0x20	RW	Bit[7:0]: Video output horizontal width[7:0]
0x380A	TIMING_Y_OUTPUT_SIZE	0x07	RW	Bit[7:4]: Not used Bit[3:0]: Video output vertical height[11:8]
0x380B	TIMING_Y_OUTPUT_SIZE	0x98	RW	Bit[7:0]: Video output vertical height[7:0]
0x380C	TIMING_HTS	0x0B	RW	Bit[7:5]: Not used Bit[4:0]: Total horizontal size[12:8]
0x380D	TIMING_HTS	0x00	RW	Bit[7:0]: Total horizontal size[7:0]
0x380E	TIMING_VTS	0x07	RW	Bit[7:0]: Total vertical size[15:8]
0x380F	TIMING_VTS	0xC0	RW	Bit[7:0]: Total vertical size[7:0]
0x3810	TIMING_ISP_X_WIN	0x00	RW	Bit[7:4]: Not used Bit[3:0]: ISP horizontal offset[11:8]
0x3811	TIMING_ISP_X_WIN	0x04	RW	Bit[7:0]: ISP horizontal offset[7:0]
0x3812	TIMING_ISP_Y_WIN	0x00	RW	Bit[7:4]: Not used Bit[3:0]: ISP vertical offset[11:8]
0x3813	TIMING_ISP_Y_WIN	0x02	RW	Bit[7:0]: ISP vertical offset[7:0]
0x3814	TIMING_X_INC	0x11	RW	Bit[7:4]: h_odd_inc Horizontal subsample odd increase number Bit[3:0]: h_even_inc Horizontal subsample even increase number
0x3815	TIMING_Y_INC	0x11	RW	Bit[7:4]: v_odd_inc Vertical subsample odd increase number Bit[3:0]: v_even_inc Vertical subsample even increase number
0x3816	TIMING_HSYNCST	0x00	RW	Bit[7:4]: Not used Bit[3:0]: HSYNC start point[11:8]
0x3817	TIMING_HSYNCST	0x00	RW	Bit[7:0]: HSYNC start point[7:0]
0x3818	TIMING_HSYNCW	0x00	RW	Bit[7:4]: Not used Bit[3:0]: HSYNC window[11:8]
0x3819	TIMING_HSYNCW	0x00	RW	Bit[7:0]: HSYNC window[7:0]

table 7-4 system timing registers (sheet 3 of 3)

address	register name	default value	R/W	description
0x3820	TIMING_TC_REG20	0x40	RW	Bit[7]: Not used Bit[6:4]: For testing only Bit[3]: Not used Bit[2]: ISP vertical flip Bit[1]: Sensor vertical flip Bit[0]: Vertical binning
0x3821	TIMING_TC_REG21	0x00	RW	Bit[7:5]: For testing only Bit[4]: Not used Bit[3]: For testing only Bit[2]: ISP mirror Bit[1]: Sensor mirror Bit[0]: Horizontal binning
0x3822~ 0x3834	DEBUG MODE	–	–	Debug Mode

7.5 strobe/frame exposure [0x3B00 ~ 0x3B0C]

table 7-5 strobe/frame exposure control registers (sheet 1 of 2)

address	register name	default value	R/W	description
0x3B00	STROBE_RSTRB	0x00	RW	Strobe Control Bit[7]: Strobe request ON/OFF 0: OFF/BLC 1: ON Bit[6]: Strobe pulse reverse Bit[3:2]: width_in_xenon 00: 1 row period 01: 2 row period 10: 3 row period 11: 4 row period Bit[1:0]: Strobe mode 00: xenon 01: LED 1 10: LED 2 11: LED 3
0x3B01	STROBE_FREX_EXP_H2	0x00	RW	Bit[7:0]: frex_exp[23:16]
0x3B02	STROBE_SHUTTER_DLY	0x08	RW	Bit[7:0]: shutter_dly[12:8]
0x3B03	STROBE_SHUTTER_DLY	0x00	RW	Bit[7:0]: shutter_dly[7:0]
0x3B04	STROBE_FREX_EXP_H	0x04	RW	Bit[7:0]: frex_exp[15:8]

table 7-5 strobe/frame exposure control registers (sheet 2 of 2)

address	register name	default value	R/W	description
0x3B05	STROBE_FREX_EXP_L	0x00	RW	Bit[7:0]: frex_exp[7:0]
0x3B06	STROBE_FREX_CTRL0	0x04	RW	Bit[7:6]: frex_pchg_width Bit[5:4]: frex_strobe_option Bit[3:0]: frex_strobe_width[3:0]
0x3B07	STROBE_FREX_MODE_SEL	0x08	RW	Bit[4]: frex_sa1 Bit[3]: fx1_fm_en Bit[2]: frex_inv Bit[1:0]: FREX strobe 00: frex_strobe mode1 01: frex_strobe mode2 1x: Rolling strobe
0x3B08	STROBE_FREX_EXP_REQ	0x00	RW	Bit[7:1]: Not used Bit[0]: frex_exp_req
0x3B09	FREX_SHUTTER_DELAY	0x02	RW	Bit[7:3]: Not used Bit[2:0]: FREX end option
0x3B0A	STROBE_FREX_RST_LENGTH	0x04	RW	Bit[7:3]: Not used Bit[2:0]: frex_rst_length[2:0]
0x3B0B	STROBE_WIDTH	0x00	RW	Bit[7:0]: frex_strobe_width[19:12]
0x3B0C	STROBE_WIDTH	0x3D	RW	Bit[7:0]: frex_strobe_width[11:4]

7.6 OTP control [0x3D00 - 0x3D21]

table 7-6 OTP control registers (sheet 1 of 2)

address	register name	default value	R/W	description
0x3D00 ^a	OTP_DATA_0	0x00	RW	OTP Buffer 0
0x3D01 ^a	OTP_DATA_1	0x00	RW	OTP Buffer 1
0x3D02 ^a	OTP_DATA_2	0x00	RW	OTP Buffer 2
0x3D03 ^a	OTP_DATA_3	0x00	RW	OTP Buffer 3
0x3D04 ^a	OTP_DATA_4	0x00	RW	OTP Buffer 4
0x3D05	OTP_DATA_5	0x00	RW	OTP Buffer 5
0x3D06	OTP_DATA_6	0x00	RW	OTP Buffer 6
0x3D07	OTP_DATA_7	0x00	RW	OTP Buffer 7

table 7-6 OTP control registers (sheet 2 of 2)

address	register name	default value	R/W	description
0x3D08	OTP_DATA_8	0x00	RW	OTP Buffer 8
0x3D09	OTP_DATA_9	0x00	RW	OTP Buffer 9
0x3D0A	OTP_DATA_A	0x00	RW	OTP Buffer A
0x3D0B	OTP_DATA_B	0x00	RW	OTP Buffer B
0x3D0C	OTP_DATA_C	0x00	RW	OTP Buffer C
0x3D0D	OTP_DATA_D	0x00	RW	OTP Buffer D
0x3D0E	OTP_DATA_E	0x00	RW	OTP Buffer E
0x3D0F	OTP_DATA_F	0x00	RW	OTP Buffer F
0x3D80 ^b	OTP_PROGRAM_CTRL	0x00	RW	Bit[7]: OTP_pgenb_o 0: It is programming time Bit[6:1]: Reserved Bit[0]: OTP_pgm Program start signal Changing from 0 to 1 initiates OTP programming
0x3D81	OTP_LOAD_CTRL	0x00	RW	Bit[7]: OTP_pgenb 0: It is programming time Bit[6:1]: Reserved Bit[0]: OTP_rd Read start signal Changing from 0 to 1 initiates OTP read

a. 0x3D00~0x3D04 is reserved for OmniVision internal use.

b. AVDD must be 2.5V ± 5% when writing/programming OTP; otherwise, there will be reliability issues. There is no such limitation when reading OTP under normal operating conditions.

7.7 BLC control [0x4000 ~ 0x4067]

table 7-7 BLC registers (sheet 1 of 2)

address	register name	default value	R/W	description
0x4000	BLC_CTRL00	0x89	RW	BLC Control Bit[7:1]: Debug mode Bit[0]: BLC enable 0: Disable 1: Enable

table 7-7 BLC registers (sheet 2 of 2)

address	register name	default value	R/W	description
0x4001	BLC CTRL01	0x00	RW	Bit[7:6]: Debug mode Bit[5:0]: start_line
0x4002	BLC CTRL02	0x45	RW	Bit[7]: Debug mode Bit[6]: blc_auto_en Bit[5:0]: reset_frame_num
0x4003	BLC CTRL03	0x08	RW	Bit[7]: blc_redo_en Bit[6]: Freeze writing 1 to this bit will trigger a BLC redo N frames begin Bit[5:0]: manual_frame_num
0x4004	DEBUG MODE	0x08	RW	Bit[7:0]: Black line num
0x4005	BLC CTRL05	0x18	RW	Bit[7:2]: Debug mode Bit[1]: blc_always_up_en 0: Normal freeze 1: BLC always update Bit[0]: Not used
0x4006~ 0x4008	DEBUG MODE	–	–	Debug Mode
0x4009	BLACK LEVEL	0x10	RW	Bit[7:0]: blc_blackleveltarget0 Black level target
0x400A~ 0x4067	DEBUG MODE	–	–	Debug Mode

7.8 frame control [0x4200 - 0x4202]

table 7-8 frame control registers (sheet 1 of 2)

address	register name	default value	R/W	description
0x4200	FRAME CTRL0	0x00	RW	Bit[7:3]: Not used Bit[2]: fcnt_eof_sel Bit[1]: fcnt_mask_dis Bit[0]: fcnt_reset
0x4201	FRAME ON NUMBER	0x00	RW	Bit[7:4]: Not used Bit[3:0]: Frame ON number When both ON and OFF numbers are set to 0x00, frame control is in bypass mode

table 7-8 frame control registers (sheet 2 of 2)

address	register name	default value	R/W	description
0x4202	FRAME OFF NUMBER	0x00	RW	Bit[7:4]: Not used Bit[3:0]: Frame OFF number When both ON and OFF numbers are set to 0x00, frame control is in bypass mode

7.9 MIPI control [0x4800 - 0x4843]

table 7-9 MIPI registers (sheet 1 of 7)

address	register name	default value	R/W	description
0x4800	MIPI CTRL 00	0x04	RW	MIPI Control 00 Bit[7:6]: Debug mode Bit[5]: Clock lane gate enable 0: Clock lane is free running 1: Gate clock lane when no packet to transmit Bit[4]: Line sync enable 0: Do not send line short packet for each line 1: Send line short packet for each line Bit[3]: Lane select 0: Use lane1 as default data lane 1: Use lane2 as default data lane Bit[2]: Idle status 0: MIPI bus will be LP00 when no packet to transmit 1: MIPI bus will be LP11 when no packet to transmit Bit[1:0]: Debug mode

table 7-9 MIPI registers (sheet 2 of 7)

address	register name	default value	R/W	description
0x4801	MIPI CTRL 01	0x0F	RW	<p>MIPI Control 01</p> <p>Bit[7]: Long packet data type manual enable 0: Use mipi_dt 1: Use dt_man_o as long packet data (see register 0x4814[5:0])</p> <p>Bit[6]: Short packet data type manual enable 1: Use dt_spkt as short packet data (see register 0x4815[5:0])</p> <p>Bit[5]: Short packet word counter manual enable 0: Use frame counter or line counter 1: Select spkt_wc_reg_o (see {0x4812, 0x4813})</p> <p>Bit[4]: PH bit order for ECC 0: {DI[7:0],WC[7:0],WC[15:8]} 1: {DI[0:7],WC[0:7],WC[8:15]}</p> <p>Bit[3]: PH byte order for ECC 0: {DI,WC_l,WC_h} 1: {DI,WC_h,WC_l}</p> <p>Bit[2]: PH byte order2 for ECC 0: {DI,WC} 1: {WC,DI}</p> <p>Bit[1:0]: Debug mode</p>

table 7-9 MIPI registers (sheet 3 of 7)

address	register name	default value	R/W	description
0x4802	MIPI CTRL 02	0x00	RW	MIPI Control 02
				Bit[7]: hs_prepare_sel
				0: Auto calculate T_hs_prepare, unit pclk2x
				1: Use hs_prepare_min_o[7:0]
				Bit[6]: clk_prepare_sel
				0: Auto calculate T_clk_prepare, unit pclk2x
				1: Use clk_prepare_min_o[7:0]
				Bit[5]: clk_post_sel
				0: Auto calculate T_clk_post, unit pclk2x
				1: Use clk_post_min_o[7:0]
				Bit[4]: clk_trail_sel
				0: Auto calculate T_clk_trail, unit pclk2x
				1: Use clk_trail_min_o[7:0]
0x4803	MIPI CTRL 03	0x50	RW	Bit[3]: hs_exit_sel
				0: Auto calculate T_hs_exit, unit pclk2x
				1: Use hs_exit_min_o[7:0]
				Bit[2]: hs_zero_sel
				0: Auto calculate T_hs_zero, unit pclk2x
				1: Use hs_zero_min_o[7:0]
				Bit[1]: hs_trail_sel
				0: Auto calculate T_hs_trail, unit pclk2x
				1: Use hs_trail_min_o[7:0]
				Bit[0]: clk_zero_sel
				0: Auto calculate T_clk_zero, unit pclk2x
				1: Use clk_zero_min_o[7:0]
0x4804	MIPI CTRL 04	0x8D	RW	Bit[7:0]: Debug mode

table 7-9 MIPI registers (sheet 4 of 7)

address	register name	default value	R/W	description
0x4805	MIPI CTRL 05	0x10	RW	MIPI Control 05 Bit[7]: MIPI lane1 disable 0: Not used 1: Disable MIPI data lane1, lane1 will be LP00 Bit[6]: MIPI lane2 disable 0: Not used 1: Disable MIPI data lane2, lane2 will be LP00 Bit[5]: lpx_p_sel 0: Auto calculate t_lpx_o in pclkex domain, unit pclk2x 1: Use lp_p_min[7:0] Bit[4]: lp_rx_intr_sel 0: Send lp_rx_intr_o at the first byte 1: Send lp_rx_intr_o at the end of receiving Bit[3:1]: Debug mode Bit[0]: Not used
0x4806	DEBUG MODE	–	–	Debug Mode
0x4810	MIPI MAX FRAME COUNT	0xFF	RW	High Byte of Maximum Frame Count of Frame Sync Short Packet
0x4811	MIPI MAX FRAME COUNT	0xFF	RW	Low Byte of Maximum Frame Count of Frame Sync Short Packet
0x4814	MIPI CTRL14	0x2A	RW	MIPI Control 14 Bit[7:6]: Virtual channel of MIPI Bit[5:0]: Data type in manual mode
0x4815	MIPI_DT_SPKT	0x00	RW	Bit[7]: Not used Bit[6]: Debug mode Bit[5:0]: Manual data type for short packet
0x4818	HS_ZERO_MIN	0x00	RW	High Byte of Minimum Value for hs_zero Unit ns
0x4819	HS_ZERO_MIN	0x96	RW	Low Byte of Minimum Value for hs_zero, unit ns $hs_zero_real = hs_zero_min_o + Tui*ui_hs_zero_min_o$
0x481A	HS_TRAIL_MIN	0x00	RW	High Byte of Minimum Value for hs_trail, unit ns
0x481B	HS_TRAIL_MIN	0x3C	RW	Low Byte of Minimum Value for hs_trail, $hs_trail_real = hs_trail_min_o + Tui*ui_hs_trail_min_o$
0x481C	CLK_ZERO_MIN	0x01	RW	High Byte of Minimum Value for clk_zero, unit ns

table 7-9 MIPI registers (sheet 5 of 7)

address	register name	default value	R/W	description
0x481D	CLK_ZERO_MIN	0x86	RW	Low Byte of Minimum Value for clk_zero, $\text{clk_zero_real} = \text{clk_zero_min_o} + \text{Tui*ui_clk_zero_min_o}$
0x481E	CLK_PREPARE_MIN	0x00	RW	High Byte of Minimum Value for clk_prepare, unit ns Bit[7:2]: Not used Bit[1:0]: clk_prepare_min[9:8]
0x481F	CLK_PREPARE_MIN	0x3C	RW	Low Byte of Minimum Value for clk_prepare $\text{clk_prepare_real} = \text{clk_prepare_min_o} + \text{Tui*ui_clk_prepare_min_o}$
0x4820	CLK_POST_MIN	0x00	RW	High Byte of Minimum Value for clk_post, unit ns Bit[7:2]: Not used Bit[1:0]: clk_post_min[9:8]
0x4821	CLK_POST_MIN	0x56	RW	Low Byte of Minimum Value for clk_post $\text{clk_post_real} = \text{clk_post_min_o} + \text{Tui*ui_clk_post_min_o}$
0x4822	CLK_TRAIL_MIN	0x00	RW	High Byte of Minimum Value for clk_trail, unit ns Bit[7:2]: Not used Bit[1:0]: clk_trail_min[9:8]
0x4823	CLK_TRAIL_MIN	0x3C	RW	Low Byte of Minimum Value for clk_trail $\text{clk_trail_real} = \text{clk_trail_min_o} + \text{Tui*ui_clk_trail_min_o}$
0x4824	LPX_P_MIN	0x00	RW	High Byte of Minimum Value for lpx_p, unit ns Bit[7:2]: Not used Bit[1:0]: lpx_p_min[9:8]
0x4825	LPX_P_MIN	0x32	RW	Low Byte of Minimum Value for lpx_p $\text{lpx_p_real} = \text{lpx_p_min_o} + \text{Tui*ui_lpx_p_min_o}$
0x4826	HS_PREPARE_MIN	0x00	RW	High Byte of Minimum Value for hs_prepare, unit ns Bit[7:2]: Not used Bit[1:0]: hs_prepare_min[9:8]
0x4827	HS_PREPARE_MIN	0x32	RW	Low Byte of Minimum Value for hs_prepare $\text{hs_prepare_real} = \text{hs_prepare_min_o} + \text{Tui*ui_hs_prepare_min_o}$
0x4828	HS_EXIT_MIN	0x00	RW	High Byte of Minimum Value for hs_exit, unit ns Bit[7:2]: Not used Bit[1:0]: hs_exit_min[9:8]
0x4829	HS_EXIT_MIN	0x64	RW	Low Byte of Minimum Value for hs_exit $\text{hs_exit_real} = \text{hs_exit_min_o} + \text{Tui*ui_hs_exit_min_o}$
0x482A	UI_HS_ZERO_MIN	0x05	RW	Minimum UI Value of hs_zero, unit UI

table 7-9 MIPI registers (sheet 6 of 7)

address	register name	default value	R/W	description
0x482B	UI_HS_TRAIL_MIN	0x04	RW	Minimum UI Value of hs_trail, unit UI
0x482C	UI_CLK_ZERO_MIN	0x00	RW	Minimum UI Value of clk_zero, unit UI
0x482D	UI_CLK_PREPARE_MIN	0x00	RW	Minimum UI Value of clk_prepare, unit UI
0x482E	UI_CLK_POST_MIN	0x34	RW	Minimum UI Value of clk_post, unit UI
0x482F	UI_CLK_TRAIL_MIN	0x00	RW	Minimum UI Value of clk_trail, unit UI
0x4830	UI_LPX_P_MIN	0x00	RW	Minimum UI Value of lpx_p, unit UI
0x4831	UI_HS_PREPARE_MIN	0x04	RW	Minimum UI Value of hs_prepare, unit UI
0x4832	UI_HS_EXIT_MIN	0x00	RW	Minimum UI Value of hs_exit, unit UI
0x4833	MIPI_REG_MIN	0x00	RW	MIPI Register Address, Lower Bound (High Byte) Address range of MIPI RW registers is from mipi_reg_min to mipi_reg_max
0x4834	MIPI_REG_MIN	0x00	RW	MIPI Register Address, Lower Bound (Low Byte)
0x4835	MIPI_REG_MAX	0xFF	RW	MIPI Register Address, Upper Bound (High Byte)
0x4836	MIPI_REG_MAX	0xFF	RW	MIPI Register Address, Upper Bound (Low Byte)
0x4837	PCLK_PERIOD	0x18	RW	Period of pclk2x, pclk_div = 1, and 1-bit decimal
0x4838	WKUP_DLY	0x02	RW	Wakeup Delay for MIPI
0x483A	DEBUG MODE	–	–	Debug Mode

table 7-9 MIPI registers (sheet 7 of 7)

address	register name	default value	R/W	description
0x483B	MIPI_LP_GPIO	0x33	RW	Bit[7]: lp_sel1 0: Auto generate mipi_lp_dir1_o 1: Use lp_dir_man1 as mipi_lp_dir1_o Bit[6]: lp_dir_man1 0: Input 1: Output Bit[5]: lp_p1_o Bit[4]: lp_n1_o Bit[3]: lp_sel2 0: Auto generate mipi_lp_dir2_o 1: Use lp_dir_man2 as mipi_lp_dir2_o Bit[2]: lp_dir_man2 0: Input 1: Output Bit[1]: lp_p2_o Bit[0]: lp_n2_o
0x4843	SNR_PCLK_DIV	0x03	RW	Bit[7:1]: Not used Bit[0]: PCLK divider 0: PCLK/SCLK = 2 and pclk_div = 1 1: PCLK/SCLK = 1 and pclk_div = 1

7.10 ISP control [0x5000 - 0x5059]

table 7-10 ISP control registers (sheet 1 of 6)

address	register name	default value	R/W	description
0x5000	ISP_CTRL00	0xFF	RW	ISP Control 00 (0: disable; 1: enable) Bit[7:3]: Not used Bit[2]: Black pixel correction Bit[1]: White pixel correction Bit[0]: Not used
0x5001	ISP_CTRL01	0x01	RW	ISP Control 01 Bit[7:1]: Not used Bit[0]: AWB 0: Disable 1: Enable

table 7-10 ISP control registers (sheet 2 of 6)

address	register name	default value	R/W	description
0x5002	ISP CTRL02	0x41	RW	ISP Control 02 (0: disable; 1: enable) Bit[7:5]: Not used Bit[6]: win_en Bit[1]: otp_en Bit[0]: AWB gain
0x5003	ISP CTRL03	0x0A	RW	ISP Control 03 (0: disable; 1: enable) Bit[7:4]: Not used Bit[3]: buf_en Bit[2]: bin_man_set Bit[1]: bin_auto_en
0x5004	ISP CTRL04	0x00	RW	ISP Control 04 Bit[7:4]: Not used Bit[3]: size_man_en 0: Disable 1: Enable Bit[2:0]: Not used
0x5005	ISP CTRL05	0x31	RW	ISP Control 05 Bit[7]: sof_man 0: SOF from BLC module 1: SOF from pre_isp module Bit[6]: awb_bias_man_en 0: AWB bias manual disable 1: AWB bias manual enable Bit[5]: awb_bias_on 0: Disable AWB bias 1: Enable AWB bias Bit[4:3]: Not used Bit[2:1]: Reserved Bit[0]: Average enable 0: Disable 1: Enable
0x5006	ISP CTRL06	0x00	RW	ISP Control 06 (0: disable; 1: enable) Bit[7]: x_odd_inc_man_en Bit[6]: y_even_inc_man_en Bit[5]: x_odd_inc_man_en Bit[4]: y_even_inc_man_en Bit[3]: x_offset_man_en Bit[2]: y_offset_man_en Bit[1]: x_skip_man_en Bit[0]: y_skip_man_en

table 7-10 ISP control registers (sheet 3 of 6)

address	register name	default value	R/W	description
0x5007	ISP CTRL07	0x00	RW	ISP Control 07 (0: disable; 1: enable) Bit[7]: bin_mode_man_en Bit[6]: bin_mode_man Bit[5]: win_x_off_man_en Bit[4]: win_y_off_man_en Bit[3]: win_x_out_man_en Bit[2]: win_y_out_man_en Bit[1]: isp_input_h_man_en Bit[0]: isp_input_v_man_en
0x5008	X OFFSET MAN	0x00	RW	Bit[7:4]: Not used Bit[3:0]: x_offset_man[11:8]
0x5009	X OFFSET MAN	0x00	RW	Bit[7:0]: x_offset_man[7:0]
0x500A	Y OFFSET MAN	0x00	RW	Bit[7:3]: Not used Bit[2:0]: y_offset_man[10:8]
0x500B	Y OFFSET MAN	0x00	RW	Bit[7:0]: y_offset_man[7:0]
0x500C	WIN X OFFSET MAN	0x00	RW	Bit[7:4]: Not used Bit[3:0]: win_x_offset_man[11:8]
0x500D	WIN X OFFSET MAN	0x00	RW	Bit[7:0]: win_x_offset_man[7:0]
0x500E	WIN Y OFFSET MAN	0x00	RW	Bit[7:3]: Not used Bit[2:0]: win_y_offset_man[10:8]
0x500F	WIN Y OFFSET MAN	0x00	RW	Bit[7:0]: win_y_offset_man[7:0]
0x5010	WIN X OUT MAN	0x00	RW	Bit[7:4]: Not used Bit[3:0]: win_x_out_man[11:8]
0x5011	WIN X OUT MAN	0x00	RW	Bit[7:0]: win_x_out_man[7:0]
0x5012	WIN Y OUT MAN	0x00	RW	Bit[7:3]: Not used Bit[2:0]: win_y_out_man[10:8]
0x5013	WIN Y OUT MAN	0x00	RW	Bit[7:0]: win_y_out_man[7:0]
0x5014	ISP INPUT X MAN	0x00	RW	Bit[7:4]: Not used Bit[3:0]: isp_x_input_man[11:8]
0x5015	ISP INPUT X MAN	0x00	RW	Bit[7:0]: isp_x_input_man[7:0]
0x5016	ISP INPUT Y MAN	0x00	RW	Bit[7:3]: Not used Bit[2:0]: isp_y_input_man[10:8]
0x5017	ISP INPUT Y MAN	0x00	RW	Bit[7:0]: isp_y_input_man[7:0]
0x5018	ISP CTRL18	0x00	RW	Bit[7:4]: x_odd_inc_man Bit[3:0]: x_even_inc_man
0x5019	ISP CTRL19	0x00	RW	Bit[7:4]: y_odd_inc_man Bit[3:0]: y_even_inc_man

table 7-10 ISP control registers (sheet 4 of 6)

address	register name	default value	R/W	description
0x501A	ISP CTRL1A	0x00	RW	Bit[7:4]: Not used Bit[3:2]: x_skip_man Bit[1:0]: y_skip_man
0x501B~ 0x501C	DEBUG MODE	–	–	Debug Mode
0x501D	ISP CTRL1D	0x00	RW	Bit[7]: Not used Bit[6:4]: win_y_offset_adjust Bit[3:0]: Not used
0x501F	ISP CTRL1F	0x03	RW	Bit[7:6]: Not used Bit[5]: enable_opt 0: Not latched by VSYNC 1: Enable latched by VSYNC Bit[4]: cal_sel 0: DPC cal_start using SOF 1: DPC cal_start using VSYNC Bit[3]: Not used Bit[2:0]: fmt_sel 011: ISP output data Others: ISP input data bypass
0x5025	ISP CTRL25	0x00	RW	Bit[7:4]: Not used Bit[1:0]: avg_sel 00: Inputs of AVG module are from ISP input 01: Inputs of AVG module are from AWB gain output 10: Inputs of AVG module are from DPC output 11: Inputs of AVG module are from binning output
0x5026~ 0x503C	DEBUG MODE	–	–	Debug Mode

table 7-10 ISP control registers (sheet 5 of 6)

address	register name	default value	R/W	description
0x503D	ISP CTRL3D	0x00	RW	Bit[7]: test_pattern_en 0: Disable 1: Enable Bit[6]: rolling_bar 0: Disable rolling bar 1: Enable rolling bar Bit[5]: transparent_mode 0: Disable 1: Enable Bit[4]: squ_bw_mode 0: Output square is color square 1: Output square is black-white square Bit[3:2]: bar_style When set to a different value, a different type color bar will be output Bit[1:0]: test_pattern_type 00: Color bar 01: Random data 10: Square 11: Input data
0x503E	ISP CTRL3E	0x00	RW	Bit[7]: Not used Bit[6]: win_cut_en Bit[5]: isp_test 0: Two lowest bits are 1 1: Two lowest bits are 0 Bit[4]: Two lowest bits are rnd_same 0: Frame-changing random data pattern 1: Frame-fixed random data pattern Bit[3:0]: rnd_seed Initial seed for random data pattern
0x504B	ISP CTRL4B	0x30	RW	ISP Control 4B (0: disable; 1: enable) Bit[7:6]: Not used Bit[5]: post_binning h_enable Bit[4]: post_binning v_enable Bit[3]: flip_man_en Bit[2]: flip_man Bit[1]: mirror_man_en Bit[0]: Mirror
0x504C	ISP CTRL4C	0x04	RW	Bit[7:0]: bias_man
0x504D~0x5056	RSVD	–	–	Reserved
0x5057	ISP CTRL57	0x00	RW	Bit[7]: sram_test_dpc1 Bit[6]: sram_test_dpc2 Bit[5]: sram_test_dpc3 Bit[4]: sram_test_dpc4 Bit[3:0]: Not used

table 7-10 ISP control registers (sheet 6 of 6)

address	register name	default value	R/W	description
0x5058	ISP CTRL58	0xAA	RW	Bit[7:4]: sram_rm_dpc1 Bit[3:0]: sram_rm_dpc2
0x5059	ISP CTRL59	0xAA	RW	Bit[7:4]: sram_rm_dpc3 Bit[3:0]: sram_rm_dpc4

7.11 AWB control [0x5180 ~ 0x51DF]

table 7-11 AWB registers (sheet 1 of 3)

address	register name	default value	R/W	description
0x5180	AWB CTRL	0x00	RW	Bit[7]: hsize_man_en Bit[6]: fast_awb 0: Disable fast AWB calculation function 1: Enable fast AWB calculation function Bit[5]: freeze_gain_en When it is enabled, the output AWB gains are input AWB gains Bit[4]: freeze_sum_en When it is set, the sums and averages value are the same as previous frame Bit[3]: gain_man_en 0: Output calculated gains 1: Output manual gains set by registers Bit[2]: start_sel 0: Select the last HREF falling edge of before gain input as calculated start signal 1: Select the last HREF falling edge of after gain input as calculated start signal Bit[1]: after_gma Bit[0]: Not used

table 7-11 AWB registers (sheet 2 of 3)

address	register name	default value	R/W	description
0x5181	AWB DELTA	0x20	RW	Bit[7]: delta_opt Bit[6]: base_man_en Bit[5:0]: awb_delta Delta value to increase or decrease the gains
0x5182	STABLE RANGE	0x04	RW	Bit[7:0]: stable_range
0x5183	STABLE RANGEW	0x08	RW	Bit[7:0]: stable_rangew Wide stable range
0x5184~ 0x5185	AWB CTRL	—	—	Debug Mode
0x5185	HSIZE_MAN	0xE0	RW	Bit[7:0]: hsize_man[7:0]
0x5186	MANUAL RED GAIN MSB	0x04	RW	Bit[7:4]: Not used Bit[3:0]: red_gain_man[11:8]
0x5187	MANUAL RED GAIN LSB	0x00	RW	Bit[7:0]: red_gain_man[7:0]
0x5188	MANUAL GREEN GAIN MSB	0x04	RW	Bit[7:4]: Not used Bit[3:0]: grn_gain_man[11:8]
0x5189	MANUAL GREEN GAIN LSB	0x00	RW	Bit[7:0]: grn_gain_man[7:0]
0x518A	MANUAL BLUE GAIN MSB	0x04	RW	Bit[7:4]: Not used Bit[3:0]: blu_gain_man[11:8]
0x518B	MANUAL BLUE GAIN LSB	0x00	RW	Bit[7:0]: blu_gain_man[7:0]
0x518C	RED GAIN LIMIT	0xF0	RW	Bit[7:4]: red_gain_up_limit Bit[3:0]: red_gain_dn_limit They are only the highest 4 bits of limitation. Maximum red gain is {red_gan_up_limit,FF} Minimum red gain is {red_gain_dn_limit,00}
0x518D	GREEN GAIN LIMIT	0xF0	RW	Bit[7:4]: green_gain_up_limit Bit[3:0]: green_gain_dn_limit They are only the highest 4 bits of limitation. Maximum green gain is {green_gan_up_limit,FF} Minimum green gain is {green_gain_dn_limit,00}

table 7-11 AWB registers (sheet 3 of 3)

address	register name	default value	R/W	description
0x518E	BLUE GAIN LIMIT	0xF0	RW	Bit[7:4]: blue_gain_up_limit Bit[3:0]: blue_gain_dn_limit They are only the highest 4 bits of limitation. Maximum blue gain is {blue_gan_up_limit,FF} Minimum blue gain is {blue_gain_dn_limit,00}
0x518F	FRAME CNT	0x00	RW	Bit[7:4]: Not used Bit[3:0]: awb_frame_cnt
0x51DF	BASE MAN	0x10	RW	Bit[7:0]: base_man

7.12 ISP output windows [0x5980 ~ 0x5988]

table 7-12 ISP output windows registers

address	register name	default value	R/W	description
0x5980	WINDOW XSTART	0x00	RW	Bit[7:5]: Not used Bit[4:0]: window_xstart[12:8]
0x5981	WINDOW XSTART	0x00	RW	Bit[7:0]: window_xstart[7:0]
0x5982	WINDOW YSTART	0x00	RW	Bit[7:4]: Not used Bit[3:0]: window_ystart[11:8]
0x5983	WINDOW YSTART	0x00	RW	Bit[7:0]: window_ystart[7:0]
0x5984	WIN X WIN	0x10	RW	Bit[7:5]: Not used Bit[4:0]: window_x_win[12:8]
0x5985	WIN X WIN	0xA0	RW	Bit[7:0]: window_x_win[7:0]
0x5986	WIN Y WIN	0x0C	RW	Bit[7:4]: Not used Bit[3:0]: window_y_win[11:8]
0x5987	WIN Y WIN	0x78	RW	Bit[7:0]: window_y_win[7:0]
0x5988	WIN MAN	0x00	RW	Bit[7:1]: Not used Bit[0]: Window manual enable 0: Auto mode 1: Manual mode

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8 operating specifications

8.1 absolute maximum ratings

table 8-1 absolute maximum ratings

parameter	absolute maximum rating ^a
ambient storage temperature	-40°C to +125°C
supply voltage (with respect to ground)	V_{DD-A} 4.5V
	V_{DD-D} 3V
	V_{DD-IO} 4.5V
electro-static discharge (ESD)	human body model 2000V
	machine model 200V
all input/output voltages (with respect to ground)	-0.3V to $V_{DD-IO} + 1V$
I/O current on any input or output pin	±200 mA

- a. exceeding the absolute maximum ratings shown above invalidates all AC and DC electrical specifications and may result in permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

8.2 functional temperature

table 8-2 functional temperature

parameter	range
operating temperature ^a	-30°C to +70°C junction temperature
stable image temperature ^b	0°C to +50°C junction temperature

- a. sensor functions but image quality may be noticeably different at temperatures outside of stable image range
b. image quality remains stable throughout this temperature range

8.3 DC characteristics

table 8-3 DC characteristics ($-30^{\circ}\text{C} < T_J < 70^{\circ}\text{C}$)

symbol	parameter	min	typ	max	unit
supply					
V _{DD-A}	supply voltage (analog)	2.6	2.8	3.0	V
V _{DD-IO}	supply voltage (digital I/O)	1.7	1.8	3.0	V
V _{DD-D}	supply voltage (digital core) ^a	1.425	1.5	1.575	V
typical power conditions: AVDD = 2.8V, DOVDD = 1.8V, and DVDD = 1.5V					
I _{DD-A}	active (operating) current with internal DVDD 2592 x 1944 @ 15 fps		32	48	mA
I _{DD-IO}			78	100	mA
I _{DD-A}	active (operating) current with external DVDD 2592 x 1944 @ 15 fps		32	48	mA
I _{DD-IO}			1.8	2.4	mA
I _{DD-D}			72	94	mA
I _{DD-A}	active (operating) current with internal DVDD 720p @ 60 fps		34	48	mA
I _{DD-IO}			70	91	mA
I _{DD-A}	active (operating) current with external DVDD 720p @ 60 fps		34	45	mA
I _{DD-IO}			1.8	2.4	mA
I _{DD-D}			65	85	mA
standby current					
I _{DDS-SCCB} ^b	standby current ^c		20	70	μA
I _{DDS-PWDN}			20	70	μA
digital inputs (typical conditions: AVDD = 2.8V, DVDD = 1.5V, DOVDD = 1.8V)					
V _{IL}	input voltage LOW			0.54	V
V _{IH}	input voltage HIGH	1.26			V
C _{IN}	input capacitor			10	pF
digital outputs (standard loading 25 pF)					
V _{OH} ^d	output voltage HIGH	1.62			V
V _{OL} ^d	output voltage LOW			0.18	V

table 8-3 DC characteristics ($-30^{\circ}\text{C} < T_J < 70^{\circ}\text{C}$)

symbol	parameter	min	typ	max	unit
serial interface inputs					
V_{IL}^d	SIOC and SIOD	-0.5	0	0.54	V
V_{IH}^d	SIOC and SIOD	1.26	1.8	2.3	V

- a. when internal regulator is bypassed
- b. external clock is stopped during measurement
- c. standby current is based on room temperature
- d. based on DOVDD = 1.8V

8.4 AC characteristics

table 8-4 timing characteristics

symbol	parameter	min	typ	max	unit
oscillator and clock input					
f_{osc}	frequency (XVCLK)	6	24	27	MHz
t_r, t_f	clock input rise/fall time			5 (10 ^a)	ns

- a. if using the internal PLL

OV5648

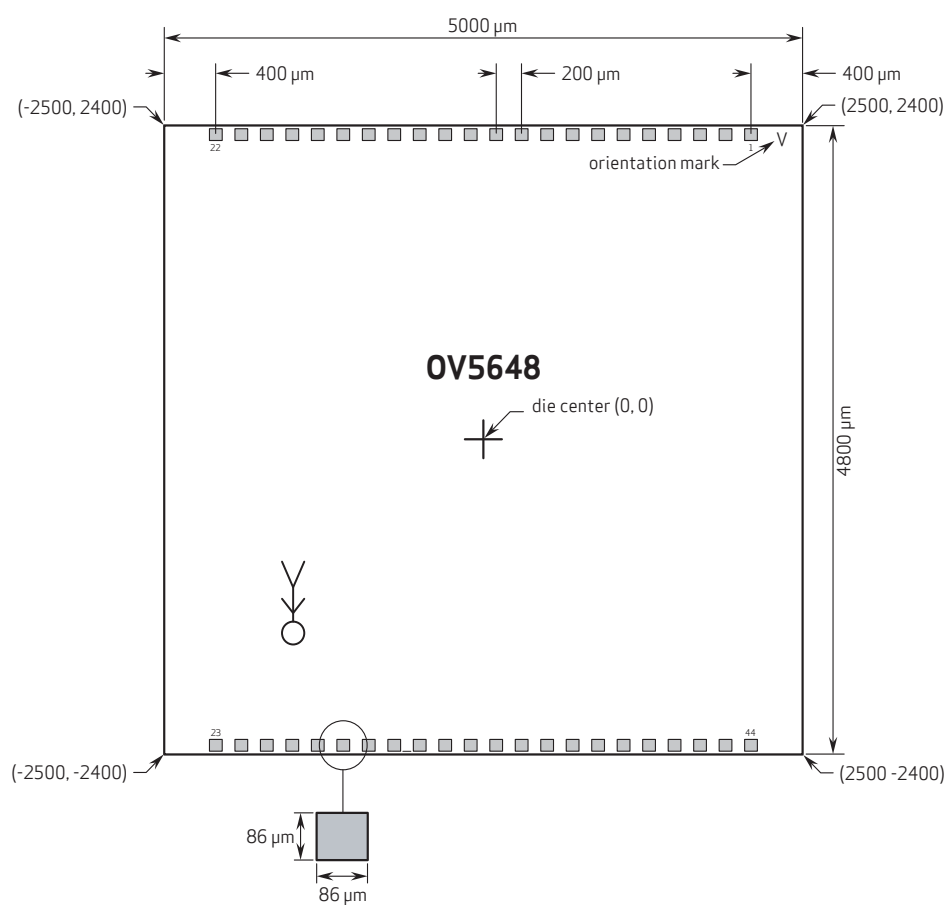
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9 mechanical specifications

9.1 COB physical specifications

figure 9-1 COB die specifications



5648_COB_DS_9_1

table 9-1 pad location coordinates (sheet 1 of 3)

pad number	pad name	x coordinate	y coordinate	bond pad opening size
1	DVDD	2100	2335	86x86
2	AGND	1900	2335	86x86
3	AVDD	1700	2335	86x86

table 9-1 pad location coordinates (sheet 2 of 3)

pad number	pad name	x coordinate	y coordinate	bond pad opening size
4	DOGND	1500	2335	86x86
5	SIOD	1300	2335	86x86
6	SIOC	1100	2335	86x86
7	DVDD	900	2335	86x86
8	SCK	700	2335	86x86
9	SDI0	500	2335	86x86
10	SDI1	300	2335	86x86
11	DOVDD	100	2335	86x86
12	GPIO	-100	2335	86x86
13	VSYN	-300	2335	86x86
14	FREX	-500	2335	86x86
15	DOGND	-700	2335	86x86
16	STROBE	-900	2335	86x86
17	RESETB	-1100	2335	86x86
18	PWDNB	-1300	2335	86x86
19	DVDD	-1500	2335	86x86
20	TM	-1700	2335	86x86
21	AVDD	-1900	2335	86x86
22	AGND	-2100	2335	86x86
23	AGND	-2100	-2335	86x86
24	AVDD	-1900	-2335	86x86
25	HVDD	-1700	-2335	86x86
26	NVDD	-1500	-2335	86x86
27	PVDD	-1300	-2335	86x86
28	XVCLK	-1100	-2335	86x86
29	DOVDD	-900	-2335	86x86
30	DVDD	-700	-2335	86x86
31	DOGND	-500	-2335	86x86
32	DOVDD	-300	-2335	86x86
33	MDP0	-100	-2335	86x86

table 9-1 pad location coordinates (sheet 3 of 3)

pad number	pad name	x coordinate	y coordinate	bond pad opening size
34	MDN0	100	-2335	86x86
35	EGND	300	-2335	86x86
36	MCP	500	-2335	86x86
37	MCN	700	-2335	86x86
38	EVDD	900	-2335	86x86
39	MDP1	1100	-2335	86x86
40	MDN1	1300	-2335	86x86
41	DOVDD	1500	-2335	86x86
42	DOGND	1700	-2335	86x86
43	DVDD	1900	-2335	86x86
44	DOVDD	2100	-2335	86x86

9.2 reconstructed wafer (RW) physical specifications

- maximum total die count: 852
- film frame: Disco
- carrier tape: UV tape



note

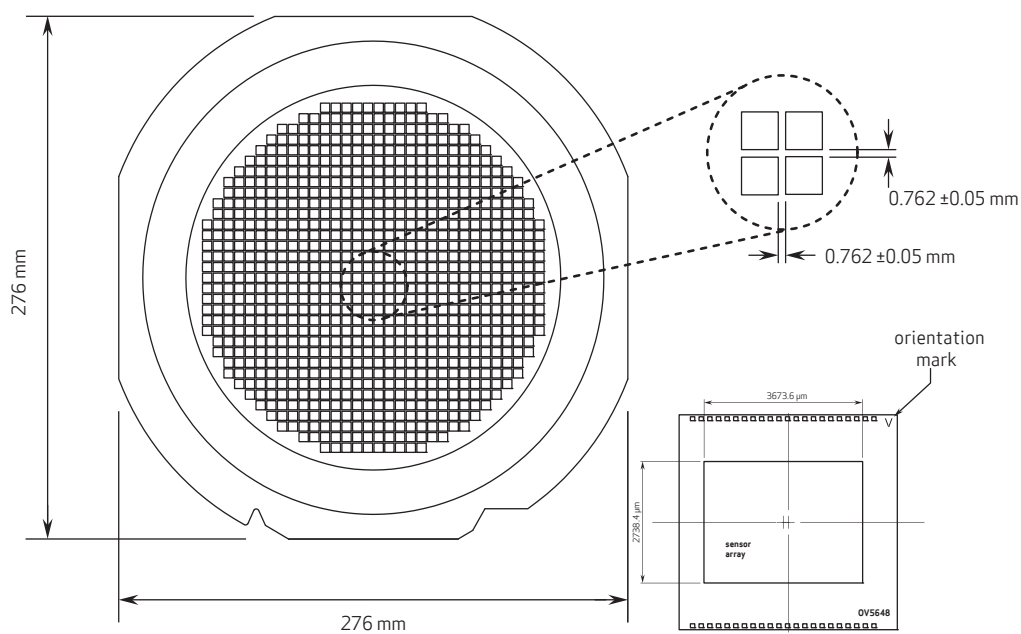
Actual die count varies and the absent die may be less than 10% of the maximum total die count (excluding the last frame of the wafer lot).

table 9-2 RW physical dimensions

feature	dimensions
RW physical dimensions	8" RW on 12" frame
wafer thickness (OVXXXXX-ABCD)	
C=4	200 μm \pm 10 μm (7.9 mil \pm 0.4 mil)
reconstructed wafer street width	0.762 mm (30 mil) \pm 0.05 mm
placement accuracy x, y, theta	\pm 50 μm (\pm 2 mil), <1.0 degree
singulated die size	
width	5050 μm \pm 20 μm (198.8 mil \pm 0.8 mil)
length	4850 μm \pm 20 μm (190.9 mil \pm 0.8 mil)
bond pad size	100 μm \times 90 μm (3.9 mil \times 3.5 mil)
minimum bond pad pitch	200 μm (7.9 mil)
bond pad opening size	86 μm \times 86 μm (3.4 mil \times 3.4 mil)
optical array	
die center	(0, 0)
optical center from die center ^a	-115 μm , 0 μm (-4.5 mil, 0 mil)

a. based on die orientation on frame with notch facing down position

figure 9-2 OV5648 RW physical diagram



5648_COB_DS_9_2

OV5648

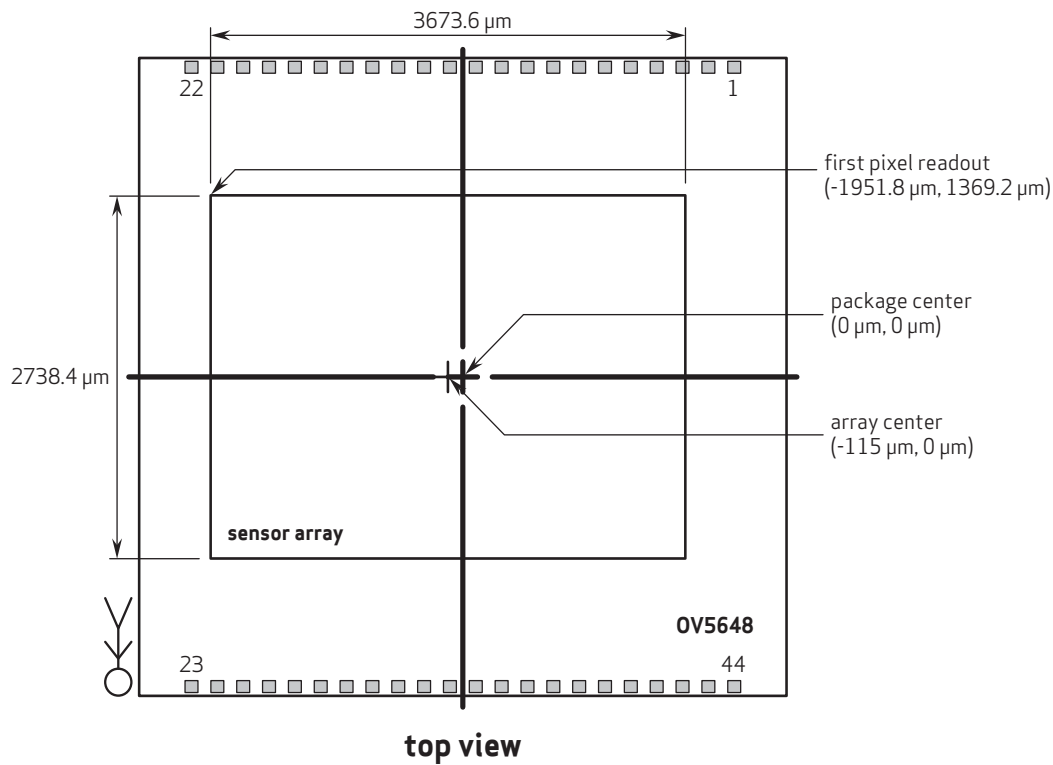
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10 optical specifications

10.1 sensor array center

figure 10-1 sensor array center



note 1 this drawing is not to scale and is for reference only.

note 2 as most optical assemblies invert and mirror the image, the chip is typically mounted with pad 1 oriented down on the PCB.

5648_COB_DS_10_1

10.2 lens chief ray angle (CRA)

figure 10-2 chief ray angle (CRA)

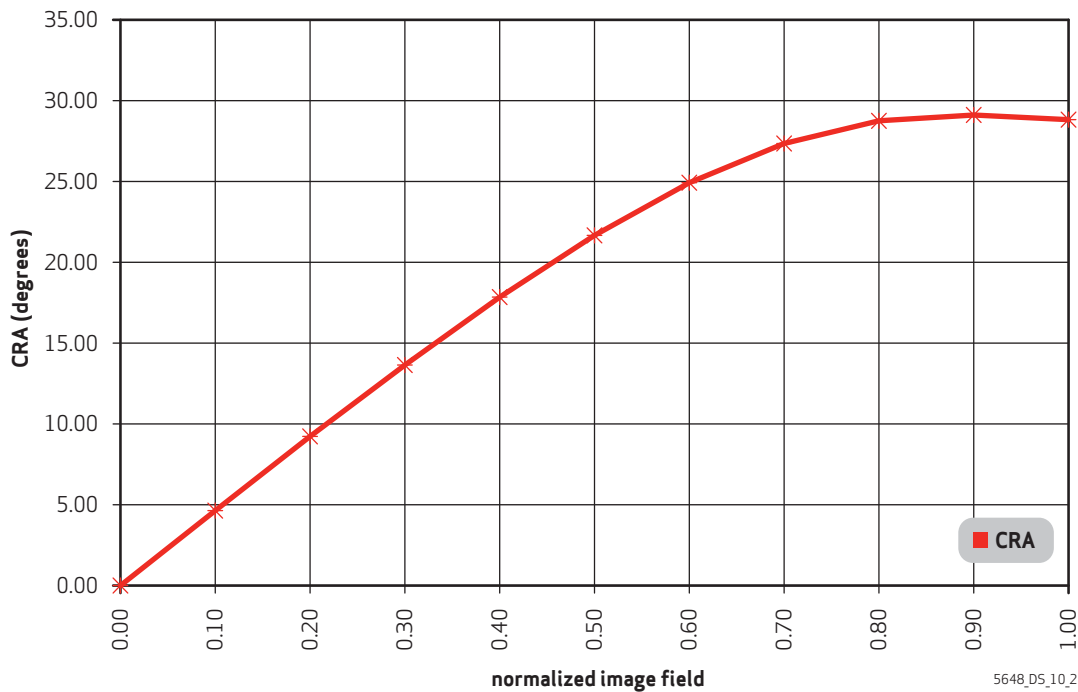


table 10-1 CRA versus image height plot

field (%)	CRA (degrees)
0.00	0.00
0.10	4.6
0.20	9.2
0.30	13.7
0.40	17.8
0.50	21.7
0.60	24.9
0.70	27.3
0.80	28.7
0.90	29.1
1.00	28.9

appendix A handling of RW devices

A.1 ESD /EOS prevention

1. Ensure that there is 500V ESD control in all work areas.
2. Use ESD safety shoes, ground strap, and static control smocks in test areas.
3. Use grounded work carts and tables in inspection areas.
4. OmniVision recommends the use of ionized air in all work areas.

A.2 particles and cleanliness of environment

1. All production, inspection and packaging areas should meet Class10 environment requirements.
2. Use optical microscopes with 50X and 100X magnifications for particle inspection.
3. Ensure that there is good cassette sealing for particle protection during storage.
4. OmniVision recommends water cleaning to remove removable particles.
5. RW die should be stored in nitrogen gas purged cabinets with temperature less than 30°C and relative humidity of 60% before assembly.

A.3 other requirements

1. Reliability assurance of RW or COB bare die is certified by product reliability of the bare die in a CLCC, CSP or QFP package form factor. Precautions should be taken if the packaging form factor of the bare die is other than these specified.
2. Avoid exposure to strong sunlight for extended periods of time as the color filter of the image sensor may become discolored.
3. Avoid direct exposure of the sensor bare die to high temperature and/or humidity environment as sensor characteristics will be affected. Extra precautions should be exercised if the bare die experiences temperatures exceeding 260°C for more than 75 seconds.

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revision history

version 1.0 07.13.2012

- initial release

version 1.1 09.28.2012

- in key specifications, changed active and standby power requirements to 198 mW and 35 μ W, respectively
- in table 1-2, changed name of sixth column to "hardware standby (power down pin = 0)"
- in section 4.11.1, replaced example of OTP program code
- in section 4.11.2, replaced example of OTP read code
- added section 5.5, picture-in-picture (PIP)

version 1.11 05.06.2013

- in key specifications, changed die dimensions to 5000 μ m x 4800 μ m (COB), 5050 μ m x 4850 μ m (RW)
- In key specifications, added a sidebar note explaining the difference between COB and RW
- in chapter 9, added section 9.2 including table 9-2 and figure 9-2

version 2.0 06.05.2013

- changed datasheet from Preliminary Specification to Product Specification
- in key specifications, changed active power requirements to 219 mW and changed standby power requirements to 36 μ W
- in table 8-3, changed sub title bar from "internal DVDD, EVDD short to DVDD, MIPI output, AVDD = 2.8V, DOVDD = 2.8V" to "typical power conditions: AVDD = 2.8V, DOVDD = 1.8V, and DVDD = 1.5V"
- in table 8-3, changed V_{DD-DO} to V_{DD-IO} and removed row for V_{DD-E}
- in table 8-3, changed I_{DD-DO} to I_{DD-IO} , changed "active (operating) current 2592 x 1944 @ 15 fps" to "active (operating) current with internal DVDD 2592 x 1944 @ 15 fps", and changed "active (operating) current 720p @ 60 fps" to "active (operating) current with internal DVDD 720p @ 60 fps"
- in table 8-3, removed rows for active (operating) current 1080p @ 30 fps, active (operating) current 720p @ 30 fps, active (operating) current VGA @ 60 fps, and active (operating) current VGA @ 30 fps
- in table 8-3, added rows for active (operating) current with external DVDD 2592 x 1944 @ 15 fps and active (operating) current with external DVDD 720p @ 60 fps
- in table 8-3, for active (operating) current with internal DVDD 2592 x 1944 @ 15 fps, changed typ values for I_{DD-A} and I_{DD-IO} from 31 and 60 to 32 and 78, respectively
- in table 8-3, for active (operating) current with internal DVDD 2592 x 1944 @ 15 fps, changed max values for I_{DD-A} and I_{DD-IO} from 45 and 78 to 48 and 100, respectively

- in table 8-3, for active (operating) current with internal DVDD 720p @ 60 fps, changed typ value for I_{DD-IO} from 56 to 70
- in table 8-3, for active (operating) current with internal DVDD 720p @ 60 fps, changed max values for I_{DD-A} and I_{DD-IO} from 45 and 74 to 48 and 91, respectively

version 2.1

08.21.2013

- in key specifications, changed max S/N ratio from "34 dB" to "36 dB", changed dynamic range from "67 dB @ 8x gain" to "72 dB @ 8x gain", changed sensitivity from "600 mV/Lux-sec" to "690 mV/Lux-sec", and changed dark current from "8 mV/s @ 50°C junction temperature" to "0.7 mV/s @ 50°C junction temperature"
- in table 8-3, for standby current, changed max value for $I_{DDS-SCCB}$ and $I_{DDS-PWDN}$ to 70 μA
- in section 9.2, changed dicing tape from "FSL-N6600" to "UV tape"

version 2.11

08.30.2013

- in figure 2-2, changed value of capacitors C1, C2 and C3 to 1 μF
- in section 9.2, changed "dicing tape" to "carrier tape"
- in section A.2, changed "OmniVision recommends air blowing..." to "OmniVision recommends water cleaning..."

version 2.12

09.18.2013

- in table 4-12, changed table footnote a to "bank 0 (0x3D00~0x3D04) and bank 1 (0x3D0F) are reserved for OmniVision internal use."

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